### SEMICONDUCTOR THERMOELEMENTS

and

# THERMOELECTRIC COOLING

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## Part 1 SEMICONDUCTOR THERMOELEMENTS

### PREFACE

My book 'Semiconductor Thermoelements', published at the beginning of 1956, is a supplemented edition of 'Energetic Principles of Semiconductor Thermoelectric Batteries' published in 1949. This English translation naturally takes into account the advances reported in the world materialistic literature since the publication of the book, as well as those multiple of the Institute for Semiconductors. We now have a better understanding of the mechanism of the appearance of thermal emf's and of the princeages of thermal and electrical conduction in semiconductors, and of how to apply our knowledge to the achievement of practical results.

This book reflects the state of the problem as I understand it at present. In addition, I thought that readers of this translation would be interested in some devices which have already been constructed in the motet Union. The book is therefore supplemented with a brief description of certain instruments which have proved themselves in practice.

In principle, the application of semiconductor thermoelements extends aver the entire field of power generation, refrigeration, and heating. The practical possibilities depend, however, on the characteristics of the available thermoelements, their efficiency, operating temperature limits, attability in operation, and cost.

The most important characteristic of the thermoelements is a quantity distributed in the text by the letter z, defined by the equation  $z=\frac{a^2\sigma}{\kappa}$ , where a is the thermoelectric power,  $\sigma$  is the specific electrical conductivity, and  $\kappa$  is the specific thermal conductivity. When a is expressed in  $V=\deg^{-1}$ ,  $\sigma$  in ohm<sup>-1</sup>  $\times$  cm<sup>-1</sup> and  $\kappa$  in  $\mathbb{W}\times \deg^{-1}\times$  cm<sup>-1</sup>, then z has the dimension of  $\deg^{-1}$ . The value of z for our best thermoelements ranges from  $1.5\times 10^{-3}$  to  $3\times 10^{-3}$  o  $K^{-1}$  depending on the operating temperature. This implies that the efficiency of thermoelectric generators is in the image f: 10%, the maximum temperature difference given by the Peltier flact across a single couple is  $60-70^{\circ}$ C, the coefficient of performance is infigurating unit in  $0.4\cdot 0.7$  at a temperature difference of  $40^{\circ}$ , whilst that of a heating unit is 1.5-1.8 for the same temperature difference.

These data define the practical possibilities at the beginning of 1957. I sling into account the fact that our level of knowledge of semiconductors

is atill low and that the range of materiala ao far inveatigated is amall, it may be expected that the characteriatics listed above will be aubstantially improved and the applicationa of thermoelements will become more wide-

spread.

I hope that this book will help to apeed up progress towards this end. It has not been my aim to discuss the construction and technology of thermoelectric batteries for apecific applicationa; these problems every one will solve according to his needa. Everybody should, however, be guided by the general physical concepta which I have attempted to ontline and explain here on the basis of our experience.

I hope that acquaintance with our experience and ideas underlying onr work will prove useful to readera of the English translation.

A. F. loffe

March 1957

### FROM THE FOREWORD TO THE RUSSIAN EDITION

Although research into the problem of thermoelectricity is in progress in our country and although, e.g., thermoelectric generators utilising the waste heat from kerosene lamps for feeding radio receivers have been developed and are now produced on an industrial scale, it is obvious that the acale of this work does not bear any relation to the importance of the problem. The time has arrived to promote the advancement of applications of thermoelectricity and for taking thermoelementa outside the walls of a few Inboratoriea. The combined efforts of physicists and chemists, heat engineers and electrical engineers should be concentrated on the aclution of this problem and, even at this early stage, it is necessary to secure the co-operation of our more advanced factories.

This book and the collective work by A. F. loffe, L. S. Stil'bans, T. S. Stavitskaya and E. K. Iordanishvili 'Thermoelectric Cooling' describe our experience in this field and are designed to furnish research and

production workers with the necessary information.

The second chapter forms the core of the book. The first (introductory) chapter and the third (supplementary) chapter present, in an abbreviated form, previously published information facilitating understanding of the problem, or else describe new applications which have not yet been put into practice.

### CHAPTER 1

#### INTRODUCTION

In 1822-1823 Seebeck 1.1 Diacovery of thermoelectric phenomena. described in the Reports of the Prusaian Academy of Sciences a phenomenon which he named "the magnetic polarisation of metala and ores produced by a temperature difference". It is obvious from the description of his experiments that Seebeck discovered thermoelectric currents arising in a closed circuit made up of different conductors at different junction temperatures.

This was an epoch when the discovery by Oersted of the effect of un electrical current on a magnetic needle was followed by a series of investigations by Ampère, Biot, Savart, Laplace, and others who eluciduted the interaction between electric currents and magnetic fields; Ampère's molecular current hypothesis reduced the aource of magnetic phenomena to electrical currents. The acience of electricity and mngnetism grew from Monday to Monday (the day of the week on which the Paria Academy of Sciencea used to ait); physicists, mathematicians and chemiats played an active part in its development.

This scientific development apread from Paris to Switzerland und Germany, and then to England, where it was enriched by Faraday's

discovery of electromagnetic induction.

When Seebeck's experiments are considered without prejudice there cun he no doubt that the phenomena observed by him were caused by the electric current, (the disappearance of the magnetic effects whenever the current was cut off by the introduction of a non-conducting layer, the quantitative relationship between the magnetic field produced by the rurrent and the observed deflections of the magnetic needle, etc.). llowover, Seebeck not only rejected this natural explanation of his results but fought actively against it for aeveral years after, accusing the exponeuts of thermoelectric current theory of following a fashion started by Ornted's discovery.

An explanation of this dogmatic attitude of Seebeck towards his discovery may be found in the canclading part of his large treatise, in which he makes an attempt to relate the Earth's magnetism to the temperature difference between the aquator or a range of southern volcannes

and the polar ice cap. It appears that this hypothesis was closer to his heart than the discovery of a still further source of electric current. The value of Seebeck's paper does not, of course, lie in this hypothesis, (he himself showed that a temperature difference without a closed electrical circuit does not produce any magnetic effects), nor in the attempt to deny the existence of an electric current, but in the copious experimental material accumulated by him and covering a great variety of solid and liquid metals, their alloys, minerals, and semiconductors. Seebeck's mistake had a positive effect: in order to disprove the electrical origin of thermoelectric currents he compared, for a great variety of materials, the contact potential (Volta) effect with the effect of temperature difference on a magnetic needle, and demonstrated the difference between these phenomena.

The extensive thermoelectric series compiled by Seebeck is, even now, of interest. Using modern notation (a = thermoelectric power, and  $\sigma$  = specific electrical conductivity), the Seebeck series is in the order of magnitude of the product  $a\sigma$  and not the quantity  $a^2\sigma/\kappa$  (where  $\kappa$  is specific thermal conductivity) which, as will be seen later on, characterises the thermoelectric properties of materials. The thoroughness of Seebeck's investigations may be illustrated, for example, by the fact that in an article by Maria Telkes published in an American journal 125 years later the best couple was given as ZnSb and PbS, which were the first and the last members in Seebeck's series.

A comparison of the qualitative Seebeck series with modern measurements of the thermoelectric power of metals shows good agreement. The divergence between Seebeck's series and those of Justi and Meisner is not larger than the divergence between the latter two series. We are reproducing below the aforementioned thermoelectric series (the thermoelectric power in Justi's and Meisner's series is expressed in  $\mu V/\deg$ ).

Had Seebeck followed his discovery with an attempt to use a thermocouple to generate electrical energy, he could have obtained, using the first and last terms in his series, an efficiency of the order of 3%, i.e., as much as that of the best steam engines at that time.

It must also be noted that Seebeck did not fail to pay attention to phenomena caused by a temperature difference in homogeneous materials and that he estimated qualitatively thermoelectric relationships which were rediscovered 30 years later by W. Thomson, who proved their existence on the basis of a thermodynamic analysis of the thermoelectric processes.

Twelve years after Seebeck's discovery Peltier, a watchmaker, published in the French journal 'Annal. Phys. Chim.' for 1834 an article on temperature anomalies observed in the vicinity of the boundary between

		Mei	isner, 1955	
Seebeck, 1822	Justi, 1948	metals	semiconduc10	rs
PbS Bi Bi amalgam Ni Co Pd P1 No. 1	Bi -80 Co -21 Ni -20 K -14 Pd - 8 Na - 7 P1 - 5	Bi -70 Co -17.5 Ni -18 K -12 Pd -6 Na -4.4 Pt -3.3	MoS ZnO CuO Fe <sub>2</sub> O <sub>3</sub> (400°C) FeO Fc <sub>3</sub> O <sub>4</sub> FeS <sub>2</sub>	-770 -714 -696 -613 -500 -430 -200
U Au No. 1 Cu No. 1	Hg - 6 C -3.5 Al -1.5	Hg -3.4 Al -0.6	$M_{\rm g}O_3H_2$ SnO $Fe_2O_3$ (50°C)	-200 -139 -60
Rh Au No. 2 Ag	Mg -1.5 Pb -1.0 Sn -1.0	Mg -0.4 Pb -0.1 Sa +0.1	CdO CuS FeS CdO	-41 -7 +26 +30
Zn C Cu No. 3	Cs -0.5 Y -1.0 Rh +1.0	Cs +0.2 Y +2.2 Rh +2.5 Zn +2.9	GeTiO <sub>3</sub> NiO Mn <sub>2</sub> O <sub>3</sub>	+ 140 + 240 + 385
Pt No. 4 Cd Steel Fe	Zn + 1.5 Ag + 1.5 Au + 1.5 Cu + 2.0	Ag + 2.4 Au + 2.7 Cu + 2.6	Ca <sup>5</sup> O Ca <sup>5</sup> O	+ 474 + 1000 + 1120
As Sb SbZn	W + 2.5 Cd + 3.5 Mo + 6.5	W +1.5 Cd +2.8 Mo +5.9	Cu <sub>2</sub> O	+ 1150
Fe	Fe +12.5 Sb +42 Si +44	Fe + 16 Sb + 35 Fe + 400		
	Fe +49 Se	Fe +400 Se +1000		

two different conductors when a current was passing through them. The phenomenon first observed by Peltier, and therefore given the name of Peltier effect, consists in reality of the generation or absorption (depending on the direction of the current) of heat, at a rate Q, at the junction between two different conductors when a current l flows through them:

$$Q = \Pi I$$

where Il is the Peltier coefficient.

The Peltier offect in very closely related to the Seebeck effect, and the coefficient II to the thermoelectric power a:

$$\Pi = \alpha T$$

where T is the absolute temperature of the junction. A temperature difference produces an electric current in a closed circuit made of different materials, whilst, in turn, a current flowing through such a circuit produces a temperature difference. It is interesting that Peltier did not notice this connection in spite of the fact that he carried out his experiments using a thermoelectric circuit. In these experiments, the Seebeck effect was used solely for secondary purposes, namely as a source of weak currents.

The anomaliea discovered by Peltier were found to be the more pronounced the larger the thermoelectric powers of the metals involved; they were particularly conspicuous at the junction of bismuth with antimony. Peltier was, however, looking for, and finding, in his experiments the confirmation of a preconceived idea that the universal law of heat generation by current, viz the Joule-Lenz law, is only valid for strong currents. Peltier thought that in the case of weak currents produced by a thermocouple the individual properties of the metals began to have an effect. He did not find a confirmation of this hypothesis in the bulk properties of the conductors, but the anomalies at the junctions were affected by the nature of the metal (in renlity by its thermoelectric properties). Peltier did not notice this and aought an explanation in the hardness or softness of the metal or its electrical conductivity, and when the facts did not come up to his expectations, for example in the case of bismuth, the thermal anomalies of which were attributed by Peltier to high electrical conductivity, he refused to believe the measurementa.

A few more years passed, during which Becquerel and other investigators tried to explain the true nature of the Peltier phenomenon, until in 1838 the St. Petersburg Academician Lenz put an end to all doubts with a aimple experiment. Lenz placed a droplet of water in a dent at the junction of bismuth and antimony rods. The droplet turned into ice when the current was reversed. It is known that to freeze 1 gm of water it is necessary to remove 80 cal, whilat in melting 1 gm of ice the same amount must be supplied. It thus became obvious that, depending on its direction, an electric current generates or absorba heat at the junction of two conductors.

Thermoelectric phenomena did not attract attention amongst physicists. They were obscured by the striking phenomena of electromagnetism which led Faraday to the discovery of electromagnetic induction. Physics was moving towards the generalising laws of Maxwell's theory, and engineering towards electrical machinery. Thirty years had passed since Seebeck's discovery when, awing to the evolution of thermodynamics, all types of energy conversion became of interest, including the conversion of thermal and electrical energy in the Seebeck and Petter effects.

This, in fact, was the approach adopted by W. Thouson, one of the founders of thermodynamic Thermodynamic analysis of the besterk and

Peltier effects led him not only to the establishment of the relationship between these two proceases, which has already been mentioned above, but also to the discovery of a third phenomenon, the Thomson effect, consisting of the generation or absorption of heat q by the passage of a current l through a homogeneous conductor in which there is a temperature

gradient  $\frac{\partial T}{\partial x}$ :  $q = rl \frac{\partial T}{\partial x}$ ;

r became known as the Thomson coefficient; as will be seen later it is related to the coefficients  $\alpha$  and  $\Pi$ .

It should be remembered that the Thomaon effect was earlier experimentally observed and inveatigated by Seebeck.

In 1857 Thomson published his theory of the thermoelectric phenomena in anisotropic crystals; however, only in the 20th century was it shown by Bridgman that a change of the direction of the current in a crystal is connected with the absorption or generation of heat, as in the case of the Peltier effect. Such an internal Peltier effect was called the Bridgman effect.

In 1920-21, almost one hundred years after Seebeck's discovery, lienedicks reported the discovery of two more thermoelectric effects depending on the value of the temperature gradient and not on the temperature difference between the ends of the conductors. When the ends of a conductor are at the same temperature, but if there is a warmer or upoler portion in between them, then, according to Benedicks, a potential difference will appear between the ends of the conductor when the warm (or cool) portion is not symmetrically placed, i.e. is closer to one of the ends. A careful check of the Benedicks effect by other investigators did not confirm its existence. It may be presumed that even if this effect exists it is negligible.

The phenomena enumerated above exhaust the field of thermoelectricity, if phenomena arising in a magnetic field, generally referred to as thermomagnetic phenomena, are not included.

Thermocouplea have been used for temperature measurement for a long time, but the problem of their power application became of importance only with the growing demand for sources of electrical energy.

In 1885 Rayleigh considered the problem of the efficiency of a thermoelectric generator and calculated it, though aomewhat inaccurately. The problem of a thermoelectric electrical energy generator was again taken up in 1909 by Altenkirch, this time, on the whole, correctly. In 1910 Altenkirch investigated the problem of thermoelectric cooling and heating. However, since the only conductors technically known at that time were totals, such devices were found to be unecommitted. It is true that a few

thermoelectric generators (by Gulcher, Coblentz, and others) made their appearance, but they did not find wide application since their efficiency did not exceed 0.6% and sometimes not even 0.1%. Therefore thermoelectricity again moved to a back place in the advance of physics, together with luminescence, photoelectricity, and piezoelectricity.

The position on the electrical engineering front (and, therefore, also the subjects of physical investigations) underwent a radical change with the advent of semiconductors. It is very characteristic of the present degree of relationship between physics and engineering that all these phenomena have again begun to attract considerable attention among physicists and are playing an important role in semiconductor production engineering. The thermoelectric aspects will be discussed in detail in this book. As far as other fields are concerned, it is enough to mention fluorescent lamps, ceramic piezoelectric materials, and solid and vacuum photocells, developed both in the Soviet Union and abroad.

The prospects of attaining appreciable efficiencies in thermoelectric generators became more favourable. In conjunction with the problems of industrialisation of the Soviet Union at the beginning of the first five-year plan, I outlined in 1929 the advantages of thermoelectric generators made of semiconductors and calculated that their efficiency could reach 2.5-4% with prospects of an appreciable increase in the future. In fact, in 1940 Yu. P. Maslakovets described a thermoelement, made of lead sulphide with an excess of lead and sulphur, with an efficiency of the order of 3%.

It seems to us that all the energetic applications of thermoelectricity:

1) thermoelectric generators, 2) thermoelectric refrigerators, and 3) thermoelectric industrial and domestic heating devices, are not only of great theoretical interest, but present real prospects of practical application on the basis of the modern science of semiconductors. Moreover, some previously unforeseen applications have arisen, such as the construction of thermoelectric sound and ultrasonic generators, vacuum thermoelements, etc.

1.2 Thomson's thermodynamic relationships. Three thermoelectric effects have been established experimentally: 1) the appearance of a thermoelectric voltage dE in an open circuit consisting of two different conductors when there is a temperature difference dT between their ends:

$$dE = \alpha_{1-2} dT \tag{1}$$

 $(\alpha_{1-2} \text{ is known as the thermal emf coefficient or sometimes simply as the thermal emf, or thermoelectric power, between the given conductors; <math>\alpha$  may depend also on temperature); 2) the generation of heat, dQ watts, at the boundary between two conductors when a current, dl amperes, flows through them:

$$dQ = \prod_{i-2} dI \tag{2}$$

(change of direction of the current leads to a change from the generation of heat in the absorption of heat and vice versa); 3) generation of heat, dy watts, by a current dI is a partion of the conductor with a length dx in the presence of a temperature gradient  $\frac{\partial T}{\partial x}$ .

$$dq = rdl \frac{\partial T}{\partial x} dx. \tag{3}$$

The relationship between  $a_{1-2}$ ,  $II_{1-2}$  and r follows from the laws of thermodynamics.

We shall consider a closed circuit made up of two conductors with a temperature difference dT between the junctions. According to the law of conservation of energy we can equate the algebraic sum of all types of energy generated in the circuit in a unit time to zero under steady-state conditions.

The Peltier heat in watts generated at one junction will be denoted by  $\Pi_{1-1}dl$ , whilst the heat absorbed at the other junction will be denoted by  $\Pi_{1-1}dl$ ; we have  $\Pi_{2-1}=\Pi_{1-2}+\frac{\partial \Pi_{1-2}}{\partial T}dT$ .

The Thomson heat generated in one second in one conductor is  $r_1 dl dT$ , whilst that absorbed in the other conductor is  $r_2 dl dT$ . The alactrical power consumed in the circuit is  $\alpha dT dl$ .

Consequently, the equation of conservation of energy in the circuit

$$\frac{\partial \Pi_{1-2}}{\partial T} dT dl + (\mathbf{r}_1 - \mathbf{r}_2) dl dT = \alpha_{1-2} dT dl$$

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$$\frac{\partial \Pi_{1-2}}{\partial T} + r_1 - r_2 = \alpha_{1-2}. \tag{4}$$

Another relationship between the coefficients  $\alpha$ ,  $\Pi$ , and r may be illustrated from the equation of the second law of thermodynamics, which is, however, only applicable to reversible processes.

All three thermoelectric phenomena ought to be regarded as reversible; their sign changes both with a change of the sign of the temperature difference dT and with a change in the direction of the current dl.

However, the irreversible phenomena of heat conduction and Joule heat generation will also inevitably take place. Whilst the Joule heat, as we shall see later, may be neglected for extremely small currents, the heat transferred by thermal conduction is of the same order as the Peltier heat and sometimes much greater.

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Equation (5) together with equation (4) gives

$$\alpha = \frac{\Pi}{T}.\tag{6}$$

Each of the quantities in expression (6) may be separately measured, thus making it possible to check this expression, obtained by separating reversible from irreversible processes in the thermocouple. Experimental material so far accumulated has always confirmed equation (6) within the the limits of experimental accuracy. We shall, therefore, use equation (6), regarding it as an experimental fact. This equation gives

$$\frac{d\alpha}{dT} = \frac{T\frac{\partial \Pi}{\partial T} - \Pi}{T^2} = \frac{1}{T} \times \frac{\partial \Pi}{\partial T} - \frac{\Pi}{T^2} = \frac{1}{T} \left( \frac{\partial \Pi}{\partial T} - \frac{\Pi}{T} \right).$$

According to equation (5) the expression in brackets is equal to  $(r_1 - r_2)$ . We have therefore

$$\frac{da_{1-2}}{dT} = \frac{1}{T}(r_1 - r_2). \tag{7}$$

On the left hand side of equation (7) is a quantity relating to the boundary between the two conductors, and on the right hand side a difference between two terms, each of which depends on the properties of only one conductor.

A question can, therefore, he posed as to whether  $a_{1-2}$  may be regarded as a difference between two quantities,  $a_1$  describing the first conductor and  $a_2$  describing the second conductor. Integrating equation (7) we

obtain  $a_{1-2} = \int_{0}^{T_2} \frac{r_2}{T} dT - \int_{0}^{T_1} \frac{r_1}{T} dT$ , where the lower limit of the integral

corresponds to the temperature of absolute zero, at which both  $a_{1-2}$  and  $\frac{da_{1-2}}{dT}$  are equal to zero. It is natural to regard

$$\alpha_{1-2} = \alpha_2 - \alpha_1 = \int_0^T \frac{r_2}{T} dT - \int_0^T \frac{r_1}{T} dT,$$

$$a_1 = \int_0^T \frac{r_2}{T} dT, \quad a_1 = \int_0^T \frac{r_1}{T} dT.$$
 (7a)

Thomson assumed that the thermoelectric phenomena are not basically related to the heat conduction process and the generation of heat by the current. The thermal conductivity of a given material and its resistivity, which govern the irreversible processes in thermocouples, do not determine the Seebeck, Thomson, and Peltier effects. These last three phenomena may he considered in isolation, assuming that the thermal conductivity and the resistivity are arbitrarily low and neglecting irreversible processes as incidental.

These considerations cannot be regarded as a convincing proof. More recently Onsager stated the conditions under which such a division of processes into reversible and irreversible is permissible. It appears that Onsager's conditions are satisfied both by metals and semiconductors. This cannot, however, be regarded even yet as definitely established.

Following Thomson, we shall assume, however, that the reversible part of thermoelectric processes may be considered separately from the irreversible processes and shall then check the resulting conclusions. Agreement between these conclusions and experimental results may be regarded as some confirmation of the underlying assumptions. Since we shall consider below only the theoretical conclusions, the theory will be regarded here merely as a way of deriving these results.

Thus, we shall apply the second law of thermodynamics to thermoelectric processes in a thermocouple with hot and cold junction temperatures  $T_1$  and  $T_0$  respectively. The hot junction receives an amount of heat  $\Pi_1 I_1$ , and the cold junction gives np an amount of heat  $\Pi_0 I_2$ ; at the same time an amount of heat rldT is generated at a temperature T in each portion of the conductors in which there is a temperature difference dT.

Reversibility of the processes leads to the condition that the total change of entropy of all the processes is equal to zero:

$$\frac{\prod_{1}}{T_{1}}I - \frac{\prod_{0}}{T}I + I\int_{T}^{T_{1}} \frac{r_{2} - r_{1}}{T} dT = 0.$$

Dividing this equation by I and differentiating it with respect to T, we obtain

$$\frac{d\frac{\Pi}{T}}{dT} + \frac{r_2 - r_1}{T} = 0, \qquad \frac{T\frac{d\Pi}{dT} - \Pi}{T^2} = \frac{r_1 - r_2}{T},$$

whence

$$\frac{d\Pi}{dT} - \frac{\Pi}{T} = r_1 - r_2 \,. \tag{5}$$

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In order to determine  $a_1$  and  $a_2$  in practice it would be necessary to know r(T) from the absolute zero to the specified temperature. Experimental measurement of Thomson heat over such a wide temperature range is difficult and so far has only heen accomplished for the normal silver alloy. The difference  $a_2 - a_1$  and its temperature dependence have been determined frequently for a wide variety of materials.

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It can be readily shown that by measuring, at a certain temperature  $T_0$ ,  $a_{1-2}$ ,  $a_{2-3}$ ,  $a_{3-4}$ , ...,  $a_{(n-1)-n}$ , we shall obtain  $a_{1-2} + a_{2-3} + a_{3-4} + \ldots + a_{(n-1)-n} = a_{1-n}$ . In fact, since all the junctions 1-2, 2-3, 3-4... are at the same temperature  $T_0$ , any change of the emf of the couple 1,n by connecting into the circuit intermediate conductors  $2,3,\ldots$  would require the conversion of heat from the surroundings into electrical energy without any compensation, which contradicts the second law of thermodynamics. The independence of the value of  $a_{i,n}$  from the effect of the intermediate conductors forms the basis for setting up a thermoelectric series. Experiment has always confirmed this relationship.

If we could ascribe to some substance a definite value  $a=a_0$  we would then be able to determine the absolute as well as the relative values of the thermal emf coefficient of all substances. Equation (7a) makes this

possible once  $\int_{0}^{T} \frac{r}{T} dT$  has been measured for one substance only;

the accuracy of such a measurement is, however, low, although nnmerous investigators (Borelius, Keesom, and others) have made attempts to determine r(T) close to the absolute zero. Consideration of the mechanism of thermoelectricity affords another method for determining the absolute values of  $\alpha$  and this will be considered in the following paragraph.

Equation (6) has been checked many times for different materials and found to hold in all cases. Using equations (6) and (7) it is possible to express the Peltier coefficient II and the Thomson coefficient r through a and  $\frac{da}{dT}$ . In particular, when  $\frac{da}{dT} = 0$ ,  $r_1 = r_2$  and therefore the quantities of Thomson heat generated in the two hranches of the thermocouple are equal and opposite in sign. The Thomson heat generated in a closed circuit is

$$q = (r_1 - r_2) I(T_1 - T_2),$$

and the Peltier heat is

$$Q = aIT$$
.

The higher  $(T_1 - T_2)$  as compared with T, the greater is the relative part played by Thomson heat.

It would appear that purely thermodynamic considerations make possible not only the establishment of a relationship between II, r, and a, but also the determination of the actual value of a. In fact, let us consider a junction between two electronic conductors through which passes I coulomb of electricity, at an infinitesimally slow rate, so that the current I is infinitesimally small; the temperature of the whole circuit is assumed to be constant and equal to T. In such a circuit there is no heat conduction or Joule heat loss and the whole circuit may he regarded as a system in equilibrium in which all processes change their sign with the change of the sign of I.

Equilibrium of two conductors implies an equilibrium of their chemical potentials  $\mu$ . We shall regard  $\mu$  as referring to one electron and equate it to free energy U - TS:

$$\mu = U_1 - TS_1 = U_2 - TS_2 = U - TS$$

On the other hand, the average energies U of electrons in two conductors in contact are different and their entropies S are also different, viz

$$S_1 - S_2 = \frac{U_1 - U_2}{T}$$

When an electron passes through the boundary its energy changes by an average of  $U_1 - U_2$ ; it is this energy that is generated in the form of of Peltier heat  $\Pi_{1-2}$ . Hence

$$S_1 - S_2 = \frac{\prod_{1-2}}{T} = \alpha_{1-2}$$
 (8)

It might have been expected that the thermal emf a at the houndary between two electronic conductors could be determined as a difference of entropies of 1 coulomb of electricity in the two conductors. This assumption is, however, not entirely correct: in the equilibrium state the electron velocity distribution follows a certain statistical law. In a stream of electrons the velocity distribution changes; for example, fast electrons pass from one conductor into another in a larger number than slow electrons. Electrons which remain in the first conductor restore the statistical equilibrium which brings about a further change of entropy. Therefore the entropy flux from one substance into another is not equal to the difference of the entropies in ench of the substances before the exchange of the electrons. Equation (8) may only he regarded as an approximation. Calculation of the exact value of  $a_{1-1}$  is, therefore, only possible starting with the consideration of the mechanism of electron transfer.

Let j denote the current of electrona through the boundary between two substances; this current consists of currents of electrona with all values of kinetic energy  $\epsilon$ :

 $j \propto \int_{0}^{\infty} j(\epsilon) d\epsilon$ .

The average value of the energy of electrona in the current is

$$\overline{\epsilon} = \frac{\int_{-\infty}^{\infty} \epsilon j(\epsilon) d\epsilon}{\int_{-\infty}^{\infty} j(\epsilon) d\epsilon}.$$

Let  $f_0(\epsilon)$  denote the equilibrium energy distribution function of the electrons and  $l(\epsilon)$  the free path length of an electron with an energy  $\epsilon$ ; the current j can then be represented in the form

$$j = C \int_{0}^{\infty} \frac{df_0(\epsilon)}{d\epsilon} \, l(\epsilon) \, \epsilon \, d\epsilon.$$

This expression is equally true for a current of gaseous molecules. Substituting it into the equation for  $\bar{\epsilon}$  we obtain

$$\overline{\epsilon} = \frac{\int_{0}^{\infty} \frac{df_{0}(\epsilon)}{d\epsilon} \, l(\epsilon) \, \epsilon^{2} \, d\epsilon}{\int_{0}^{\infty} \frac{df_{0}(\epsilon)}{d\epsilon} \, l(\epsilon) \, \epsilon \, d\epsilon} .$$

If S is the flow of entropy with the passage of one electron, then the flow of entropy  $\frac{S}{e}$  corresponding to 1 coulomb of electrical charge, on which the value of  $\alpha$  depends, will be described by the expression

$$\alpha = \frac{S}{e} = \frac{1}{e} \left( \frac{\overline{\epsilon}}{T} - \frac{\mu}{T} \right) = \frac{k}{e} \left( \frac{\overline{\epsilon}}{kT} - \frac{\mu}{kT} \right).$$

Using the notation  $\frac{\epsilon}{kT} = \epsilon^*$  and  $\frac{\mu}{kT} = \mu^*$ , we have

$$\alpha = \frac{k}{e} \left[ \int_{0}^{\infty} \frac{df_0(\epsilon^*)}{d\epsilon^*} l(\epsilon^*) \epsilon^{*2} d\epsilon^* - \mu^* \right]. \tag{8a}$$

The Peltier heat  $\Pi = \alpha T = \frac{1}{e}(\overline{\epsilon} - \mu)$ .

These are the most general expreasions for the thermal emf and the Peltier coefficient which are valid both for degenerate and non-degenerate semiconductora and metala.

1.3 Statistical theory. At the beginning of this century, the theory of metala was based on the concept of the presence in each metal of a certain concentration of free electrons n, different for differing metals, moving at random within the metal in a similar way to gas molecules. According to theae theories (Rieke, Drude, Lorentz and Debye) electrons were governed by the same Boltzmann atatistics as gaseous molecules. As in a gas their average translation energies were regarded as equal to  $\frac{3}{2}kT$  where k is the Boltzmann constant and T the absolute temperature.

The thermal emf V in an open circuit consisting of two metala, calculated according to this theory, was

$$V = \frac{k}{e} \int_{T_1}^{T_2} \log \frac{n_2}{n_1} dT.$$

It can be readily calculated that, e.g., when  $\frac{n_2}{n_1} = 2.7$ ,  $V = 86 \times 10^{-6} (T_2 - T_1)$  value, and  $\alpha = 86 \ \mu V/\deg$ , which is much higher than the experimentally observed value of  $\alpha$  in cases where one would expect that  $\frac{n_2}{n_1} > 2.7$ .

For the majority of metala  $\alpha$  does not exceed a few  $\mu V/deg$ .

The quantum theory of metala developed in 1927-1928 by Ya. I. Frenkel' in one form and by A. Sommerfeld in another form eliminated this discrepancy as well as many othera.

According to the theory of Sommerfeld who applied Fermi-Dirac quantum minimization to electrons in metala, the thermal emf between two metals is to a first approximation (taking into account only linear terms) equal to some. Only the next approximation leads to a certain finite, although very muntly, value of a. All this is not surprising. Let us consider a metallic and, the ends of which are at different temperatures. Since the temperature does not change the concentration of electrons n in the metal but brings about only a slight redistribution of their thermal agitation velocities, it is obvious that a large thermal emf cannot arise in such a metal.

The state of semiconductors in the quantum theory is aimilar to that all the classical metal considered at the beginning of the 20th century.

The classical metal considered at the beginning of the 20th century.

The classical metal considered at the beginning of the 20th century.

The classical metal considered at the bound of the concentration of free electrons in semiconductors varies but is usually so much similar than in metals that the Boltzmann classical statistics are applicable. A rise of temperature leads to a change in both the concentration of free electrons and their binetic energy which, as in the case

of gas molecules, may be equated to  $\frac{3}{2}kT$ . Let us consider a rod of semiconductor in which there is a temperature gradient  $\frac{dT}{dx}$ . At the hot end of the rod both the concentration and the velocities of the electrons are higher than at the cold end. Therefore more electrons will start to diffuse in the direction of the temperature gradient than in the opposite direction. The diffusion flux, carrying the negative charge away from

the hot end and transferring it to the cold end, acta up a potential difference hetween the enda.

The diffusion process is increasingly retarded by the electrical field in the interior of the semiconductor until the flux of electrous caused by diffusion ia equal to the reverae flux caused by the potential difference which has ariaen. Under these conditions a dynamic electron equilibrium in the semiconductor will he eatablished, under which the temperature difference hetween the enda of the roda will maintain a corresponding potential difference.

The number of electrona pasaing through any croas-section of the conductor in a unit time in hoth directions is equal. However, the velocities of electrons proceeding from the hot end are higher than the velocities of electrons passing through the given section from the cold end. This difference ensures that there is a continuous transfer of heat energy in the direction of the temperature gradient without any actual charge tranafer.

The heat transfer mechaniam is authorantially different when negative (electrona) and positive (holes) charge carriers participate simultaneonaly in the current. Simultaneous transfer of equal numbers of holes and electrong does not lead to an accumulation of the charge and an incrense of the potential. Simultaneous diffusion of electrons and holes from the hot end to the cold end is caused not only by the difference in the carrier velocities hut slao by their concentration gradieut.

In the case of such a hipolar diffusion s thermal emf can also arise due to the following two factora:

- 1) When the concentration of one type of carrier (e.g. negative) exceeds the concentration of the opposite type of carrier the flux of the first type of carrier will carry towards the cold end predominantly a charge which will retard their motion and, converaely, accelerate the carriers of the opposite aign until the fluxea of both carriers are equal; an electric field governed by the temperature gradient will thus he estahliahed.
- 2) The difference of charge carrier mobilities forms the second acurce of thermal emf'a. The mobility u is related to the diffusion coefficient D by the universal relationship established by Einstein:

$$\frac{u}{D} = \frac{\sigma}{kT}$$

Under the effect of the concentration gradient set up by the temperature gradient, the curriers characterised by higher values of u and D would have moved forward had they not created a space charge on becoming separated from the carriers of opposite aign. The corresponding electric field E returds their motion and accelerates the alower carriers of the opposite sign. The electric field E equalises the velocities of both types of carrier enabling them to diffuse as a single hody.

Therefore, even when thermal agitation creates an equal number of current carriera of each aign, their diffusion produces an electric field in the conductor depending on the difference in carrier mobilities. The expression for this electric field E will be similar to that for the diffusion of iona in an electrolyte, namely

$$E = E_0 \frac{u_1 - u_2}{u_1 + u_2} .$$

where Ep is the electric field which would have existed in the presence of current carriers of one aign only, and u, and u, are the mobilities of positive and negstive charges.

The advantage of semiconductors when used as msterials for themoclements ia due to their higher valuea of thermal emf. We shall try to explain the resears for this property of semiconductors.

In metala the concentration of free charge carriers ia high (of the order of 10<sup>22</sup> cm<sup>-3</sup>) and does not depend on temperature; the kinetic energy of the highly degenerate electrons is virtually independent of temperature, and the same applies to the contact potential of the metal at its houndaries. Under anch conditions thermal emf's as a rule do not exceed a few µV per °C.

In aemiconductora, however, temperature has a pronounced effect on the concentration n and kinetic energy e of free charge carriers, whilat the absolute value of the concentration is smaller by a few orders of magnitude ( $10^{14}$  to  $10^{20}$  cm<sup>-3</sup>). The contact potential  $\phi$  of semiconductora with respect to metala and the corresponding chemical potential  $\mu$  are also functions of temperature. Thermal emf's amount in this case to hundreds of  $\mu V/^{\circ}C$ .

What part does each of the above enumerated factors (low concentration, and the temperature dependence of the concentration, kinetic energy and contact potential) play in the appearance of high thermal emfa?

In the volume of a semiconductor the temperature gradient acts up a diffusion flux due to the concentration gradient  $\frac{dn}{dx}$  and the gradient of

the mean kinetic energy of free charge carriers  $\frac{d\epsilon}{dx}$ . When the charge

carriers are of one sign, the diffusion flux which transports them sets up an electric field E counteracting the diffusion. In the equilibrium state the electrical current produced by the field E balances the diffusion flux.

We shall consider separately the phenomena occurring in the bulk of the semiconductor and at its boundaries.

A temperature gradient may produce a unidirectional diffusion flux in two ways: 1) because of a concentration gradient of free carriers  $\frac{\partial n}{\partial x}$ ,

when n = f(T); and 2) because of variation of the coefficient of diffusion D with temperature. Variation of D with temperature may in turn stem from two canses: a) D may depend on the temperature T of the medium in which the carriers move; and h) D may vary depending on the velocity v or kinetic energy  $\epsilon$  of electrons transported by diffusion.

It will readily he seen that thermal agitation in the medium and its temperature T cannot by themselves produce a unidirectional flow of charge carriers, whilst in each portion of the solid an equilibrium thermal agitation is established corresponding to temperature  $T_m$ . Therefore  $\frac{\partial D}{\partial T_m}$  does not lead to the appearance of a thermal emf.

On the other hand, dependence of the coefficient of diffusion on the kinetic energy of electrons  $\frac{\partial D}{\partial \epsilon}$  may give rise to a unidirectional flow of carriers. even at a constant concentration n, when in addition to the temperature gradient  $\frac{dT}{dx}$  there exists also a kinetic energy gradient  $\frac{d\epsilon}{dx}$ . In fact, when the coefficient of diffusion of the carriers (electrons and holes) increases with rising temperature, i.e. when  $\frac{\partial D}{\partial \epsilon} > 0$ , more carriers will pass through each cross-section in the direction from the hot end to the cold end than in the reverse direction. The carriers will accumulate at the cold end, setting up an electric field  $E_D$  which will balance the diffusion flux. Conversely, when  $\frac{\partial D}{\partial \epsilon} < 0$ , the diffusion flux directed from the cold end to the hot end will predominate; charge carriers will accumulate at the hot end and the sign of the field  $E_D$ , and therefore also of the corresponding part of thermal emf  $a_D$ , will be opposite.

Therefore the equilibrium condition for carriers in an insulated specimen with free non-degenerate carriers of one sign may be expressed in the form

$$E u n = D \frac{dn}{dx} + n \frac{dD}{dx}$$

where u is the mobility of free carriers.

1. We shall first consider a special case of a semiconductor in which n = const and  $D = f(T) = F(\epsilon)$ . Let  $E_D$  be the electric field in this case and  $a_D$  the corresponding thermal emf.

The equilibrium condition becomes:

$$E_D u n = n \frac{dD}{dx} = n \frac{\partial D}{\partial \epsilon} \frac{d\epsilon}{dx}.$$

Using Einstein's relationship

$$\frac{u}{D} = \frac{e}{kT}$$

we obtain

$$E_D \frac{dx}{d\epsilon} = \frac{k}{e} T \frac{1}{D} \frac{\partial D}{\partial \epsilon}.$$

In order to express the dependence of D on T we shall use the familiar properties of mobility u which is interrelated with D. The mobility of electrons is proportional to the time r required by the electrons to cover the mean free path, and

$$r = \frac{\overline{l}}{v} \propto \frac{\overline{l}}{\sqrt{\epsilon}}$$

where  $\overline{l}$  is the mean free path length.

The relationship hetween  $\overline{l}$  and  $\epsilon$  depends on the conditions of scattering of free charge carriers; it varies depending on the nature of the chemical binding forces, lattice defects, and impurities, and is usually expressed in the form

We have therefore

and since T a c.

$$D \propto uT \propto \epsilon^{(r+\frac{1}{2})}$$

$$\frac{1}{D}\frac{\partial D}{\partial r} = \frac{1}{r}(r + \frac{1}{2}).$$

Substituting this value in the equilibrium condition, we obtain

$$a_D = E_D \frac{dx}{dT} = \frac{k}{e} (r + \frac{1}{2})$$

2. Let us now put D = const and n = f(T); the corresponding component of therms l emf will be denoted by  $a_n$ . We then have

$$Eun = \frac{D\partial n}{\partial x} = D\frac{\partial n}{\partial T}\frac{\partial T}{\partial x}$$

$$\alpha_n = E \frac{dx}{dT} = \frac{k}{e} T \frac{\partial \ln n}{\partial T}$$

3. Finally, let us consider the effect of the temperature dependence of the contact potential  $\phi$  on the thermal emf  $a_{\phi}$ ; this dependence is determined by the temperature dependence of the chemical potential  $\mu$  since

 $\frac{\partial (\phi e)}{\partial T} = -\frac{\partial \mu}{\partial T}$ 

where

$$\mu = kT \ln \left\{ \frac{n h^3}{2 (2 \prod m kT)^{\frac{3}{2}}} \right\}$$

$$\frac{\partial \mu}{\partial T} = -k \left( \frac{3}{2} + \frac{\mu}{kT} - T \frac{\partial \ln n}{\partial T} \right)$$

$$\alpha_{\phi} = \frac{\partial \phi}{\partial T} = + \frac{k}{e} \left( \frac{3}{2} + \frac{\mu}{kT} - T \frac{\partial \ln n}{\partial T} \right).$$

It will be seen that the expressions  $a_n$  and  $a_\phi$  contain the term  $T \frac{\partial \ln n}{\partial T}$  which is governed by the temperature dependence of concentration. However, in the expression for the total thermal emf

$$\alpha = \alpha_D + \alpha_n + \alpha_{\phi} = \frac{k}{e} \left( r + 2 + \frac{\mu}{kT} \right)$$

this term cancels out. The potential difference produced by the concentration gradient in the hulk of the semiconductor is balanced by the difference of the contact potential at its boundaries. The experimentally

observed thermal emf is not related to the temperature dependence of the concentration of the current enriers  $\frac{\partial n}{\partial T}$ . On the other hand, the absolute value of the concentration n appears in the expression for a, through the chemical potential, in the form  $\ln n$ . In the subsequent considerations we shall frequently employ the dependence of a on  $\ln n$  and plots using an coordinates  $a = f(\log n)$ , and n.

All this is confirmed by the example of semiconductors in which the concentration of electrons (small in comparison with that in metals) remains constant in a wide temperature range. Semiconductors of this type include, for example, lead sulphide and lead telluride containing un excess of lead. Despite the constant concentration, the thermal emf is of the order of hundreds  $\mu V/\deg$ , i.e. of the same order as in semiconductors with a pronounced temperature dependence of concentration.

The difference in electron velocities at the hot and cold ends of the memiconductor leads, however, to the appearance of a potential difference between the two ends. The higher the electron concentration in the memiconductor, the lower is the electric field E required for transferring the same number of electrons as that which diffuses owing to the difference in the velocities at the hot and cold ends of the rod.

The thermal emf a per 1°C msy he regarded as an entropy flux of a coulomb of electrical charge. As we have seen, the value of a dependent only on the entropy difference between two substances or two portions of a single conductor at different temperatures, but also on the conditions of the motion of the electrons. These conditions msy, in turn, depend on the nature of the semiconductor, and on the mechanism of electron scattering in the transfer of electrons from one portion of the semiconductor to another. Therefore, the value of a is closely related to the mobility u which is governed by the same scattering mechanism.

On the other hand, the scattering mechanism, and therefore also the values of u and a in anisotropic crystals (with the exception of crystals with cubic symmetry), depend on the direction. Therefore, s thermal emf appears between two rods cut out from the same crystal in different crystallographic directions, and Peltier heat is generated when current in passed through such s couple. When the current lines within a homogeneous crystal are bent, Peltier heat is generated everywhere where the current lines have a curvature. This is the so-called Bridgman effect.

The most important factor for all applications of thermoelectricity is the experimental fact that there are semiconductors with current carriers of opposite sign. Experience shows that when one end of a semiconductor and is heated and the other end cooled there will appear in some substances an electric field directed from the hot end to the cold end, whilst

in other substances the field will have an opposite direction, as if, in the first case, negative electrons diffused from the hot end to the cold end, and, in the second case, the diffusion of positive carriers took place. This effect is explained by the quantum theory as a result of the incomplete saturation by electrons of all the normal quantum states. Vacant quantum states behave in the same way as free electrons possessing a positive charge. They have been named 'holes'.

The term 'free' as applied to electrons and holes should not be considered in the literal sense. Their movements in the crystal lattice only resemble the movements of charges in an air-free space. The powerful electric fields set up by atoms, ions, and dipoles in the crystal lattice affect, however, the laws of motion. The band theory of semiconductors leads to the conclusion that in two cases: 1) when the electrons in the conduction band occupy a small number of quantum states, and 2) when only a small number of vacant states (holes) remains in the valence band the average velocities of electrons and holes obey the same laws of electrodynamics as free charges in vacuo, although with the distinction that these charges should be credited with a different mass from that of a free electron  $(9.1 \times 10^{-28} \text{ gm})$ . The charge of electrons and holes, e, in the bulk of the crystal should be taken as  $-1.6 \times 10^{-19}$  coulombs for electrons and  $+1.6 \times 10^{-19}$  conlombs for holes. Thus, for example, the accelera-

tion a produced by the electrical force Ee is not equal to  $\frac{Ee}{m}$  where m is the free electron mass. The acceleration  $\overline{a}$  for the mean velocity of motion extending over a number of crystalline cells may, however, be regarded as proportional to the applied force:

$$\overline{a} = Ee \frac{1}{m^*}.$$

The value of  $m^*$  is not equal to m but is called the 'effective mass'. The ratio  $m^*/m$  depends on the structure of the crystal and its dielectric constant and, in anisotropic crystals, also on the direction of motion.

This should not, however, be interpreted in the sense that inside a crystal lattice the electron possesses a different real mass, a different weight, or a different zero energy  $U=m^*c^2$ . Neither the inertia nor the weight of electrons in metals are different from the inertia and weight of free electrons, and it is these quantities that determine the real mass of any given body. The presence in a semiconductor of electrons with a very high effective mass does not lead to any increase of its weight.

Similarly, the movement of positive holes does not mean that there are free positive charges in the body. When a body is made to rotate very quickly it is found that the free charges in it possess inertia. These charges are found, however, to be negative electrons with the

name charge to mann ratio  $\frac{e}{m} = 1$ , its  $-10^{\circ}$  coul/gm as that for free electrons, even in the case of conductors with a purely hole-type mechanism of conductivity.

Therefore the concepts 'linle' and 'effective mass' should be regarded as convenient auxiliary means of simplifying complicated statistical infallations of the behaviour of a large number of electrons in the periodic lattice field. All departures from periodicity, due either to the thermal agitation of atoms, geometrical defects, or extraneous impurities, affect the uniform and, on the average, rectilinear motion of an electron in a crystal which is subjected to an external electric field. All such imperfections introduce a certain probability of deviation of the electron path from the direction of the electron before meeting the given distortion of the periodicity.

Therefore, distortions are found to act as electron scattering centres. The greatest distortions of the regular lattice structure produce very pronounced scattering, following which all electron velocity directions become equally probable, regardless of the direction of the electron motion hefore encountering the distortion. Weaker non-homogeneities produce probabilities of deflections through smaller angles, but after a few such collisions the initial direction of motion censes to have any proference. The aggregate of distortions satisfying this last condition may be summed up by the concept of the 'scattering centre'.

The path of a carrier from one scattering centre to another or to a distortion at which it loses its kinetic energy, giving it up to the crystal lattice, is called 'the free path length' of the electron or hole. Buth the effective mass and the free path length in one and the same crystal are different for an electron and for a hole.

When n closed thermocouple circuit is composed of semiconductors with the same (electronic- or hole-) type conductivity mechanism, the emil's produced by the temperature difference are directed in both arms of the thermocouple from the bot to the cold junction or vice versa. I herefore, they oppose each other in the circuit, and the thermoelectric vultage is equal to their difference:

$$E = (a_1 - a_2)(T_1 - T_2).$$

On the other hand, when the thermoelectric circuit consists of an alectronic and a hole type conductor, their thermal emf's are additive:

$$E = (a_1 + a_2)(T_1 - T_2).$$

It is evident that such a combination of combustors passesses substantial advantages.

Electronic and hole type conductors exist not only among semiconductors hut also among metals, but the physical meaning of 'holes' in metal is more difficult to fit into a band scheme. According to this scheme, in the valence hand of the metal there should remain only a small number of quantum states unoccupied by electrons, whilst, in fact, metals represent substances in which the valence hand is only partly filled. Nevertheless, one has to consider that metals such as tungsten, molybdenum, zinc, etc. exhibit purely hole type conductivity, whilst lead and tin exhibit a mixed bole and electronic conductivity.

The type of current mechanism in a given conductor may he determined not only on the basis of the sign of the thermal emf hut also from the direction in which the current carriers are deflected by a magnetic field perpendicular to the direction of the current. The laws of electromagnetism (e.g. the rule of the three fingers of the left hand interrelating the directions of deflection, magnetic field, and current) govern the direction in which the magnetic field deflects the carriers, regardless of whether the current is due to the flow of electrons from left to right or of holes from right to left. When the current carriers are electrons, the portion of the conductor towards which the current is deflected by the field becomes negatively charged with respect to the opposite side; when the current is produced by the holes, the side towards which the current is deflected is charged positively.

This phenomenon is known as the Hall effect. Experiment shows that measurements of the thermal emf and the Hall effect always yield the same current carrier signs, provided the current consists of charges of one sign only.

In conductors with mixed conductivity hoth the thermal emf's of holes and electrons, and potential differences produced by them in a magnetic field oppose each other and are therefore small. The quantitative rules of such a subtraction differ somewhat for the two phenomena. Thus, denoting hy  $n_+$  and  $n_-$  the concentrations of boles and electrons and by  $u_+$  and  $u_-$  their mobilities, i.e. their average drift velocities in an electric field of 1 V/cm, we obtain for the Seeheck effect

$$a \propto \frac{n_{+}u_{+} - n_{-}u_{-}}{n_{+}u_{+} + n_{-}u_{-}}$$

On the other hand the emf produced by the Hall effect is given by the expression

$$E_H \propto \frac{u_+^2 n - u_-^2 n}{(u_+ n_+ + u_- n_-)^2}$$

In the special case where  $n_+ = n_-$  and  $n_+ = n_-$  both a and  $F_H$  become squal to zero. The converse deduction that when  $E_H = 0$ , then also  $\alpha = 0$  cannot be regarded with confidence. In metals, however, it is possible to consider with sufficient accuracy that  $n_+ \approx n_-$  and therefore to assume that when  $E_H = 0$  then, also,  $n_+ \Rightarrow n_-$ , i.e. to expect that  $\alpha = 0$ .

We meet with this state of affairs in the case of metals Pb and Sn for which  $E_H$  is extremely small and changes sign when going over from Pb to Sn. This allows us to assume that the case a=0 is somewhere between  $ap_b$  and  $a_{Sn}$  which differ only by 0.2  $\mu V/\deg$ . The values of thermal emf's referred to this zero value may be regarded as the absolute values of the thermal emf coefficients.

The difference between the absolute values of  $\alpha$  determined from  $T = \int_{0}^{T} \frac{r}{T} dT$  for the normal silver alloy and from the assumption that

the menn value between  $a_{\rm Pb}$  and  $a_{\rm Sn}$  can be regarded as a=0 amounts to about 1  $\mu V/{\rm deg}$ , as follows from the comparison of Justi's table which was based on first definition, with Meisner's table which was calculated on the basis of the second definition.

Even in metals the value of a is very sensitive to the presence of the smallest amounts of impurities and therefore the two series do not fully coincide, both as far as the absolute value of a is concerned, and also with regard to the order of metals in the thermoelectric series (e.g., the positions of Cu, Pt, Au, Nos. 1-4, see p. 3).

In semiconductors impurities play a decisive role as may be seen from Meisner's second series reproduced on page 3 in which quite different values are given for one and the same compound. Thus, for example, the values listed for Cu<sub>2</sub>O are 474, 1000, 1120 and 1150  $\mu$ V/deg and for Fe<sub>2</sub>O<sub>3</sub> -613 and -60  $\mu$ V/deg.

As we shall see later, the introduction of impurities into semiconductors opens up a way for the improvement of their thermoelectric properties.

1.4 Calculation formulae. In this paragraph we are giving formulae for the calculation of the thermal emf per 1°C,  $\alpha$ , without giving any proofs. Detailed information on this subject will he found: 1) in part II of the article by A. G. Samoilovich and L. L. Korenhlit (Uspekhi Fizicheskikh Nauk, 1953, 49, No. 2-3); 2) in part I of the article hy V. l. Davydov and l. M. Shmushkevich (ihid, 1940, 24, No. 1); and 3) in the hook by A. F. loffe "The Physics of Semiconductors", published hy the Academy of Sciences in 1957.\*

The other thermoelectric coefficients, namely the Peltier coefficient

English translation, Infosearch, London, 1958.

II and the Thomson coefficient r mny, no we have seen earlier, be derived from the expression for a.

For metals, in particular monovalent metals, the quantum theory yields the following relationship

$$\alpha = \frac{1}{3e} \pi^2 k^2 T \left[ \frac{1}{\mu} + \left( \frac{1}{l} \times \frac{dl}{d\epsilon} \right) \right]. \tag{9}$$

Here  $\mu$  is the chemical potential of electrons, which in the case of metals is equal to the Fermi level energy, and l is the free path length of electrons with a kinetic energy  $\epsilon$ . For metals one may assume that

$$l \propto \epsilon^2$$
, (10)

and since the electrons contributing to the current have predominantly  $\epsilon \approx \mu$ , we have

$$\frac{1}{\mu} + \frac{1}{l} \times \frac{dl}{d\epsilon} = \frac{3}{\mu},$$

whence

$$\alpha = \frac{1}{e} \pi^2 k^2 T \frac{1}{\mu} = \pi^2 \frac{k}{e} \times \frac{kT}{\mu}. \tag{11}$$

The value of  $\mu$  is almost independent of temperature and therefore in monovalent metals  $\alpha$  is proportional to the absolute temperature T:

$$\alpha = T$$
. (12)

Expression (11) gives an order of magnitude of

$$\alpha \approx 10.86 \frac{3 \times 10^{-2}}{5} = 5.2 \,\mu\text{V/deg}$$

which is in good agreement with experimental data.

An exception here is lithium for which  $\alpha=41\,\mu\text{V}/\text{deg}$ . A. G. Samoilovich and F. Serova have shown that in this case there takes place, in addition to the diffusion of electrons, a dragging of current carriers by thermal waves (phonons) from the hot to the cold end of the conductor and the term  $\frac{1}{l} \times \frac{dl}{d\epsilon}$  acquires the value  $-\frac{2.8}{\epsilon}$  as compared with  $+\frac{2}{\epsilon}$  for the majority of metals. The possibility of dragging of electrons by phonons was first pointed out by L. E. Gurevich.

In semiconductors one has to take into account the possibility of the existence of both free electrons with a concentration a and holes with a concentration  $n_4$ . The thermal emf's produced by the electrons and the holes have opposite signs and therefore one is subtracted from the other. In this case the thermal emf is given by the following expression

$$\alpha = \frac{1}{T\sigma} \left[ u_{-}n_{-}(2kT - \mu) - u_{+}n_{+}(2kT - \mu + \Delta E) \right],$$

where  $\sigma$  is the specific electrical conductivity, u the mobility and  $\Delta E$  the width of the forbidden energy band.

N. L. Pisnrenko derived an expression for a which is more convenient for computation purposes

$$u = \frac{k}{\sigma} \left\{ u_{-} n_{-} \left[ A + \ln \frac{2(2\pi m_{-}^{*} kT)^{\frac{3}{2}}}{h^{3} n_{-}} \right] - u_{+} n_{+} \left[ A + \ln \frac{2(2\pi m_{+}^{*} kT)^{\frac{3}{2}}}{h^{3} n_{+}} \right] \right\}.$$
(13)

the value of the constant A depends on the electron scattering mechanism, and in particular on the value of  $\frac{1}{l} \times \frac{dl}{d\epsilon}$ . The latter is in turn governed by the character of scattering centres.

In crystals with an atomic lattice with covalent binding the thermal vibration spectrum consists of acoustic vibrations, the frequencies of which are initially (at the low frequencies and long wavelengths which play the main rôle in the interaction with slow electrons) proportional to their momentum. For such crystals

$$\frac{dl}{d\epsilon} = 0$$
,  $l = \text{const.}$  (44)

In crystals with an ionic lattice the electrons are principally scattered by electromagnetic polar vibrations in which positive and negative ions move in opposite directions. The most important of these 'optical' vibrations are the longitudinal vibrations producing an accumulation of charges in some parts and a reduced density of charges in other parts. This lends to the appearance of most powerful electric fields deflecting the moving electrons.

In ionic crystals it is necessary to consider two temperature ranges:

1) temperatures at which the average kinetic energy of electrons hT is much lower than the energy of antural vibrations of the ions  $h\nu_0$  (these vibrations correspond to the residual rays); at these temperatures, which are below the Debye temperature  $\theta$ , we have at  $kT << h\nu_0$ 

 $l = l_0 \sqrt{\frac{\epsilon}{h\nu_0}} e^{\frac{h\nu_0}{kT}}; \qquad (15)$ 

2) on the other hand, at high temperatures when  $kT >> h\nu_0$ 

$$l \propto \epsilon$$
. (15a)

At temperatures above the Debye temperature, when  $kT >> h\nu_0$ , the electrons in many crystals interact with vibrations of a frequency which changes little with the increase of the momentum of the atoms, so that

$$l \propto \epsilon^{-1} \tag{16}$$

Electron scattering centres need not only result from the thermal vibrations, i.e. the interaction of electrons with phonons; any other distortions of the crystalline lattice may form scattering centres. Of these it is the presence of ionised impurity atoms that is of the greatest importance. In this case, we have as in metals

$$l \propto \epsilon^2$$
. (17)

Scattering on neutral atoms is usually small; it corresponds to

$$l \propto \epsilon^{1/2}$$
 (18)

Shear strains in deformed crystals and geometrical defects also produce electron scattering. However, the number of affected places is usually too small to produce a noticeable effect in comparison with other sources of scattering.

When various scattering sources are present in a crystal lattice they can be replaced with sufficient accuracy by scattering with a path length L satisfying the following equation

$$\frac{1}{L} = \sum_{l} \frac{1}{l} . \tag{19}$$

The constant A in expression (13) acquires, depending on the type of relationship between l and  $\epsilon$  or between mobility u and temperature T, the following values.

For atomic lattices

$$l \propto \epsilon^0, \quad u \propto \frac{1}{T^{\frac{3}{2}}}, \quad A = 2. \tag{20a}$$

For lonic lattices at kT << hirst

$$l = l_0 \sqrt{\frac{\epsilon}{h\nu_0}} e^{\frac{h\nu_0}{kT}}, \quad u = e^{\frac{h\nu_0}{kT}}, \quad A = 2.5.$$
 (20b)

For ionic lattices at  $kT >> h\nu_0$ :

$$l = \epsilon, \quad u = \frac{1}{T^{\frac{1}{2}}}, \quad A = 3.0.$$
 (20c)

For senttering by vibrations of constant frequency

$$l \propto \epsilon^{-1}, \quad u \propto \frac{1}{T^{5/2}}, \quad A = 1.0$$

$$l \propto \epsilon^{-3/2}, \quad u \propto \frac{1}{T^{3}}, \quad A = 0.5.$$
(20d)

For scattering on impurity ions

$$l \propto \epsilon^2, \quad u \propto T^{\frac{3}{2}}, \quad A = 4.0.$$
 (200)

In general when  $l \propto e^r$ ,  $u \propto T^{r-\frac{1}{2}}$  and A = r + 2, when the scattering takes place on thermal fluctuations. When lattice defects which do not depend on temperature form the scattering centres,  $u \propto T^{r-\frac{1}{2}}$ .

The character of the binding forces which governs the dependence of l on  $\epsilon$  is difficult to determine. Therefore the value of r has to be nationated from the temperature dependence of mobility.

In practical applications of thermoelectric phenomena, the simultaneous presence of holes and electrons is undesirable if the hole and electron mobilities  $u_+$  and  $u_-$  do not differ much from each other. For those purposes it is also desirable to use semiconductors with high electrical conductivity. Both requirements are satisfied by the introduction of impurities into the semiconductor, creating either free electrons or holes.

For a semiconductor with current entriers of one type only, expression (13) may be simplified and replaced by the formula

$$u = \frac{h}{\pi} \left( A + \ln \frac{2(2n \, m^* k \, T)^{3/2}}{h^* n} \right). \tag{21}$$

Expressions for a may also be written down in a different form. For atomic lattices with current carriers of one type

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$$\alpha = \frac{k}{e} \left( 2 - \frac{\mu}{kT} \right) \tag{22a}$$

or, denoting by  $\Delta E$  the distance of the impurity level from the corresponding band edge, we have at  $\Delta E \gg kT$ 

$$a \approx \frac{k}{e} \times \frac{\Delta E}{2kT}$$
. (22b)

The last expression requires that the value of a should decrease with increasing temperature proportionally to  $\frac{1}{T}$  and tend to infinity as the temperature tends to absolute zero. This conclusion not only disagrees with experimental data, but is also at variance with the principles of thermodynamics according to which not only  $a(T)_{T=0} = 0$ , but also  $\left(\frac{d\,\alpha}{dT}\right)_{T=0}=0.$ 

This contradiction indicates that the approximations made in the derivation of expressions (21), (22a) and (22b) are inadequate and that some properties which manifest themselves at low temperatures have been neglected.

For ionic semiconductors

$$\alpha = \frac{k}{e} \left( 3 - \frac{\mu}{kT} \right). \tag{23}$$

The polaron model of ionic semiconductors evolved by S. I. Pekar leads to more complex functions  $l(\epsilon)$  and therefore somewhat different formulae for a. Pekar's theory is found to be well substantiated in the case of ionic semiconductors, when the electrons diffuse simultaneously with the polarisation of the surrounding medium. For a constant temperature T one can put according to Pekar

For practical purposes it is convenient to write expression (21) as a relationship between a and a both of which can be readily measured. By introducing an impurity or an excess of one of the components of the compound it is possible to vary the conventration a within wide limits without apprecially affecting the mobility u. Therefore the expression for a may be rewritten in the form

$$a = \frac{k}{e} \left[ A + \ln \frac{2(2\pi m^{\phi} kT)^{\frac{3}{2}} eu}{h^{\phi}} \right] - \frac{k}{e} \ln (neu)$$

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$$a = C - 86 \times 10^{-6} \ln \sigma = C - 2 \times 10^{-4} \log \sigma. \tag{24}$$

There is a large group of semiconductors with high electrical conduc-Hylty in which the concentration n does not vary with temperature. The affective mass m\* is also independent of temperature. According to exprennion (21) the temperature dependence of a for these materials lukum the form

$$\alpha = \frac{k}{e} \left[ A + \ln \frac{2(2\pi m^* k)^{\frac{3}{2}}}{h^{\frac{3}{2}}n} \right] + \frac{3}{2} \times \frac{k}{e} \ln T.$$
 (25)

in such cases expressions (24) and (25) are well substantiated by experiment. In the plot  $\alpha = f(\log \sigma)$  a is represented by a straight line with a slope of approximately  $2 \times 10^{-4}$  (see figs. 8 and 9, pp. 52 and 54). the temperature dependence of a at a given constant concentration a nlan vorresponds to a slow logarithmic rise of a with T.

With the increase of free electron concentration the system gradually thunges into the degenerate state when it is no longer possible to upply the limiting case of Boltzmann statistics in place of Fermi-Dirac statiatten, which in general govern the electrons.

These more general formulae yield for the concentration

$$n = \frac{4\pi (2m^*kT)^{\frac{3}{2}}}{h^3} F_{\frac{1}{2}} \left(\frac{\mu}{kT}\right). \tag{25a}$$

The most general expression for a for n given current carrier concennotion n of one sign has the form

$$\alpha = \left(\frac{k}{\sigma} \begin{bmatrix} r_{+1} & F_{r+1} \left(\frac{\mu}{kT}\right) \\ r_{+1} & T \end{bmatrix} - \frac{\mu}{kT} \right)$$
 (26)

In particular, for atomic lattices, in which r = 0

$$a = \pm \frac{k}{e} \left[ 2 \frac{F_1 \left( \frac{\mu}{kT} \right)}{F_0 \left( \frac{\mu}{kT} \right)} - \frac{\mu}{kT} \right]. \tag{26a}$$

 $F_{\frac{1}{2}}\left(\frac{\mu}{kT}\right)$ ,  $F_r\left(\frac{\mu}{kT}\right)$  and  $F_{r+1}\left(\frac{\mu}{kT}\right)$  in expressions (25a), (26) and (26a) denote Fermi integrals

$$F_r\left(\frac{\mu}{kT}\right) = \int_{e}^{\infty} \frac{x^r dx}{x - \frac{\mu}{kT} + 1}$$

where x is reduced energy of the electrons  $x = \frac{\epsilon}{kT}$ .

The values of the function  $F_r$  for a range of values of r, and expressions for  $\kappa$ ,  $\sigma$ , and  $\alpha$  are listed on pages 90-92.

Having studied the conditions of transition from Boltzmann statistics to Fermi statistics, K. S. Shifrin found that the effect of degeneracy becomes noticeable when  $\frac{\mu}{kT} > -2$  and when  $\frac{\mu}{kT} > 2$  the state of electrons must be regarded as strongly degenerate.

T. A. Kontorova has, however, shown that Pisarenko's expression (21) is of such a form that it does not lead to large errors up to values of  $\mu$ 

 $\frac{\mu}{kT}=1.$ 

All the foregoing considerations and formulae are based on the assumption that in a temperature gradient it is possible to regard the state of each small portion of material, containing a large number of atoms and electrons, as an equilibrium state, each portion only being described by different parameters. L.E. Gurevich showed in 1945 that this is not always true. The flux of phonons proceeding from the hot end to the cold end drags a larger number of electrons than that which follows from conditions of normal diffusion and an electric field. This factor may bring about an increase of the thermal emf.

In fact, soon afterwards, F. A. Serova and L. G. Samoilovich showed that the abnormally high thermal emf of lithium is due to the drag effect.

Elementary calculation of the possible drag effect in semiconductors, carried out in 1951 by G. E. Pikus, indicated that its influence on the thermal emf is negligible.

Experimental data for germandum and silicon have shawn, against expectations, that the phonon drug affect is very high at law temperatures.

The disagreement with Pikus's calculations is attributed to the fact that electrons do not interact with all the thermal vibration phonons but only a few phonons, the wavelengths of which are not less than the wavelength of the electrons, or, more precisely, the wavelength vector G of such a phonon should be less than double the wavelength vector K of the electron.

Phonons satisfying this requirement possess a much larger free path length and a much longer relaxation time than the bulk of the phonons in the solid. Moreover, these phonons possess the most narked directional properties along the temperature gradient. Therefore, the effect of dragging of electrons by such phonons is particularly large.

At extremely low temperatures the drag effect is small since the free path length of both phonons and electrons depends on the dimensions of the crystals from which the solid is composed. At higher temperatures muly the longwave phonons still retain a free path length of the order of the crystal dimensions. At still higher temperatures, the free path length of all phonons is smaller than the external dimensions, but the free path length of longwave phonons exceeds by many times its average value which governs the thermal conductivity of the solid. With a still further time of temperature this difference becomes less pronounced and at a sufficiently high temperature, for which Pikus's calculations are valid, it no longer has any effect.

Accordingly, the increase of thermal emf, above that given by the formulae listed above, becomes particularly pronounced in a certain temperature range - usually below room temperature - for germanium around  $100^{\circ}$ K and for silicon around  $100^{\circ}$ K; in the case of silicon  $\alpha$  reaches the value of  $50,000~\mu\text{V}/^{\circ}$ C. A complete theory of these phenomena has been given by C. Herring.

1.5 Experimental facts. A systematic study of thermal emiss of various semiconductors has been carried out by B. M. Gokhberg and M. S. Sominskii. Among the materials investigated by them there was only one substance, namely WO<sub>3</sub>, which satisfied equation (22b): in the temperature range from liquid air temperature (90°K) to 400°K the thermal runf was found to be inversely proportional to the absolute temperature.

In  $V_2O_5$  the relationship given by equation (22b) was only observed above  $-30^{\circ}\text{C}$  (240 K); below this temperature  $\alpha$  was proportional to the absolute temperature. The temperature dependence of  $\alpha$  may be plotted in the form of two intersecting straight lines by plotting  $\alpha$  vs. T up to  $240^{\circ}\text{K}$  and vs.  $\frac{1}{T}$  above  $240^{\circ}\text{K}$ . It is remarkable, however, that despite

the abrupt change is the temperature dependence of a the temperature dependence of resistivity does not undergo a noticeable change at 240°K. The function  $\log \rho = f\left(\frac{1}{T}\right)$  represents a straight line in the entire range from liquid air temperature (90°K) to 500°K.

In Cu<sub>2</sub>O  $\alpha$  is found to be independent of temperature from 90° to 355°C (or 630°K), whilst above 630°K it is inversely proportional to temperature. Andersen has shown that in this case the sudden change of slope from a straight line for  $\alpha$  against  $\frac{1}{T}$  at 630°K coincides with a change of slope in the graph  $\log \rho = f\left(\frac{1}{T}\right)$ . The constancy of  $\alpha$  below 630°K is at variance with theoretical predictions since here one would expect impurity conduction obeying expression (22b).

For tin sulphide (SnS) a is proportional to T at low temperatures; then a becomes constant, and at high temperatures it is proportional to  $\frac{1}{T}$ .

The temperature dependence of  $\alpha$  is even more complex in the case of  $\mathrm{Tl_2S}$ : at low temperatures  $\alpha$  increases with an increase of T, then it decreases, then it again increases, and at high temperatures it again decreases.

The aforementioned semiconductors possess relatively high resistivities and a wide forbidden band. Data are also available for several other semiconductors of this type.

Expression (22b), according to which a is proportional to  $\frac{1}{T}$ , is found to be valid only at elevated temperatures (above 600°K in Cu<sub>2</sub>O, above 700°K in BaO, and above 700°K in NiO). On the other hand, at low temperatures a is proportional to T, which is contrary to expression (22b) but in full agreement with the requirements of quantum thermodynamics. Such a temperature dependence of a was found to hold for SiC below 200°K, CdO below 700°K, SbS below 190°K, and Ge below 30°K, and also in SnS, TiO<sub>2</sub> and certain other materials.

At intermediate temperatures there is often a range over which  $\alpha$  is nearly constant; as has been mentioned earlier, this is true of Cu<sub>2</sub>O in the range 90 to 630°K.  $\alpha$  was found to be constant in MoS<sub>2</sub> from 300 to 500°K, in Bi<sub>2</sub>S<sub>3</sub> from 110 to 450°K, in SiC from 100 to 300°K, and in l'bS from 30 to 750°K. In this temperature range the two tendencies -  $\alpha$  proportional to T at low temperatures and  $\alpha$  proportional to  $\frac{1}{T}$  at high temperatures - appear to be balancing each other.

Modern theory of thermoelectric phenomena indicates that the thermal emf in impurity semiconductors with a non-degenerate system of electrons

can only decrease with rise of temperature. According to this theory a cunble proportional to temperature only in substances with degenerate electrons. In two cases (Ge and CdO), when such a temperature dependence of a was observed in semiconductors it was possible to demonstrate that the electrons were, as in metals, in a degenerate state.

There is, however, no remson to expect that in all semiconductors the electrons become degenerate as the absolute zero is approached, incidentally, close to the absolute zero a and even  $\frac{da}{dT}$  should tend to zero, where T tends to  $0^{\circ}K$ , the entropy approach T.

when T tends to  $0^{\circ}$ K, the entropy according to Nernst's theorem tends to zero, and, therefore,  $\alpha$  also tends to zero.

Experimental data are in good agreement with such an extrapolation of the function a = f(T), but so far no theoretical foundations for this behaviour are available. General empirical formulae describing thermodectric properties of semiconductors over a wide temperature range are also non-existent. It is only possible to state a qualitative rule according to which the thermal emf a of a semiconductor starting with a = 0 at T = 0 is at first proportional to T, then rises less steeply with T often remaining constant in a certain temperature range, and then it begins to decrease approaching the theoretical expression (22a).

All the semiconductors discussed above are materials with a high nemistivity ( $\rho > 1$  ohm × cm) which are unsuitable for use in high affiniously thermoelements. Data on semiconductors with low remintivity ( $\rho < 10^{-2}$  ohm × cm) are reported in the section dealing with thermoelements cooling and are discussed further on in this section (see pp. 41-72)

Since in order to calculate a it is necessary to know the effective mass of current carriers  $m^*$  and the scattering law, it is not possible to calculate a independently. The value of  $m^*$  may be estimated on the basis of several other properties of semiconductors: from the activation energy of impurities, the mobility, and magnetic and optical phenomena. The nature of the carrier scattering governs the temperature dependence of mobility.

The values of  $\alpha$  for specific semiconductors calculated on the basis of much information are found to be close to the results of direct measurements. A detailed analysis is given in the section on thermoelectric cooling.

Within the temperature limits with which we have been dealing so far the thermal emf theory outlined above may serve as a basis for calculations. All the calculated values of a are found to agree within experimental accuracy with the observed values.

### CHAPTER 2

### THERMOELECTRIC GENERATORS

2.1 Energetic principles of thermoelectric batteries. Let us consider a thermoelement (fig. 1), consisting of p-type (1) and n-type (2) semiconductor rods joined by a metallic bridge (3). An external resistance R is connected in the circuit across the cold ends of the thermoelement;

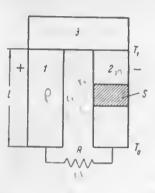


Fig. 1

this resistance acts as a load for the electrical energy generated. When the potential difference across the cold ends of the circuit is denoted by U volts, the power delivered by the thermoelement will be  $W = \frac{U^2}{R}$ , whilst the current  $I = \frac{U}{R}$ .

We shall denote the thermal emf, which is in this case equal to the sum of the thermal emf's of the two branches, by  $\alpha \text{ V/deg}$ ;  $\alpha = |\alpha_1| + |\alpha_2|$ .

The hot ends, joined by the bridge, are maintained at a temperature  $T_1$ , receiving heat energy from a source with a slightly

higher temperature. The cold ends are at a temperature  $T_0$ , slightly above the temperature of the surroundings or of the heat exchange medium.

We shall denote the internal resistances of the two branches by  $r_1$  and  $r_2$  and their thermal conductivities by  $K_1$  and  $K_2$ . Denoting the resistivities by  $\rho$ , the specific thermal conductivities by  $\kappa$ , and assuming that the lengths of both rods are equal to l, and their cross-section areas are  $S_1$  and  $S_2$ , we have

$$r = r_1 + r_2 = \left(\frac{\rho_1}{S_1} + \frac{\rho_2}{S_2}\right) l,$$

$$K = K_1 + K_2 = (\kappa_1 S_1 + \kappa_2 S_2) \frac{1}{l}.$$

On the basis of the general laws of thermoelectric phenomena we can calculate the Peltier heat generated and absorbed by the thermoelement

at its two ends, the Thomson heat generated or absorbed limide the rods, the heat transferred by conduction from the hot to the cold ends, the heat generated by the current in the rods, and the useful electrical energy delivered by the thermoelement. We shall refer to energy par second and express the power in watts. These units will also be used for purely thermal quantities; e.g. specific thermal conductivity will be expressed in W/deg × cm and not in cal/deg × cm × sec.

$$1 \text{ cal/deg} \times \text{cm} \times \text{sec} = 4.19 \text{ W/deg} \times \text{cm}$$

The amount of heat energy  $Q_i$  received by the hot junctions, due to the Peltier effect, is

$$Q_1 = \alpha_1 I T_1$$

The power Qo delivered at the cold junction is

$$Q_o = -\alpha_o I T_o$$
.

The Thomson heat Q generated in each rod is, according to equation (7),

$$Q = \pm \int_{T_0}^{T_1} T \frac{d\alpha}{dT} I dT.$$

In the special case, when  $\alpha$  at both ends has the same value, Q=0. The heat flux  $Q_h$  transferred from the hot junction to the cold junction through the two rods is

$$Q_h = K(T_1 - T_0).$$

The Joule heat generated in the two rods is  $Q_I = I^2 r$ . The useful power W delivered by the thermoelement is  $W = I^2 R$ ; the current is

$$I = \frac{\alpha (T_1 - T_0)}{R + r}$$

Putting

$$\frac{R}{r} = m, \qquad (27)$$

we have

$$Q_1 = \alpha_1^2 T_1 (T_1 - T_0) \frac{1}{r(m+1)}$$

$$W = \alpha^2 (T_1 - T_0)^2 \frac{m}{r(m+1)^2}.$$

For the time being we shall neglect the Thomson heat, regarding it as small in comparison with the other terms and shall assume  $a_1 = a_0 = \alpha$ . When  $a_1 \neq a_0$  the Thomson heat is accounted for in the determination of the efficiency by substituting for  $\alpha$  the mean value for the two ends  $\overline{\alpha} = \frac{a_1 + a_0}{2}$ .

Of the total Joule heat  $I^2r$  generated in the thermoelement, half passes to the hot junction, returning the power  $\frac{1}{2}I^2r$  and the rest is transferred to the cold junction.

The efficiency  $\eta$  will be defined as the ratio of the useful electrical energy  $l^2R$  delivered to the external circuit to the energy consumed from the heat source. The latter consists of the Peltier heat  $Q_1$ , and the heat  $Q_h$  transferred by conduction to the cold junction, from which it is necessary to deduct the electrical energy  $\frac{1}{2}l^2r$  returned to the heat source.

$$\eta = \frac{W}{Q_1 + Q_h - \frac{1}{2}I^2r} = \frac{\alpha^2 (T_1 - T_0)^2 \frac{1}{r} \times \frac{m}{(m+1)^2}}{\alpha^2 T_1 (T_1 - T_0) \frac{1}{r} \times \frac{1}{(m+1)} + K(T_1 - T_0) - \frac{1}{2} \times \frac{\alpha^2 (T_1 - T_0)^2}{r(m+1)^2}} = \frac{T_1 - T_0}{T_1} \times \frac{\frac{m}{m+1}}{1 + \frac{Kr}{\alpha^2} \times \frac{m+1}{T_1} - \frac{1}{2}(T_1 - T_0) \frac{1}{m+1}}$$

Thus the efficiency of the thermoelement is fully determined by a) the hot and cold junction temperatures; b) the quantity  $\frac{Kr}{\alpha^2}$  which depends on the properties of the materials used in the thermoelement and which will be denoted by  $\frac{1}{\epsilon}$ , so that

$$x = \frac{n^4}{K_L} \tag{20}$$

and, finally, c) the nelected ratio  $m = \frac{R}{r}$ 

In order to achieve as high an efficiency as possible in thermoelements at given values of  $\alpha$ ,  $\kappa$ , and  $\rho$  and an arbitrary ratio  $\frac{R}{r}=m$ , it is necessary to find the optimum cross-section areas  $S_1$  and  $S_2$ , so that at given values of  $\kappa$  and  $\rho$  the product Kr is minimum. To find the condition for a minimum of Kr we shall differentiate

$$K_r = (\kappa_1 S_1 + \kappa_2 S_2) \left( \frac{\rho_1}{S_1} + \frac{\rho_2}{S_2} \right) = \kappa_1 \rho_1 + \kappa_2 \rho_2 + \kappa_1 \rho_2 \frac{S_1}{S_2} + \kappa_2 \rho_1 \frac{S_2}{S_1}$$

with respect to  $d\left(\frac{S_1}{S_2}\right)$  and equate the derivative to zero. This given

$$\frac{\rho_1}{\kappa_1} \times \frac{\kappa_2}{\rho_2} = \left(\frac{S_1}{S_2}\right)^2 . \tag{29}$$

At this value of  $\frac{S_1}{S_2}$ 

$$K_r = (\sqrt{\kappa_1 \rho_1} + \sqrt{\kappa_2 \rho_2})^2$$

$$z = \frac{\alpha^2}{K_F} = \frac{\alpha^2}{(\sqrt{\kappa_1 \rho_1} + \sqrt{\kappa_2 \rho_2})^2} \deg^{-1}.$$
 (30)

This expression contains only the properties of the materials of the two branches of the thermoelement, but not their dimensions.

We shall now find the ratio  $\frac{R}{r} = m$  giving the highest efficiency. The condition for delivering the maximum power to the load leads, in the case of a thermoelement as with other current sources, to the requirement R = r, i.e. m = 1, and

$$\eta = \frac{1}{2} \frac{T_1 - T_0}{T_1 + \frac{2}{z} - \frac{1}{4} (T_1 - T_0)}.$$

We shall find the condition for the maximum efficiency by putting  $\frac{\partial \eta}{\partial m} = 0$ ; straightforward calculations give

$$\left(\frac{R}{r}\right)_{opt} = M = \sqrt{1 + \frac{1}{2}z(T_1 + T_0)}, \qquad (31)$$

where  $(T_1 z)$  and M are dimensionless numbers.

Substituting this optimum value of m, denoted here by M, into the expression for  $\eta$  we find

$$\eta = \frac{T_1 - T_0}{T_1} \times \frac{M - 1}{M + \frac{T_0}{T_1}}.$$
 (32)

Henceforward  $\eta$  will refer only to this maximum efficiency.

The first factor represents the thermodynamic efficiency of a reversible engine, and the second describes the reduction of this efficiency as a result of irreversible losses due to heat conduction  $(\kappa)$  and Joule heat  $(\rho)$  entering into the expression for z.

The greater is M in comparison with unity, i.e. the larger the values of z and  $T_1 + T_0$ , the smaller is the reduction of the efficiency due to irreversible losses. Therefore an increase of the hot junction temperature  $T_1$  increases  $\eta$  not only by increasing the value of the efficiency of a reversible engine  $\frac{T_1 - T_0}{T_1}$  but also because of the simultaneous increase of M at a given z.

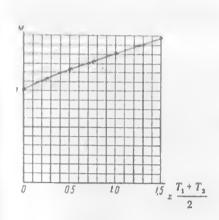
This equation also shows clearly that in order to achieve the maximum efficiency the material has to satisfy only one condition, namely the maximum value of z compatible with the maximum temperature  $T_1$  of the heat source, or more precisely the maximum product  $z \frac{T_1 + T_0}{2}$  attainable for the given material.

Neglecting the quantity  $\frac{1}{2}I^2r$  in the expression for the efficiency, assuming it to be small in comparison with  $Q_1 + Q_h$ , we obtain

$$M' = \sqrt{1 + T_1 z} , \qquad (33)$$

$$\eta' = \frac{T_1 - T_0}{T_1} \times \frac{M' - 1}{M' + 1} \tag{34}$$

The value of  $\eta'$  differs little from  $\eta$  as long as  $\eta$  itself is small. For example, in the special case when  $T_1 = 600^{\circ}\text{K}$ ,  $T_0 = 300^{\circ}\text{K}$  and  $z = 2 \times 10^{-3}$ , we have M = 1.38, M' = 1.48,  $\eta = 0.101$ ,  $\eta' = 0.097$ .



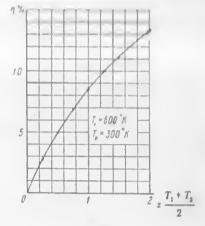


Fig. 2

Fig. 3

The dependence of M and  $\eta$  on the product  $\frac{1}{2}z(T_1 + T_0)$  is shown in figs. 2 and 3 and in table 1 for  $T_1 = 600^{\circ}$ K,  $T_0 = 300^{\circ}$ K and  $\frac{T_1 - T_0}{T_1} = 0.5$ .

TABLE 1

$\frac{1}{2} z \left( T_1 + T_0 \right)$	M	$\frac{M-1}{M+\frac{T_1}{T_0}}$	F, %		
0.25	1.12	0.074	3.7		
0.50	1.23	0.133	6,6		
0.75	1.32	0.176	8.8		
1.0	1.41	0.215	10.8		
1.25	1.50	0.250	12.5		
1.50	1.58	0.280	14.0		
2.0	1.73	0.330	16.5		

Assuming  $T_0 = 300^{\circ}$ K, we show in table 2 and fig. 4 the values of the efficiency  $\eta$  and M as functions of z at different values of  $T_1$  and in fig. 4a the dependence of  $\eta$  on  $T_1$  for different values of z.

2.2 Materials for semiconductor thermoelements. We shall now consider the selection of the most suitable materials for thermoelements.

First of all, it should be noted that semiconductors, owing to their much higher values of a, are definitely preferable to metals. In fact, for

TABLE

7, "h 400	100 - 500		)	600		700		100		1000		
= 10 <sup>a</sup>	W	77 %	W	η%	M	η%	М	η%	M	η%	M	η%
0 h	1.085	1.15	1.095	2.25	1.111	3.45	1.12	4.4	1.13	5.4	1.15	7.2
0.75	1.13	1.5	1.14	3.2	1.155	4.7	1.17	6.1	1.19	7.6	1.22	10.0
1 ()	1.162	2.13	1.185	4.15	1.20	5.9	1.225	7.8	1.25	9.6	1,285	12.5
1.35	1.20	2.65	1.225	5.0	1.25	7.2	1.275	9.2	1.30	11.1	1.35	15,0
15	1.24	3.0	1.27	5.8	1.295	8.2	1.325	10.5	1.35	12.7	1.40	16.5
1.75	1.27	3.35	1.30	6.3	1.325	9.2	1.37	11.8	1.40	14.0	1.46	10.0
0,0	1.31	3.75	1.345	7.1	1.375	10.1	1.42	13.0	1.45	15.5	1.52	20
7.5	1.38	4.4	1.41	8.2	1.46	11.7	1.50	14.8	1.55	17.5	1.62	22.
10	1.43	4.9	1.48	9.2	1.53	13.0	1.85	16.5	1.63	19.5	1.72	25
4.0	1.55	6.0	1.62	11.1	1.675	15.5	1.73	19.2	1.88	23.0	1,90	28
B ()	1,66	6.8	1.73	12.5	1.80	17.2	1.87	21.5	1.94	25.0	2,00	32

ment metals  $\alpha < 10 \times 10^{-6}$  V/deg. The ratio of electrical conductivity  $\kappa$  for all metals is close to the theoretical value predicted by quantum mechanics

$$\frac{\kappa}{\sigma} = \frac{\pi^2}{3} \left(\frac{k}{e}\right)^2 T = 2.44 \times 10^{-8} T.$$

At an average temperature  $T = 500^{\circ} \text{K}$ 

$$z = 8.2 \times 10^{-6}$$

and at  $T_1 = 700$  °K and  $T_0 = 300$  °K

$$\eta = 8.5 \times 10^{-4} = 0.085\%$$
.

For the best pair of metals Bi-Sb we can put:  $a = 100 \times 10^{-6}$ ,  $\kappa \rho = 9 \times 10^{-6}$ ,  $1.1 \times 10^{-3}$ ,  $T_1 < 450^{\circ}$ K,  $T_0 = 300^{\circ}$ K and  $\eta = 3.1\%$ .

In several semiconductors z reaches, and sometimes exceeds, the value of  $1\times10^{-3}$ , and  $\eta$  approaches 10%. Furthermore, several semiconductors possess a high melting point, thus permitting operation at high

Fig. 4

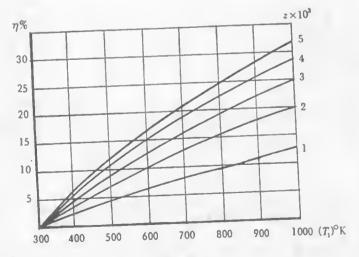


Fig. 4a

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values of  $T_1$ . Therefore, efficiencies of the order of 10-15% and more cannot be regarded as unattainable with the use of semiconductors. Values of  $\eta$  equal to 3.3 and even 7% have been reported in literature.

The higher the value of  $z = \frac{\alpha^2}{\kappa \rho}$  for the individual branches of the thermoelement, the higher is the value of  $z = \frac{(\alpha_1 + \alpha_2)^2}{(\sqrt{\kappa_1 \rho_1} + \sqrt{\kappa_2 \rho_2})^2}$  which

determines the efficiency of the entire thermoelement. However, the relationship between the z of the thermoelement and the values of  $z_1$  and  $z_2$  for the individual branches cannot be stated in a general form. In individual cases, when  $z_1 = z_2$ , then  $z = z_1 = z_2$ ; when  $\kappa_1 \rho_1 = \kappa_2 \rho_2$ , then  $z = \frac{1}{4}(z_1 + z_2) + \frac{1}{2}\sqrt{z_1 z_2}$ . If  $\alpha_1 = \alpha_2 = 172 \ \mu\text{V/deg}$ , as is required for the

best utilisation of semiconductor materials (see below), then

$$z = \frac{4}{\left(\frac{1}{\sqrt{z_1}} + \frac{1}{\sqrt{z_2}}\right)^2} = \frac{4z_1z_2}{(\sqrt{z_1} + \sqrt{z_2})^2}.$$

Starting with equation (21) for semiconductors it is possible to establish the relationship between a and  $\sigma = 1/\rho$ . Assuming the temperature to be constant and the mobility to be practically independent of concentration n, one would expect a linear relationship between a and  $\ln \sigma$ :

$$\alpha = C - 86 \times 10^{-6} \ln \sigma = C - 2 \times 10^{-4} \log \sigma. \tag{35}$$

The value of C depends on temperature T, mobility, and the character of the chemical bonds in the semiconductor.

In addition,  $\sigma$  is related to  $\kappa$ . The thermal conductivity of the semi-conductor  $\kappa$  is composed of the electronic thermal conductivity  $\kappa_{el}$  and the thermal conductivity due to thermal vibrations and the propagation of heat waves (denoted here as phonon thermal conductivity  $\kappa_{oh}$ ):

$$\kappa = \kappa_{el} + \kappa_{ph} \,. \tag{36}$$

The former is related to electrical conductivity  $\sigma$  by the Wiedemann-Franz law. However, the coefficient of proportionality has a value equal to that for metals

$$\frac{\kappa_{el}}{\sigma} = \frac{\pi^2}{3} \left(\frac{k}{e}\right)^2 T \tag{37}$$

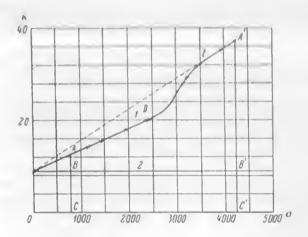


Fig. 5. Dependence of thermal conductivity of a semiconductor on its electrical conductivity.

 $l - \kappa = \kappa_{el} + \kappa_{ph}$ ;  $2 - \kappa_{ph}$ ; AB and  $A'B' - \kappa_{el}$ ; D - start of degeneracy; E - complete degeneracy.

only at very high concentrations of free electrons (more than  $2.5 \times 10^{10}$  cm<sup>-1</sup>) when the latter must be regarded as degenerate.

At lower concentrations usually prevailing in semiconductors

$$\frac{\kappa_{\rm el}}{\sigma} = 2\left(\frac{k}{e}\right)^2 T = 1.48 \times 10^{-6} \ T \ V^2/{\rm deg.},$$
 (311)

which gives, at room temperature (T = 293°K),

$$\frac{\kappa_{el}}{\sigma} = 4.35 \times 10^{-6} \text{ V}^2/\text{deg.*}$$

\* In the general case the Wiedemann-Franz law for semiconductors has the following form

$$\frac{\kappa_{e} I}{\sigma} = (r+2) \left(\frac{k}{e}\right)^{2} T, \qquad (38a)$$

which for atomic lattices with r=0 reduces to equation (38), r is the exponent in the formula giving the electron free path length l as a function of kinetic energy  $(l=e^r)$ .

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In other words, every 1000 ohm<sup>-1</sup>  $\times$  cm<sup>-1</sup> of electrical conductivity corresponds to  $4.35 \times 10^{-3}$  W/deg  $\times$  cm, or  $1.04 \times 10^{-3}$  cal/deg  $\times$  cm  $\times$  aec of thermal conductivity.

Fig. 5, based on our measurements, illustrates expressions (36), (37) and (38) in the case of one and the same semiconductor with different electrical conductivities and free carrier concentrations.

At  $\sigma < 2500$  ohm<sup>-1</sup> × cm<sup>-1</sup> the electrons can be regarded as non-degenerate. In this case  $\kappa_{e\,l} = 4.5 \times 10^{-6}~\sigma$ . At  $\sigma = 4000$  ohm<sup>-1</sup> × cm<sup>-1</sup> the electrons are largely degenerate and in this range  $\kappa_{el}$  approaches the value  $\kappa_{e\,l} = 7.3 \times 10^{-6}~\sigma$ .

The Wiedemann-Franz law deacribes the relationship between thermal conductivity  $\kappa_{el}$  and electrical conductivity accurately only in the case of semiconductors with carriers of the same sign. When carriers of both signs are present simultaneously, a continuous stream of chargea can flow in the direction of the temperature gradient and the thermal conductivity  $\kappa_{el}$  increasea appreciably.

On the way from the hot to the cold junction the concentration of the holes and electrons decreases, the recombining pairs of charges liberating an energy  $\Delta E_0$ .

We shall denote the current transported by the holes by  $l_1$  and that transported by the electrons by  $l_2$ . In an electric field E,  $l_1 = E\sigma_1$  and  $l_2 = E\sigma_2$ . Further, we shall write down  $\kappa_{el}/\sigma = LT$ .

The thermal conductivity due to the diffusion of carriers can then be expreased as

$$\kappa_{el} = L \left(\sigma_1 + \sigma_2\right) T + 2LT \frac{\sigma_1 - \sigma_2}{\sigma_1 + \sigma_2} \left(\frac{\Delta E_0}{2kT} + r + 2\right)^2.$$

In addition to the recombination of charges, heat may also be conducted from the hot end to the cold end by the transfer of other types of excitation energy. All such processes increase the thermal conductivity of semiconductors when the latter are heated above a certain temperature. They reduce, therefore, the efficiency of the thermoelements at these temperaturea.

By analogy with diffusion and thermal conduction in gases, the phonon part of thermal conductivity  $\kappa_{ph}$  can be expressed as

$$\kappa_{ph} = \frac{1}{3} c v \overline{\lambda}, \tag{39}$$

where c is specific heat (J/cm<sup>5</sup>), v is sound velocity (cm/sec) and  $\bar{\lambda}$  is the mean phonon free path length (cm).

In the case of the majority of semiconductors c=1.2 to 1.6,  $v=2\times10^5$  to  $5\times10^5$ , and  $\frac{1}{3}cv=1\times10^5$  to  $3\times10^5$ .

The value of thermal conductivity  $\kappa_{ph}$  of a semiconductor is also related to electron mobility u and, therefore, also to electrical conductivity.

Both phonons and electrons are scattered by the same non-homogeneities of the crystalline lattice, but the degree of scattering is different owing to their different wavelengths  $(7 \times 10^{-7} \text{ for electrons and approximately } 5 \times 10^{-8} \text{ cm for phonons})$  and their different physical nature. There should however exist aome correlation between  $\bar{\lambda}$  and the mean free path length of electrons  $\bar{l}$ .

In comparing the thermal conductivity and the mobility of various materials one finds that in a series of substances with similar structure

the thermal conductivity decreases, whilst the mobility increases, with increasing atomic weight. Thus, in the series: diamond, silicon, germanium,  $\kappa_{ph}$  decreases from 2 to 1 and 0.6 W/deg × cm, whilst the electron mobility increases from 900 to 1400 and 3600 cm²/V × sec. Thus, an has been pointed out by 11. J. Goldsmid, the ratio  $n/\kappa_{ph}$ , governing the value of a of thermocouples, increases with increasing atomic weight.

The factors affecting the value of thermal conductivity  $\kappa_{ph}$  are clearly seen in the diagram in fig. 6. The thermal conductivity decreases, not only with increasing average atomic weight, but also in going over from purely valence type to ionic compounds, i.e. from elements in group IV of the periodic system

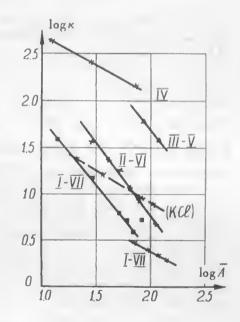


Fig. 6

towards the compounds of groups III with V, II with VI, and I with VII.

Elements and atomic compounds in the first and second rows of the periodic system (B, C, Si, SiC) have a thermal conductivity of 1 to 2 W/cm × deg. Valence compounds and elements in the next two rows, e.g. GaSb and InSb, have thermal conductivities of the order of tenths of W/cm × deg, and, for materials in the last rows,  $\kappa_{ph}$  does not exceed a few hundredths of W/cm × deg. A similar behaviour is exhibited by elements of group IV (C, Si, Ge), alkali halide compounds (from LiF to RbBr), oxides of elements in group II (from BeO to HgO), and titanntes of group II elements.

Of major importance for thermoelements is the effect of impurities on the thermal conductivity. When N impurity atoms are dissolved in a crystal containing  $N_0$  atoms, the initial thermal conductivity  $\kappa_0$  drops to a value  $\kappa$  described, at low concentrations, by the expression

$$\frac{\kappa_0}{\kappa} = 1 + \frac{N}{N_0} \times \frac{\lambda_0}{a} S,$$

where  $\lambda_0$  is the free path length of phonons in the pure substance;  $\alpha$  is the interatomic distance in the crystal lattice and S is the scattering cross-section of an impurity atom with respect to phonons expressed in units equal to a crystal cell area.

At high concentrations of impurities within the solid solution – concentrations close to 50% – the free path length of phonons drops to values of the order of a to 2a. The effect is largest in substances for which  $\frac{\lambda_0}{a}$  is large. For Si  $\frac{\lambda_0}{a} \approx 100$ , and the formation of a solid solution with Ge and Sb reduces  $\kappa$  from about 1 to 0.03 W/deg  $\times$  cm.

In cases when  $\kappa_{ph} >> \kappa_{el}$ ,  $\kappa$  can be regarded as practically independent of  $\alpha$  and  $\sigma$ . Small impurity concentrations which increase n, and therefore  $\sigma$ , tens and hundreds of times have, under these conditions, little effect on u and  $\kappa$ . Therefore for such semiconductors it is possible to consider separately the conditions of the maximum of  $\alpha^2\sigma$ , in which both  $\alpha$  and  $\sigma$  can be regarded as primarily functions of concentration n.

Let us consider the conditions at which  $\alpha^2 \alpha$  reaches a maximum. According to equation (21):

$$a = \frac{k}{e} \left[ A + \ln \frac{2(2\pi m^* k)^{\frac{3}{2}}}{h^3} + \ln euT^{\frac{3}{2}} - \ln \sigma \right] = \frac{k}{e} (S - \ln \sigma),$$

$$\alpha^2 \sigma = \left(\frac{k}{e}\right)^2 \sigma \left[ S^2 - 2S \ln \sigma + (\ln \sigma)^2 \right],$$

$$\frac{\partial (\alpha^2 \sigma)}{\partial \sigma} = \left(\frac{k}{e}\right)^2 \left[ (\ln \sigma)^2 - 2(S - 1) \ln \sigma + S(S - 2) \right].$$

The condition  $\frac{\partial (a^a \sigma)}{\partial \sigma} = 0$  gives

When the sign is positive,  $\ln a = S$  and a = 0, and, therefore, also  $a^3a = 0$ . When the sign is negative,  $\ln a = S = 2$  and

$$a = 2\frac{k}{e} = 172 \times 10^{-6} \text{ V/deg},$$
 (40)

$$(a^2 \sigma)_{max} = 3 \times 10^{-6} \sigma.$$
 (41)

Condition (40) for the maximum of  $a^2\sigma$  is valid at all temperatures, and at all values of the coefficient A in Pisnrenko's formula. Therefore  $(a^4\sigma)_{max}$  is determined under these conditions by the value of  $\sigma$ . The temperature dependence of  $a^2\sigma$  will have the following form

$$\alpha^2 \sigma = \left(\frac{k}{e}\right)^2 \sigma(T) \left[ A + \ln \frac{2(2\pi m^* k)^{\frac{3}{2}}}{h^3} + \ln \frac{euT^{\frac{3}{2}}}{\sigma(T)} \right]^2.$$

In atomic lattices  $u = u_0 T^{-\frac{3}{2}}$ . In this case

$$a^{2}\sigma = \left(\frac{k}{e}\right)^{2}\sigma\left(T\right)\left[A + \ln\frac{2\left(2\pi m^{2}k\right)^{3/2}}{h^{3}}eu_{0} - \ln\sigma\left(T\right)\right]^{3}.$$

 $a^{2}\sigma$  has a maximum when the value of  $\sigma$  corresponds to a=2k/e, and therefore

$$\ln \sigma = (A-2) + \ln \frac{2(2\pi m^* k)^{\frac{3}{2}}}{h^3} + \ln euT^{\frac{3}{2}}.$$

For atomic lattices A = 2 and  $uT^{\frac{3}{2}} = u_0 T_0^{\frac{3}{2}}$ , therefore

$$\sigma_{opt} = \frac{2e(2\pi m^* kT_0)^{\frac{3}{2}}}{h^{\frac{3}{2}}} u_0$$

where  $u_0$  is mobility at temperature  $T_0$ . Taking  $T_0 = 300^{\circ}$ K and  $m^* = m_0$  we have

$$\frac{2(2\pi m_0 k T_0)^{\frac{3}{2}}}{h^3} = 2.5 \times 10^{19},$$

$$\sigma_{opt} = 2.5 \times 10^{19} \times 1.6 \times 10^{-19} u_0 = 4u_0$$
 (42)

for all temperatures.

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In many semiconductor materials which may find application in thermoelectric batteries n = const and  $u \propto T^{-\frac{n}{2}}$ , or  $uT^{\frac{n}{2}} = u_0 T_0^{\frac{n}{2}}$ ,  $uT^{\frac{n}{2}} = u_0 T_0^{\frac{n}{2}} \frac{1}{T}$ and A = 1. For such materials

$$\sigma_{opt} = \frac{1}{2.7} \times \frac{2e \left(2\pi m^* k T_0\right)^{\frac{3}{2}}}{h^3} u_0 \frac{T_0}{T}.$$

At  $m^* = m_0$ 

$$\sigma_{opt} = 1.44 u_0 \frac{T_0}{T} \text{ ohm}^{-1} \times \text{cm}^{-1}$$
 (43)

In these two cases the optimum values of z are: for atomic lattices with A = 2

$$z_{opt} = \frac{\alpha^2 \sigma}{\kappa} = 1.16 \times 10^{-7} \frac{u_0}{\kappa},$$
 (44)

and for lattices in which A = 1

$$z_{opt} = 4.3 \times 10^{-8} \frac{u_0}{\kappa} \times \frac{T_0}{T} \text{ deg}^{-1}$$
 (45)

When  $\kappa \approx \kappa_{ph}$ , then  $\kappa T \approx \text{const} = \kappa_0 T_0$  and

$$z_{opt} = 4.3 \times 10^{-6} \frac{u_0}{\kappa_0} \text{ deg}^{-3}$$
.

If  $u_0 = 1000 \text{ cm}^2/\text{sec} \times \text{V}$ , and  $\kappa_0 = 5 \times 10^{-3} \text{ cal/deg} \times \text{cm} \times \text{sec} = 2.1 \times 10^{-3} \text{ cal/deg} \times \text{cm} \times \text{sec} = 2.1 \times 10^{-3} \text{ cal/deg} \times \text{cm} \times \text{sec} = 2.1 \times 10^{-3} \text{ cal/deg} \times \text{cm} \times \text{sec} = 2.1 \times 10^{-3} \text{ cal/deg} \times \text{cm} \times \text{sec} = 2.1 \times 10^{-3} \text{ cal/deg} \times \text{cm} \times \text{sec} = 2.1 \times 10^{-3} \text{ cal/deg} \times \text{cm} \times \text{sec} = 2.1 \times 10^{-3} \text{ cal/deg} \times \text{cm} \times \text{sec} = 2.1 \times 10^{-3} \text{ cal/deg} \times \text{cm} \times \text{sec} = 2.1 \times 10^{-3} \text{ cal/deg} \times \text{cm} \times \text{sec} = 2.1 \times 10^{-3} \text{ cal/deg} \times \text{cm} \times \text{sec} = 2.1 \times 10^{-3} \text{ cal/deg} \times \text{cm} \times \text{sec} = 2.1 \times 10^{-3} \text{ cal/deg} \times \text{cm} \times \text{sec} = 2.1 \times 10^{-3} \text{ cal/deg} \times \text{cm} \times \text{sec} = 2.1 \times 10^{-3} \text{ cal/deg} \times \text{cm} \times \text{sec} = 2.1 \times 10^{-3} \text{ cal/deg} \times \text{cm} \times \text{sec} = 2.1 \times 10^{-3} \text{ cal/deg} \times \text{cm} \times \text{sec} = 2.1 \times 10^{-3} \text{ cal/deg} \times \text{cm} \times \text{sec} = 2.1 \times 10^{-3} \text{ cal/deg} \times \text{cm} \times \text{sec} = 2.1 \times 10^{-3} \text{ cal/deg} \times \text{cm} \times \text{sec} = 2.1 \times 10^{-3} \text{ cal/deg} \times \text{cm} \times \text{sec} = 2.1 \times 10^{-3} \text{ cal/deg} \times \text{cm} \times \text{sec} = 2.1 \times 10^{-3} \text{ cal/deg} \times \text{cm} \times \text{sec} = 2.1 \times 10^{-3} \text{ cal/deg} \times \text{cm} \times \text{cm}$ × 10<sup>-2</sup> W/deg × cm

$$z_{opt} = 2.05 \times 10^{-1} \text{ deg}^{-1}$$
.

The minimum value of a = 0,  $a^2 \sigma = 0$  and z = 0 occurs for an atomic lattice when

$$\sigma_{min} = 29u_0 \text{ ohm}^{-1} \times \text{cm}^{-1}$$
,

and for a lattice with A = 1 when

$$\sigma_{min} = 10.7 u_0 \frac{T_0}{T}.$$

Fig. 7 shows  $(a^2\sigma)/(a^2\sigma)_{max}$  as a function of  $\ln{(\sigma/u_0)}$ .

It follows from expressions (42) and (43) that the optimum free electron concentration n at 300°K is equal, for an atomic lattice with A=2, to



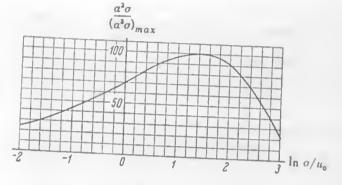


Fig. 7

This condition corresponds to  $n = \frac{2(2\pi m_0 kT)^{3/2}}{L^3}$  and  $\alpha = \frac{k}{c}(2+0) = 2\frac{k}{c}$ .

For a lattice with A = 1 we have, at  $T = T_0 = 300$ °K,

$$n_{opt} = 9 \times 10^{18} \text{ cm}^{-3}$$
 (47)

l'isarenko's formula gives for this value of  $n_{opt}$ 

$$a = \frac{k}{e} (1 + \ln 2.7) = 2 \frac{k}{e}$$
.

These concentrations are close to the onset of electron degeneracy.

Fig. 8 shows the results of measurements on PbSe with hole conductivity and PbTe with hole and electronic conductivity containing different free charge concentrations.

On the basis of the temperature dependence of mobility, which in Pisarenko's formula has the form  $uT^3 = \text{const}$  or  $uT^{\frac{5}{2}} = \text{const}$ , the constunt A for these substances ought to have the value  $A = \frac{1}{2}$  or A = 1(assuming  $m^*/m_0 = 1$ ). The experimental points down to  $n = 4 \times 10^{10}$  fall on to straight lines in good agreement with Pisarenko's equation. When it is assumed that  $m^*/m_0 = 1$  these lines correspond to values A = 1.2for p-type PbTe, A = 1 for p-type PbSe and  $A = \frac{1}{4}$  for n-type PbTe.

Alternatively, it could be assumed that all these compounds with an analogous chemical structure are covered by a single law  $uT^{\frac{5}{2}} = \text{const}$ 

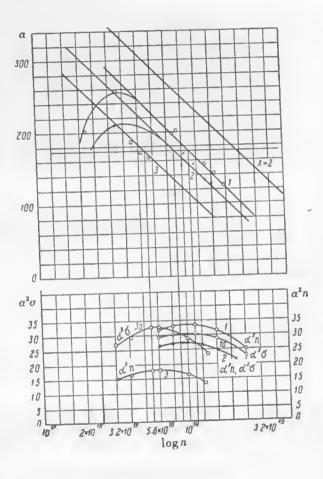


Fig. 8. Comparison of experimental results with Pisarenko's formula.

o p-type PbTe (A = 1.2,  $m^*/m_0 = 1$ ; or A = 1,  $m^*/m_0 = 1.13$ )

a n-type PbTe (A = 0.5,  $m^*/m_0 = 1$ ; or A = 1,  $m^*/m_0 = 0.7$ )

 $\times$  p-type PbSe (A = 1,  $m^*/m_0 = 1$ )

and A=1. In this case their effective masses would be different:  $m^{\bullet}/m_{\bullet} = 1.13$  for  $\mu$ -type PhTe,  $m^{\bullet}/m_{\bullet} = 1$  for  $\mu$ -type PhTe.

The lower graph in fig. 8 shows the values of  $a^2n$  based on the data to the apper graph (curves 1-3) and the values of  $a^2\sigma$  calculated on the assumption that for all the specimens A=1 and the relationship between mobility and effective mass is of the form  $um^*/_2 = count$  (curves 1a and 1a, which correspond to curves 1-3 in the upper and lower graphs). As in meen from the lower graph,  $a^2\sigma$  reaches a maximum in all cases at  $u=172\,\mu\text{V/deg}$  and its value is highest for n-type PbTe which has the lowest ratio  $m^*/m_0$ . The scale for  $a^2\sigma$  in the lower graph has been no molected that, at  $m^*/m_0=1$ ,  $a^2n$  coincides with  $a^2\sigma$ .

The upper graph in fig. 9 shows the value of a for an atomic lattice we a function of n with  $m^*/m_0 = 1$  (curve 1) and  $m^*/m_0 = \frac{1}{4}$  (curve 2, which apparently corresponds to electrons in germanium). The lower graph in fig. 9 shows the variation of  $a^2n$  for both cases (curves 1 and 2); for the lattice with  $m^*/m_0 = \frac{1}{4}$  (curve 2) the scale has been increased ten times. In memiconductors, the lower the effective mass and, therefore, the lower the carresponding  $(a^2n)_{max}$ , the larger is the value of  $(a^2o)_{max}$ .

in addition to curves 1 and 2 representing  $a^2n$ , the lower graph in fig 9 also shows the values of  $a^2\sigma$  (curves 1a and 2a) plotted, this time, and the same scale.

The values of  $\sigma$  can be obtained from the corresponding values of n by multiplying the latter by the mobility u, which is in turn determined by the value of  $m^*$ . For atomic lattices the relationship between u and  $m^*$  can be expressed in the form  $um^{*\frac{5}{2}} = \text{const.}$  In particular, for  $m^*/m_0 = 0.2\pi$ ,  $u/u_0 = 32$ . As is seen from the plot of  $a^2\sigma$ , the value of  $(a^2\sigma)_{max}$  for the lattice with  $m^*/m_0 = \frac{1}{4}$  is four times larger than for the lattice with  $m^*/m_0 = 1$ .

The formula describing the dependence of a and  $a^2\sigma$  on  $\sigma$  contains the laterrelated quantities u and  $m^*$ . According to the quantum theory, for atomic lattices  $um^{*\frac{5}{2}} = u_0m_0^{\frac{5}{2}}$ , whilst for polar lattices  $um^{*\frac{3}{2}} = u_0m_0^{\frac{3}{2}}$ . Therefore for polar lattices a can be written down as

$$a = \frac{k}{e} \left[ 3 + \ln \frac{2e (2\pi m_0 kT)^{3/2}}{h^3} - \ln \frac{\sigma}{u_0} \right], \tag{48}$$

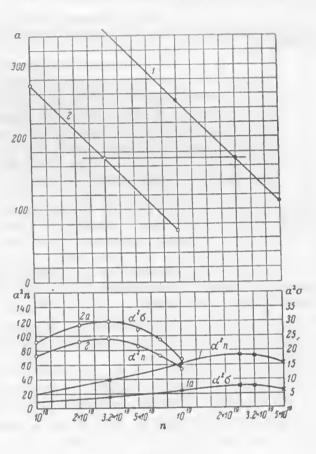


Fig. 9

and for atomic lattices as

$$\alpha = \frac{k}{e} \left[ 2 + \ln \frac{2e \left(2\pi m_0 k T\right)^{\frac{3}{2}}}{h^3} - \ln \frac{\sigma}{u_0} \times \frac{m}{m_0} \right] =$$

$$= \frac{k}{e} \left[ \left( 2 + \ln \frac{m_0}{m^*} \right) + \ln \frac{2e \left(2\pi m_0 k T\right)^{\frac{3}{2}}}{h^3} - \ln \frac{\sigma}{u_0} \right]. \tag{49}$$

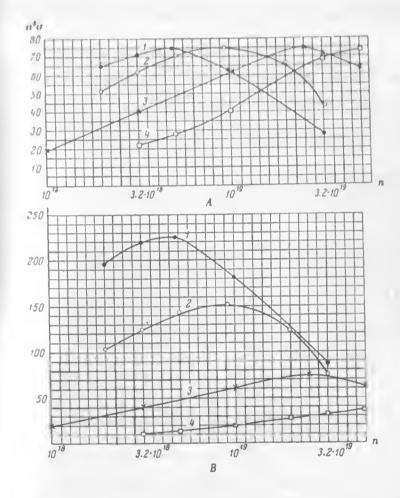


Fig. 10. A - ionic lattice  $n/n_0 = (m_0/m^*)^{\frac{3}{2}}$ ; B - atomic lattice  $n/n_0 = (m_0/m^*)^{\frac{5}{2}}$ ;  $1 - m^*/m_0 = \frac{1}{3}$ ;  $2 - m^*/m_0 = \frac{1}{2}$ ;  $3 - m^*/m_0 = 1$ ;  $4 - m^*/m_0 = 2$ .

We can infer from this that for polar lattices neither a at a given a, nor  $(a^2\sigma)$  depends on  $m^*/m_0$ . On the other hand, for atomic lattices the value of  $(a^2\sigma)_{max}$  increases with decrensing  $m^*/m_0$ ; for  $m^*/m_0 = 2.7$  the value of the constant A increases from 2 to 3 compared with  $m^*/m_0 = 1$ .

Fig. 10 shows the dependence of  $(a^2\sigma)$  on  $\log n$  for different values of  $m^*/m_0$  for atomic and polar lattices. It is possible to combine the curves in fig. 10 relating to different values of  $m^*/m_0$  into one curve by replacing

n along the axis of abscissae by  $\epsilon = n \left(\frac{m_0}{m^*}\right)^{\frac{3}{2}}$ . Such curves are shown in

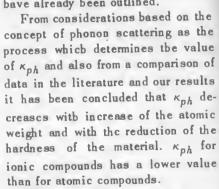
figs. 11 and 11a. A network of values of  $\log n$  for different  $m^*/m_0$  has been plotted at the bottom of fig. 11a to permit graphic conversion of abscissae from  $\log \epsilon$  to  $\log n$ . The smaller  $m^*$ , the lower is the concentration  $n_{opt}$  required to produce  $(\alpha^2 \sigma)_{max}$ .

Thus, in order to obtain the highest values of  $(a^2\sigma)_{max}$  it is desirable to select scmiconductors with maximum mobility u and minimum effective mass  $m^*$ .

We have discussed here the electrical portion  $a^2\sigma$  of the quantity z, which determines the maximum achievable factor of merit. No less important is the thermal conductivity of the semiconductor expressed by the

tant is the thermal conductivity of the semiconductor expressed by the quantity  $\kappa$ . Here we should aim at a minimum value. An exact theory of thermal conductivity bas not yet been

evolved. Certain rules, bowever, bave already been outlined.



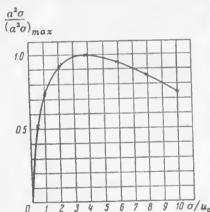


Fig. 11. Atomic lattice

$$\frac{u}{u_0} = \left(\frac{m_0}{m^*}\right)^{5/2}$$

The above calculations were based on the assumption that  $(a^2\sigma)_{max}$  would coincide with the condition  $z_{max} = \left(\frac{a^2\sigma}{\kappa}\right)_{max}$  which holds only

In tunes when a is independent of a. Of the two terms of which the thermal conductivity is composed,

only the phonon component of thermal conductivity is independent of a, whereas the second, electronic component  $\kappa_{el}$ , is determined by the value of a increasing with the increase of a, viz  $\kappa_{el} = La$ .

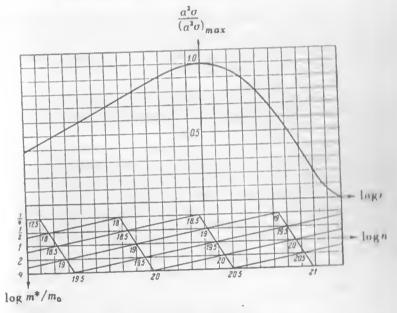


Fig. 11a. Ionic lattice:  $u/u_0 = (m_0/m^e)^{3/2}$ ,  $\epsilon = n(m_0/m^e)$ .

The numbers down the sides indicate the ratio  $m^e/m_0$ .

This second component can be neglected only when  $\kappa_{el} << \kappa_{ph}$ , which is for from being always the case. In the general case, when  $\kappa_{ph}$  and  $\kappa_{el}$  are quantities of the same order, the condition  $\alpha_{opt} = 172~\mu\text{V/deg}$  is no longer valid.

Instead of investigating the condition  $z_{max}$  we shall consider the equivalent condition  $(1/z)_{min}$ :

$$\frac{1}{z} = \frac{\kappa_{ph}}{\alpha^2 \sigma} + \frac{\kappa_{el}}{\alpha^2 \sigma} = \frac{\kappa_{ph}}{\alpha^2 \sigma} + \frac{L}{\alpha^2}.$$

THERMODILE THE BINDHATORS

a is related to  $\sigma$  by the equation  $a = C - \frac{k}{e} \ln \sigma$ , whence  $\frac{d\sigma}{da} = -\frac{\sigma}{k}$ . By equating  $\frac{d\left(\frac{1}{z}\right)}{dz} = 0$ , we obtain

$$\alpha_{opt} = 2 \frac{k}{e} \left( 1 + \frac{\kappa_{el}}{\kappa_{ph}} \right) = 172 \left( 1 + \frac{\kappa_{el}}{\kappa_{ph}} \right) \mu V/\text{deg}.$$
 (40s)

At  $\kappa_{el} << \kappa_{ph}$  this condition reduces to the earlier one,  $\alpha_{opt} = 172 \ \mu V/deg$ . Both the left hand side (a) and the right hand side (kel) in equation (40s) depend on concentration n. Therefore this equation should be regarded as a transcendental equation determining the value of n at which a<sup>2</sup>o resches its maximum.

All these formulae relate to non-degenerate electrons. In the presence of degeneracy it is necessary to use expressions (26) and (26s) and to compute the values graphically.

The value of the thermsl conductivity of thermocouples is not only important from the viewpoint of efficiency, but also for determining the size of the thermoelectric batteries and for establishing conditions which should be astisfied by thermoelectric refrigerators.

A battery will have the maximum efficiency permitted by its composition when the hot junction temperature T, is as high as possible, and the cold junction temperature To as low as possible. These conditions determine the temperature difference  $T_1 - T_2$ . The lower the thermal conductivity  $\kappa$ , the shorter should be the thermocouple, i.e. the smaller should be the length l (fig. 1, page 36).

The density of the hest flux (q) passing through the thermoelement (therms) energy in watts passing through a section with an area of 1 cm2) can be expressed in the form:

$$q = \kappa \frac{T_1 - T_0}{l} {.} {(50)}$$

When l is specified it is necessary to ensure a certain value of q and, conversely, when the hest flux density is specified the length of the battery elements l is governed by thermal conductivity k.

In practical thermoelements, the efficiency of which does not exceed 10%, the bulk of the power delivered by the heat source passes to the cold junctions by thermal conduction. Therefore the power loss from the hest source is primarily governed by the hest flow through the branches of the thermoelement. The electric power delivered by the battery can be represented as  $\eta Q_h$ , where  $Q_h = qS$  (S is the total cross section area of the battery):

$$W = \eta \eta S - \eta \kappa \, \, \frac{T_s - T_s}{I} \, S \, . \label{eq:W}$$

The power produced by every em' of the battery, i.e. the specific power, in equal to

$$w = \frac{W}{Sl} = \eta \kappa (T_1 - T_0) \frac{1}{l^2}, \qquad (51)$$

, at a given value of the heat flux q,

$$w = \eta q \frac{1}{I}.$$
 (51n)

The lower the thermal conductivity, the shorter should be the thermoalements for a given temperature difference, and the higher should be hant flux density at a given W. As the length I decreases, the specific number increases as  $l^2$ , and the hent flux density increases l times.

Finally, thermal conductivity is also of importance for the determination of thermal stresses crested in the battery and deformations suffered by It under conditions of non-uniform heating.

Let us denote the temperature coefficient of linear expansion by p An a result of the temperature difference T1 - To between the hot and cald much of the battery, their linear dimensions P, which were initially equal, will differ by

$$\Delta P = p (T_1 - T_0) P.$$

When the length of the elements is I, the bending, which each branch of the thermoelement undergoes under the effect of the temperature gradient is described by the radius of curvature

$$R = \frac{P}{\Delta P} \, l = \frac{1}{p(T_1 - T_0)} \, l \,. \tag{52}$$

For example, when  $p = 2 \times 10^{-5} \text{ deg}^{-1}$ ,  $T_1 - T_0 = 300^{\circ} \text{K}$  and l = 0.6 cm, then R = 100 cm.

As a result of bending, the initially flst surface of the hot junction, fixed at one end, will move at the other end by n distance

$$\Delta l = \frac{P^2}{2R} = P^2 \frac{p(T_1 - T_0)}{2l}.$$
 (52a)

With the above assumptions, when the width of the battery is P = 10 cm, the other end will move away from the plane by a distance  $\Delta l = 0.5$  cm.

THE HMOLLICIBLE GENERALORS

or when the centre of the battery is fixed its edges will move by 2.5 nm. When the free bending of the battery is impeded, the stresses generated in the battery may bring about its failure due to cracking. At a given

temperature difference  $(T_1 - T_0)$  these stresses are the more harmful,

the smaller is l and the larger is P.

So far we have assumed that one branch of the thermoelement consists of a semiconductor with purely hole conductivity and the other with purely electronic conductivity. When free electrons with a concentration of nand mobility  $u_{-}$ , and holes with a concentration  $n_{+}$  and mobility  $u_{+}$ , are simultaneously present in one and the same branch, Pisarenko's formula takes on the following form

$$\alpha = \frac{k}{\sigma} \left\{ n_{-}u_{-} \left[ A + \ln \frac{2(2\pi m_{+}^{*}kT)^{\frac{3}{2}}}{h^{3}} - \ln n_{-} \right] - n_{+}u_{+} \left[ A + \ln \frac{2(2\pi m_{+}^{*}kT)^{\frac{3}{2}}}{h^{3}} - \ln n_{+} \right] \right\}.$$
 (53)

In the special case of a chemically pure semiconductor without admixtures, when  $n_{-}m_{+}^{3/2} = n_{+}m_{-}^{3/2} = nm_{-}^{3/2}$ , a becomes

$$\alpha = \frac{k}{\sigma} \left\{ (n_{-}u_{-} - n_{+}u_{+}) \left[ A + \ln \frac{2(2\pi m^{*}kT)^{\frac{3}{2}}}{h^{3}n} \right] \right\}.$$

When  $n_{-}u_{-} = n_{+}u_{+}$ , then  $\alpha = 0$ . In general, however, the values of  $\alpha$ for semiconductors with a mixed conductivity mechanism are appreciably lower than for impurity semiconductors with current carriers of one sign. Semiconductors in which the ratio  $u_{-}/u_{+}$  is very high form an exception. InSb, for example, is known to have  $u_{\perp}/u_{\perp} > 80$ . For such impurity-free semiconductors to possess an adequate concentration n, it is essential that the width of the forbidden zone should not exceed certain limits.

We have not taken into account in our calculations the Thomson heat generated (or absorbed) by the current in the branches of the thermoelement in which there is a temperature gradient  $(T_1 - T_0)/l$ .

It should be noted that when the condition for the maximum of  $(a^2\sigma)$  is satisfied and a has a constant value of ±172 µV/deg throughout the entire circuit, then the Thomson coefficient r = 0, and, therefore, the Thomson heat is also equal to zero. When, however, this condition is not satisfied and  $\frac{\partial a}{\partial r} \neq 0$ , then, owing to the Thomson heat,  $a_i$  at the lot junction has to be replaced by the mean value

$$\overline{a} = \frac{a_1 + a_0}{2}. \tag{54}$$

It is also necessary to specify with greater precision what is understood by the properties of the materials,  $\kappa$  and  $\rho$ , in expression (30), when the temperature T varies. Both  $\kappa$  and  $\rho$  are functions of temperature and It is necessary to substitute in equation (30)

$$\kappa \rho = \frac{1}{T_1 - T_0} \int_{T_0}^{T_1} \kappa \rho dT.$$

Hetween the limits  $T_0 = 300^{\circ}$ K and  $T_1 = 600^{\circ}$ K,  $\kappa$  changes approximately by a factor of 2 and  $\rho$  by a factor of 4 to 5.

A should not be regarded as the menn value of K, but the inverse volum of the mean thermal resistance 1/k, which increases linearly with tomperstare:

$$\tilde{\kappa} = \frac{2}{\frac{1}{\kappa_0} + \frac{1}{\kappa_1}} \,. \tag{4.1}$$

It would be erroneous to think that  $\overline{\kappa} = \kappa_1$  at the hot junction on the manumption that we are only interested in the loss of heat by themanl regulaction from the hot junction of the thermoelements. In reality the temperature gradient at this end  $\left(\frac{\partial T}{\partial x}\right)_{T=T}$  is not equal to  $\frac{T_1-T_0}{l}$  when A IN a function of T. In the stationary case the temperature gradient in distributed in the branches of the element in such a way that

$$\kappa_1 \left( \frac{\partial T}{\partial x} \right)_{T=T_1} = \overline{\kappa} \, \frac{T_1 - T_0}{l} \,, \tag{56}$$

where  $\vec{k}$  is given by expression (55).

In order to determine the mean resistivity  $\rho$  entering into expressions for z and  $\eta$  it is necessary to know the law governing the changes of  $\rho$ with temperature and temperature distribution along the rod. The latter In governed by the dependence of  $\kappa$  or  $1/\kappa$  on T. Since  $1/\kappa \sim T$ , the temparature distribution along a cylindrical rod may be described by the equations

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$$\frac{dT}{T} = Cdx, \quad T = T_1 e^{cx}, \quad C = \frac{1}{l} \ln \frac{T_0}{T_1},$$

where x is the distance from the hot junction.

For the majority of semiconductors, temperature dependence of  $\rho$  can be expressed in the form  $\rho T^{-n}={\rm const};$  then

$$\bar{\rho} = \frac{\int_{0}^{l} \rho dx}{l} = \frac{\int_{T_{0}}^{T_{1}} \rho(T) \frac{dx}{dT} dT}{l} = \frac{\text{const}}{Cl} \int_{T_{0}}^{T_{1}} \frac{T^{n}}{T} dT = \frac{\text{const}}{Cl} \int_{T_{0}}^{T_{1}} T^{n-1} dT,$$

$$\bar{\rho} = \frac{1}{n} \times \frac{\text{const}}{Cl} (T_{1}^{n} - T_{0}^{n}) = \frac{1}{n} \times \frac{1}{C} \times \frac{\rho_{1} - \rho_{0}}{l} = \frac{1}{n} \ln \frac{T_{1}}{T_{0}} (\rho_{1} - \rho_{0}), \tag{57}$$

and in the general case of an arbitrary function  $\rho(T)$ 

$$\bar{\rho} = \frac{1}{Cl} \int_{T_0}^{T_1} \rho(T) \frac{1}{T} dT = \ln \frac{T_1}{T_0} \int_{T_0}^{T_1} \rho(T) \frac{1}{T} dT.$$
 (57a)

Pisarenko's formula describes a as a function of three quantities:  $m^*$ , T and n. Experiments show that by introducing impurities into the semi-conductor or creating an excess of one of the coastituents of the main substance in the lattice, n can be varied within wide limits without significantly affecting the value of  $m^*$ .

Impurities may not only alter the carrier concentration but may also affect the sign of the current carriers. When excess or impurity atoms become ionised in the lattice giving up their electrons into the free band they produce electronic conductivity; on the other hand when impurity atoms pick up electrons from the band filled with valence electroas, hole conductivity is produced. Thus, an excess of lead in PbS produces electronic conductivity, and an excess of sulphur, hole conductivity; in both cases the number of current carriers increases. Excess of Mg in the semiconducting alloy Mg<sub>3</sub>Sb<sub>2</sub> produces an electronic current flow mechanism,

and an excess of Sb, a hole current flow machanism; electrical conductivity increases in this process from 10° to 0.1 and to 1000 phm" × cm". Excess of oxygen or lack of copper (which amounts to the same thing) in cuprous exide Cu<sub>2</sub>O brings about a sharp increase of hole conductivity from 10° to 10° ohm" × cm". In all the examples listed above, atoms with a low ionisation potential, which give up electrons easily in vacuo (such as Mg, Pb), also give up electrons in the crystal, thus raising the concentration of free electrons; atoms of electrically negative elements, which produce negative gaseous ions (such as O, S), become sources of hole conductivity. It may be inferred that we are dealing in these cases with lattices in which ionic honds predominate.

There exist, however, semiconductors in which an excess of any of lts components raises the electrical conductivity, whilst producing curriers of one kind only which are characteristic of the substance. A semiconducting alloy of this type is ZnSh, in which hoth an excess of Zn and an excess of Sh increase hole conductivity without changing currier sign. There are several semiconductors, in which - as in ZnSh the sign of current carriers is always the same, whatever impurities are introduced.

In semiconductors with pure valence bonds, the sign of current carriers introduced by impurities depends on the number of valence electrons in the atom. This, for example, is true for Ge and Si. Here each of the pair of atoms should provide one electron for the chemical hund. When the place of an atom in the main lattice is occupied by an atom of a different themical nature, the latter should provide as many electrons for bonds with the adjacent atoms as there are in the main atoms in the lattice. When there are more valence electrons in an impurity atom than is required for this purpose, the surplus of electrons passes over into the free zone. When there are act enough valence electrons, they are supplemented by electrons from the filled zone, leaving behind a corresponding number of holes.

In the previously cited example of Ge and Si each atom has four valence electrons, which saturate four valence bonds with adjacent atoms. Elements of groups I, II and III of Mendeleev's periodic system, which have a deficiency of valence electrons, produce hole conductivity, whilst elements of Group V produce electronic conductivity.

It is important to note that this rule is valid only for substitutional impurities which occupy the place of one of the lattice atoms. In the case of interstitial impurities, when the extraneous atoms take up positions within lattice cells and create local lattice defects, the sign of the conductivity depends primarily on whether the impurity atom is electrically positive or negative. In such cases one would expect that the elements

in the first columns would produce electionic conductivity and elements belonging to groups VI and VII inde conductivity (as in the case of rounce compounds).

Finally, an impurity may occupy defect sites and vacancies, which usually occur as a result of different diffusion velocities of the constituents. In such cases the electron mobility usually increases and the sign of conductivity depends on the conditions of binding of the impurity atom.

Admixture of impurity atoms or a departure from the exact stoichiometric composition of the compound also affects other properties of the semiconductor: as n rule the electron and hole mobilities decrease and the thermal conductivity also falls. An impurity providing positive ions reduces the electron mobility, whilst negative ions reduce hole mobility. In all cases the cause is the higher concentration of scattering centres.

If the conditions for electron and phonon scattering were the same, the ratio of the mobility u to the phonon thermal conductivity  $\kappa_{ph}$  would not be affected by the introduction of impurities. In this case  $\kappa_{ph}/u = \text{const.}$ 

In reality, however, as has already been pointed out, the conditions of electron and phonon scattering differ. Under no conditions can  $\kappa_{ph}$  be regarded as directly proportional to u.

Whilst most phonons have a wavelength ranging from one to a few atomic distances and are therefore scattered on all lattice distortions of the order of atomic distances, the wavelength of electronic waves extends over a few tens atomic distances; therefore electrons are scattered on defects of this size only to a small degree.

Fig. 12 shows the thermal conductivity  $\kappa_{ph}$  for PbSe in which various amounts of PbTe have been dissolved. Whereas  $\kappa_{ph}$  in approx. 50% solutions decreases 2.5 times and the free path length of phonons in such solutions does not exceed two lattice constants, the electron mobility does not decrease, or it becomes even higher than in pure PbTe and PbSe.

The ratio  $\kappa_{ph}/u$  in solid solutions is, therefore, particularly favourable for thermoelements.

However, negligible amounts of certain impurities (concentrations of less than 0.1%) reduce the mobility of Ge many times, whilst the lattice component of its thermal conductivity only decreases to n half on the addition of ns much as 3% of other impurities, e.g. silicon atoms.

The introduction of various impurities into the semiconductor is the principal method available chabling us to alter semiconductor parameters  $(\alpha, \sigma, \kappa)$  in the desired direction. It must be remembered, however, that impurities not only increase free charge concentration n, but may also decrease free charge mobility u, so that  $\sigma$  cannot be regarded as proportional to n; in fact  $\sigma$  grows more slowly than n. Introduction of impurities

does not lead only to an increase of the electronic part of thermal conductivity together with  $\sigma$ , but also to a simultaneous decrease of the planton thermal conductivity. When these circumstances are taken into account,  $a^4\sigma$  is found to reach a maximum at thermal emf values slightly different from 172  $\mu V/\deg$ .

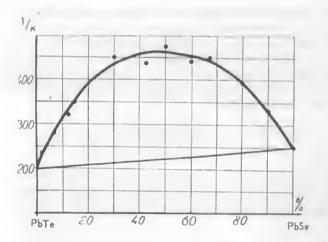


Fig. 12

The presence of impurities in the semiconductor, which affects the electron concentration, mobility, and thermal conductivity at a given temperature, also affects the temperature dependence of these quantities.

Scattering centres introduced by the impurities reduce the thermal conductivity of the semiconductor and slow down the rise of thermal resistance  $1/\kappa$  with temperature.

These effects of impurities are well illustrated in fig. 13, which shows the results of measurements of the thermal conductivity  $\kappa$  of both pure lead telluride (curve 1) and lead telluride containing large amounts of impurities (curve 2). Having determined the thermal conductivity and electrical conductivity of both specimens in the temperature range from  $-40^{\circ}$  to  $300^{\circ}$ C, we could separate the phonon part of thermal conductivity  $\kappa_{ph}$  on the basis of the Wiedemann-Franz law (curves 1a and 2a).

Fig. 13 demonstrates the reduction of the phonon part of thermal conductivity caused by the introduction of impurities. At 50 °C  $\kappa_{ph}$  decreases to a half, viz from  $25 \times 10^{-3}$  to  $12.2 \times 10^{-3}$ . It is also found that in the

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pure substance  $\kappa_{\mu h}$  is approximately inversely proportional to absolute temperature.

$$\frac{\kappa_{ph} \text{ (nt 50°C)}}{\kappa_{ph} \text{ (at 300°C)}} = 1.85,$$

whilst the inverse of the ratio of the absolute temperature is

$$\frac{573^{\circ}\text{K}}{323^{\circ}\text{K}} = 1.78$$
.

The impurity semiconductor presents a completely different picture. For the same temperature ratio (1.78):

$$\frac{\kappa_{ph} \text{ (at 50°C)}}{\kappa_{ph} \text{ (at 300°C)}} = 1.07.$$

Such a negligible drop of  $\kappa_{ph}$  with temperature rise indicates the predominance of phonon scattering by impurities, which is independent of temperature, over scattering by thermal vibrations.

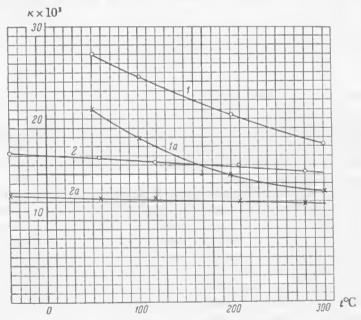


Fig. 13. The effect of impurities on the thermal conductivity of PbTe.

The effect of impurity atoms on the electron concentration a depends on the ionisation energy  $\Delta E$  in the given substance, in other words on the energy level of the electrons in the atom with respect to the homology of the forbidden band.

When the energy level of an electron in an atom is close to the conduction band, this leads to electronic conductivity; on the other hand when there is an electron level in the atom which is closer to the edge of the valence band, the electrons from this band are picked up by impurity atoms which results in hole conductivity. Denoting by  $\Delta E$  the difference between the electron energies in the atom and close to the band edge, and by N the number of impurity atoms, we find

$$n_{+} = \frac{2^{\frac{1}{2}} N^{\frac{1}{2}} (2\pi m^{*} kT)^{\frac{3}{4}}}{h^{\frac{3}{2}}} \times e^{-\frac{\Delta E}{2kT}}$$

The energy  $\Delta E$  depends in turn on the ionisation potential of the utom and the dielectric constant of the medium. For, e.g., hydrogen-like atoms in a medium with a dielectric constant  $\epsilon$ , the radius of the first quantum urbit is

$$r = 0.535 \times \epsilon \times 10^{-8}$$
 cm.

When  $\epsilon$  is of the order of 10 or more, r is appreciably larger than the lattice constant and the medium can be regarded as continuous without introducing a large error. We have then

$$\Delta E = E_0 \times \frac{1}{\epsilon^2} = \frac{13.5}{\epsilon^2} \text{ eV}.$$

As a rule, interstitial impurities distort the lattice more than substitutional impurities, particularly in the region encompassing the bulk of the electric field of the ion. Therefore, when the above formula is applied to interstitial impurities without modifying the value of  $\epsilon$ , the resulting value of  $\Delta E$  is not always accurate.

The temperature dependence of the electronic part of thermal conductivity  $\kappa_{el}$  is given by the Wiedemann-Franz law

$$\kappa_{el} = 1.72 \times 10^{-8} \, \sigma T.$$

When  $\sigma$  rises with temperature, as happens in semiconductors with a low electrical conductivity,  $\kappa_{el}$  increases with temperature at a steeper rate than T.

In semiconductors with a low resistivity, which are mainly used in the construction of highly efficient thermoelements, n often remains approximately constant over a wide temperature range, whilst the mobility u decreases with temperature; consequently o decreases with temperature, this decrease usually being steeper than the increase of T.

In impurity-free substances the mobility decreases with temperature rise according to the law  $uT^{\frac{3}{2}} = \text{const}$  or  $uT^{\frac{5}{2}} = \text{const}$ . When n is constant,  $\kappa_{el}$  decreases with temperature either as  $T^{-\frac{1}{2}}$  or as  $T^{-\frac{3}{2}}$ .

Finally, let us consider the conditions most frequently encountered in semiconductor thermobatteries, when the electrons are produced by impurity atoms. It is possible for the impurities here to be the principal factor governing the scattering of electronic and thermal waves. In comparison with scattering by impurities, which does not vary with temperature, scattering by thermal vibrations, which is proportional to the absolute temperature, then plays a secondary role. Therefore, in such impurity semiconductors, the phonon part of thermal conductivity varies little with temperature (fig. 13). On the other hand, as has already been noted, the temperature dependence of the electronic part of thermal conductivity is governed by the temperature dependence of the product  $\sigma T$ .

Electron scattering by ionised impurity atoms increases with decreasing electron velocity, and the mean electron velocity in non-degenerate semiconductors is proportional to T. Therefore the mobility in such semiconductors, when it depends on scattering by ionised impurities (as often happens at low temperatures), increases, and not decreases, with rise of temperature.

The predominance of scattering by ionised impurities has also another important effect on the thermoelectric properties of the semiconductor: the dependence of the free path length l on the kinetic energy  $\epsilon$  has in this case the form

Therefore the constant term in Pisarenko's formula becomes equal to 4, and the expression for the impurity conductivity for a single type of carrier becomes

$$a = \pm \frac{k}{e} \left[ 4 + \ln \frac{2(2\pi m^* kT)^{3/2}}{h^3 n} \right].$$

The optimum value of  $\alpha = 172 \left(1 + \frac{\kappa_{el}}{\kappa_{ph}}\right) \mu V/\text{deg}$  is reached at higher

values of n than in the case when the first term in the square bracket is equal to 2.

Introduction of impurities reduces the mobility to a lenser degree than it increases a, so that the electrical conductivity a at a given value of a is higher and consequently  $a^2a$  has also a higher value. Since impurities reduce the phonon thermal conductivity  $\kappa_{ph}$ , the value of  $z=\frac{a^2a}{\kappa}$  increases on the introduction of ionised impurities when the number of tons is sufficiently large to govern the mechanism of electron scattering.

Introduction of a large quantity of impurities producing free charges of the same sign frequently raises the carrier concentration to a level at which a degenerate system is formed. As the concentration increases,  $\alpha$  decreases; however, in the degeneracy range  $\alpha$  decreases with  $\sigma$  less steeply than in the non-degenerate state.

Calculations of the optimum value of  $\alpha$  in the case of degeneracy have to be carried out by graphical methods, using tables for the function  $F_r\left(\frac{\mu}{kT}\right)$ . In the case of advanced degeneracy, when  $\frac{\mu}{kT} >> 2$ , the semiconductor can be regarded as a metal with a low concentration of free charges and with r equal to 2. The condition of the minimum of

$$\frac{1}{z} = \frac{\kappa_{ph}}{\alpha^2 \sigma} + \frac{L}{\alpha^2}$$

leads in the general case to the differential equation

$$\frac{d\left(\frac{1}{\sigma}\right)}{d\alpha} = \frac{2}{\alpha} \left(\frac{1}{\sigma} + \frac{L}{\kappa_{ph}}\right) ,$$

where L may range from  $2\frac{k^2}{e^2}T$  to  $3.3\frac{k^2}{e^2}T$ , depending on the extent of degeneracy.

By plotting  $\alpha$  as a function of  $1/\sigma$ , it is possible to find the value of  $a_{opt}$  for a given value of  $L/\kappa_{ph}$ .

After having discussed a number of topics related to the selection of materials for thermoelectric power generators, we shall consider now a few specific examples with some numerical results.

As we have seen, the figure of merit of a thermoelement under the selected optimum conditions is governed by the electron mobility and the phonon thermal conductivity in the range  $T_1 - T_0$ . The total thermal conductivity here always exceeds its electronic part.

Let us assume that for an atomic lattice we have attained the conditions  $\alpha = 172 \ \mu\text{V}/\text{deg}$ ,  $\sigma \approx 4u$ , and take the values of  $10^{-2}$  and  $2 \times 10^{-2}$  for  $\kappa_{ph}$ . Further, we shall take  $T_0 = 300^{\circ}\text{K}$ . Tables 3 and 4 show the values of z and  $\eta$  for these conditions.

The optimum values of the efficiency  $\eta$  are listed in table 5 for both heat acurces with a temperature  $T_1 = 373^{\circ}$ K, as well as for very high

TABLE 3 THE VALUE OF  $z \times 10^3$  AS A FUNCTION OF u AND  $\kappa_{ph}$ 

u cm³/sec×V	W/deg	
cm / sec x v	10	20
100	1.01	0.54
200	1.78	1.0
400	2.85	1.78
800	4.1	2.8
1000	4.4	4.3
2000	5.5	5.4
10000	6.5	6.2

temperature heat sources  $(T_1 = 1800^{\circ}\text{K})$ , assuming in all cases that  $T_0 = 300^{\circ}\text{K}$ ,  $\kappa_{ph} = 10 \times 10^{-3}$  and  $u = 400 \text{ cm}^3/\text{acc} \times \text{V}$ .

We shall make numerical calculations for thermoelectric generators on the following assumptions:

1)  $T_1 = 370^{\circ}\text{K}$ ,  $T_0 = 300^{\circ}\text{K}$ ,  $\sigma = 1600 \text{ ohm}^{-1} \times \text{cm}^{-1}$ ,  $\kappa_{ph} = 20 \times 10^{-3}$ ,  $\kappa_{el} = 7.2 \times 10^{-3}$ ,  $\alpha = 230 \text{ } \mu\text{V/deg}$ ,  $z = 3.1 \times 10^{-3}$ ,  $\eta = 3.6\%$ .

2)  $T_1 = 600^{\circ}\text{K}$ ,  $T_0 = 300^{\circ}\text{K}$ ,  $\sigma = 1600 \text{ ohm}^{-1} \times \text{cm}^{-1}$ ,  $\kappa_{ph} = 15 \times 10^{-3}$ ,  $\kappa_{el} = 10.8 \times 10^{-3}$ ,  $\alpha = 295 \text{ } \mu\text{V/deg}$ ,  $z = 5.4 \times 10^{-3}$ ,  $\eta = 18\%$ .

In both casea, the attainment of  $\alpha=230$  or  $295~\mu\text{V}/\text{deg}$  at an electrical conductivity  $\sigma=1600~\text{ohm}^{-1}\times\text{cm}^{-1}$  requires a very high mobility. Unfortunately, there are few known materials with such a mobility, the phonon thermal conductivity of which at room temperature does not exceed  $20\times10^{-3}~\text{W/cm}\times\text{deg}$ .

TABLE 4

THE VALUE OF  $\eta_{opt}$  (%) AT  $T_0 = 300^{\circ}$ K AS A FUNCTION OF MOBILITY u.

и	$\kappa_{ph} \times 10^3 \text{ W/deg} \times \text{cm}$					
cm³/aec×V	10	20	10	20		
	$T_1 =$	600°K	$T_1 = 1$	000°K		
100	6.1	3.7	12.8	7.7		
200	9.2	6.1	18.5	12.8		
400	12.6	9.2	24.3	18.5		
800	15.8	12.5	26.8	24.5		
1000	16.1	13.6	29.5	25.5		
2000	18.2	16.3	32.5	29.5		
10000	20.0	19.4	34,5	34.2		

The following conditions conform more closely to the proportion of

3)  $T_1 = 600^{\circ}\text{K}$ ,  $T_0 = 300^{\circ}\text{K}$ ,  $\sigma = 1000 \text{ ohm}^{-1} \times \text{cm}^{-4}$ ,  $\kappa_{ph} = 20 \times 10^{-4}$ ,  $\kappa_{el} = 6.5 \times 10^{-4}$ ,  $a = 200 \ \mu\text{V/deg}$ ,  $z = 1.5 \times 10^{-3}$ ,  $\eta = 8.2\%$ .

TABLE 5  $\eta_{opt}$  (%) AT  $T_0 = 300^{\circ}$ K,  $z = 2 \times 10^{-3}$  AND  $u = 400 \text{ cm}^3/\text{wec} \times \text{V}$  AS A FUNCTION OF  $T_1$ 

T°K	373	600	1000	1800
ηορι	3.55	12.6	24.3	37.5
$\eta_{thermodynamic} = \frac{T_1 - T_0}{T_1}$	19.5	50.0	70.0	83.0
$\eta_{opt}$	18.0	25.0	35.0	45.0
1 thermodynamic	18.0	25.0		35.0

In the last case the optimum value of  $\alpha$  would have been 225  $\mu V/degl$  at the same electron mobility,  $\sigma = 875 \text{ ohm}^{-1} \times \text{cm}^{-1}$ ,  $\kappa_{el} = 6.3 \times 10^{-8}$ ,  $\epsilon = 1.7 \times 10^{-3}$ ,  $\eta = 9\%$ .

\* \*

Let us formulate the conditions for achieving high efficiency. It has been shown that the material should be characterised by as high a value of  $z = \alpha^2 \sigma / \kappa$  as possible, and be capable of operation up to very high temperatures  $T_1$  of the heat source.

For thia purpose:

- 1. The phonon component of the thermal conductivity of the aemiconductora ahould be as low as possible. This condition should be antisfied by substances with a low Debye temperature, consisting of heavy molecules weakly bound to each other. The value of  $\kappa_{ph}$  can be further reduced by the introduction of impurities and the formation of solid solutions, provided these impurities do not simultaneously reduce the electron mobility by a similar amount.
- 2. The mobility of current carriers (electrona or holea) ahould be as high as in compatible with condition 1. The mobility should preferably not be reduced much by the introduction of impurities which raise the electrical conductivity σ. This condition will be best satisfied by atomic or molecular lattices with the predominance of acoustic vibrations in the

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thermal spectrum. The mobility can be slightly increased by thorough annealing and in some cases by the introduction of impurity atoms tending to occupy empty lattice aites and reduce any lattice distortion.

- 3. One of the arms should conaist of a purely hole type and the other of a purely electronic type aemiconductor. For this purpose semiconductors should he selected which have low ionisation energy  $\Delta E$ , and a forhidden band of such a width that the concentration should he determined solely hy impurity atoms up to the hot junction temperature. Only at high ratios of electron-to-hole mobilities is it possible to employ semiconductors with a narrow forbidden hand.
- 4. The electron concentration throughout the entire element, from the hot junction temperature  $T_i$  to the cold junction temperature  $T_o$ , should

he so adjusted that the thermal emf  $\alpha = 172 \left(1 + \frac{\kappa_{el}}{\kappa_{ph}}\right) \mu V/\text{deg}$  at the tem-

peraturea prevailing in the various portions of the element. To satisfy this requirement it is necessary to make the thermoelement arms with a variable impurity content or construct them from several parts. In the low temperature zone the impurity concentration should be lower than in the high temperature zone since the value of a at a given  $m^*$  (effective mass of correct carriers) is governed by the ratio  $T^{\frac{3}{2}}/n$ .

- 5. An important requirement for practical applications of the material is its atability to chemical influences, in particular to oxidation, and good mechanical strength and elasticity are necessary to prevent the thermoelement from cracking under the effect of thermal streams.
- 6. In addition to materiala auitable for the arms of the thermoelement it is also necessary to find a material for the metallic bridge connecting the arms which should create neither additional electrical resistances at the houndary with the semiconductors, nor additional thermal stresses.

The last two conditions become particularly important when, instead of a aingle thermoelement, one is considering a pile consisting of a large number of thermoelements. With a thermal emf of  $172 \,\mu\text{V/deg}$  in each arm and a temperature difference of  $300^{\circ}$ , each element generatea about  $0.1 \, \text{V}$ . Consequently it is necessary to connect, e.g., 1000 elements in series to produce a  $100 \, \text{V}$  pile. Therefore, a flexible hond is required between the couplea of the pile and the hot and cold aources in order to avoid damage by thermal atreases.

2.3 Vacuum thermoelements. The low efficiency of semiconductor thermoelements is primarily due to the conduction of heat from the hot junction to the cold junction. Electron scattering in the thermoelement and the transfer of energy, accumulated over a free path length, to the lattice, together with the transfer of thermal energy hy heat waves, create an unfavourable relationship hetween mobility and thermal conductivity.

From this point of view it is af laterest to consider a thermaelement based on thermionic emission in vacuo. Such a generator of electrical energy may, e.g., consist of a number of plates kept at a high temperature  $T_1$  and separated by vacuum from another set of plates maintained at a lower temperature  $T_2$ . Emission increases so steeply with temperature that even at  $T_1 - T_2 > 200^\circ$  the emission of plates at temperature  $T_2$  can be practically neglected in comparison with the emission of the hotter platea. The difference between the kinetic energies in such a system creates an emf of a corresponding magnitude. The current is, however, limited by the space charge; reduction of the space charge is the main problem which has to be overcome in vacuum thermoelectric generators.

Instead of heing transferred through lattice heat conduction, the hent will here pasa through the vacuum hy radiation. Nevertheleas, since the emisaivity is fully determined hy one to two atomic layers, i.e. an outer layer  $10^{-7}$  cm thick, whereaa a layer of an order of  $0.25 \times 10^{-4}$  participates in the radiation and reflection of infra-red rays, it is posaible to produce surfacea characterised by high electronic emission and low radiation.

The reflection coefficient can be increased to 95-97% and the radiation coefficient can be correspondingly decreased. In this way heat conduction, which is the main source of loasea, could be substantially reduced in vacuum electric power generators.

Vacuum generatora can ohviously operate only at high temperatures, viz  $T_1 > 900\,^{\circ}\mathrm{K}$ , whilat there would be no sense in decreasing the temperature  $T_2$  below the limit at which electronic emission substantially decreases.

Taking  $T_1 = 1000^{\circ}$ K and  $T_2 = 700^{\circ}$ K, the thermodynamic efficiency becomes 30% and the efficiency of the thermopile 10%. The temperature difference from  $700^{\circ}$  to  $300^{\circ}$ K could be utilized in a semiconductor thermoelement with an efficiency of, e.g., 10%, thus bringing the total efficiency to 20%.

The power halance of such a device will he found to he favourable as a result of an increase of the efficiency of the thermoelement. Possibilities of practical utilisation of high temperature heat sources in a combination of a vncuum thermoelement with a solid state generator will depend on the specific power output of auch a generator, its dimensions and cost, nll of which depends to a large extent on the attainable emission current density.

## OTHER APPLICATIONS OF THERMOELEMENTS

3.1 Cooling. The problem of the thermoelectric refrigerator is discussed in detail in the section on thermoelectric cooling. We are therefore presenting here only the principal results relating to this application.

Thermoelectric refrigerators utilise the Peltier effect consisting of the generation or absorption of heat at the junction between two conductors when a current is passed through a thermoelectric circuit (fig. 1, p. 36). We shall choose the direction of the current l so that the heat is absorbed from the cooled volume at a temperature T and generated at a room temperature  $T_0$ . The power absorbed at the cold junction is then

$$Q = \alpha l T$$

and that generated at the hot junction

$$Q_0 = a_0 I T_0$$
.

The Joule heat generated in the thermoelement is

$$W = I^2 r$$

where r is the resistance of both branches of the thermoelement. Half of W proceeds to the bot junction and the other half to the cold junction.

The heat transferred from the hot junction to the cold junction by conduction is

$$Q_h = k(T_0 - T).$$

In addition it is necessary to take into account the power consumed by the current flowing against the potential difference between the hot and cold junctions,

$$Q_p = \alpha I(T_0 - T).$$

The coefficient of performance K is equal to the ratio of the power absorbed by the cold junction to the electrical power consumed by the thermoelement

 $K = \frac{aIT - \frac{1}{2}I^{*}r - k(T_{0} - T)}{I^{2}r + a(T_{0} - T)I}$  (58)

75

As in the case of the thermoelectric generator we shall describe the thermal conductance of the thermoelement k and its resistance r by the specific parameters for the two branches  $\kappa_1$  and  $\kappa_2$ ,  $\rho_1$  and  $\rho_2$  and the dimensions of the branches  $S_1$  and  $S_2$ ,  $l_1 = l_2 = l$ . As in the case of the thermoelectric generator K is maximum when

$$\frac{S_1}{S_2} = \sqrt{\frac{\rho_1}{\rho_2} \times \frac{\kappa_2}{\kappa_1}} ;$$

under these conditions

$$kr = (\sqrt{\kappa_1 \rho_1} + \sqrt{\kappa_2 \rho_2})^2.$$

In the expression for K we shall multiply the numerator and denominator by r and replace lr by V. Dividing the numerator and denominator by V we obtain

$$K = \frac{\alpha T - \frac{1}{2}V - k_r(T_0 - T)\frac{1}{V}}{V + \alpha(T_0 - T)}.$$

We shall select the potential difference between the ends of the thermoclement so as to make K maximum. For this purpose we shall equate  $\frac{\partial K}{\partial V}$  to zero which gives

$$V_{opt}^2 - \frac{4kr}{a} \times \frac{T_0 - T}{T_0 + T} V_{opt} - 2kr \frac{(T_0 - T)^2}{T_0 + T} = 0,$$

whence

$$V_{opt} = \frac{2kr}{a} \times \frac{T_o - T}{T_o + T} \left[ 1 + \sqrt{1 + \frac{1}{2}z(T_o + T)} \right].$$

Putting again

$$\sqrt{1+\frac{1}{2}z(T_0+T)}=M,$$

we obtnin

$$V_{opt} = \alpha (T_0 - T) \frac{1}{M - 1}$$
 (59)

<sup>\*</sup> In this chapter K is used to denote the coefficient of performance and k the thermal conductance of the thermoelements.

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and the value of the coefficient of performance corresponding to this value of V

$$K = \frac{T}{T_o - T} \times \frac{M - \frac{T_o}{T}}{M + 1} . \tag{60}$$

The maximum temperature drop  $(T_0 - T)_{max}$  attainable at a given value of M will be obtained by equating K to zero. In this case we have from (59)  $M = \frac{T_0}{T}$  and

$$(T_0 - T)_{max} = \frac{1}{2} z T^2;$$
 (61)

in this case  $V_{opt} = aT$  and the power consumption  $W = \frac{a^2}{r}T^2 = kzT^2$ .

The first multiple in the expression for K represents the thermodynamic efficiency of a reversible Carnot cycle, and the second multiple the reduction of efficiency due to the irreversible processes of thermal conduction and Joule heat generation.

It is easily seen from the expression

$$\frac{1}{\widetilde{K}} = \left(\frac{T_o}{T} - 1\right) \frac{M+1}{M - \frac{T_o}{T}}$$

that the coefficient of performance K decreases (and  $\frac{1}{K}$  increases) with increasing  $\frac{T_0}{T}$  and, for a given  $\frac{T_0}{T}$ , with decreasing M, i.e. decreasing value of  $\frac{1}{2}z(T_0+T)$ .

Taking for example  $z = 2 \times 10^{-3}$ ,  $T_0 = 300^{\circ}$ K, and  $\Delta T = 30^{\circ}$ K, we have M = 1.225, and  $K = 10 \times \frac{0.144}{2.255} = 0.64$ .

Since the conditions which have to be satisfied by the material of the thermoelement in order to achieve maximum K can, as previously, be reduced to the maximum value of  $z(T_0 + T)$ , the selection of materials will be governed by the same considerations as before, except, of course, the effect of temperature on the materials.

Table 6 and fig. 14 give the dependence of the value of  $K_{opt}$  on z and the temperature difference  $(T_o-T)$ . In addition to the value of  $(T_o-T)_{max}$ , following from expressions (59) and (61), table 6 also shows the corresponding values for thermoelectric batteries consisting of two stages arranged

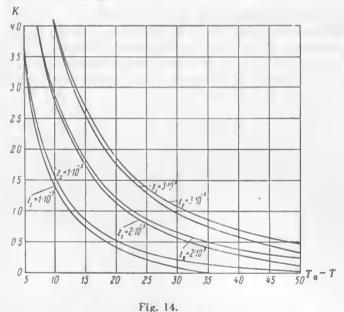
in series  $\left(T_n - \frac{T_n + T}{2}\right)$  and  $\left(\frac{T_n + T}{2} - T\right)$ . It may be shown that, when the coefficients of performance of the individual stages are  $K_1$  and  $K_2$ , the averall coefficient of performance for the two stages in series will be

$$K = \frac{1}{\frac{1}{K_1} + \frac{1}{K_2} + \frac{1}{K_1 K_2}} \tag{62}$$

and when  $K_1 = K_2$ 

$$K=\frac{K_1}{2+\frac{1}{K_1}}.$$

Straightforward calculation shows that the use of two stages increases appreciably the value of K only when K < 1. It is in practice useless to increase the number of stages above two.



When, however, it is intended to achieve the maximum temperature drop without paying attention to energy consumption, each new stage will decrease the temperature by a value somewhat smaller than  $T\frac{Tz}{2}$ . When z is independent of temperature, the reduction of temperature is proportional to  $T^2$ , where T is the final temperature achieved by cooling. Therefore

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successive stages will give smaller and smaller temperature drops. When for example  $z=2\times 10^{-3}$  and  $T_0=300^{\circ}\mathrm{K}$ , the first stage will produce a temperature drop of 59°, the second somewhat less than 40°, the third less than 29°, the fourth less than 22°, etc. The power consumption steeply increases with the increasing number of stages. The maximum temperature drop which may be uchieved with a single stage at  $z=2\times 10^{-3}$  and  $T=100^{\circ}\mathrm{K}$  is only 8.5°.

The main condition governing the efficiency of a cooling device as well as of a generator is the heat flux across the thermopile. In a generator this depends mainly on heat conduction. The amount of heat transferred to the hot junctions is only slightly greater than that removed from the cold junctions. These conditions are somewhat different for a refrigerator: to the power  $Q_c$  removed from the cold end of the thermoelectric battery is added electric energy which often considerably exceeds  $Q_c$  (it is equal to Q/K), and the energy which has to be removed from the hot junction is  $Q_h = Q_c \left(1 + \frac{1}{K}\right)$ . When K = 0.25 the power removed from the hot junction is five times that absorbed by the cold junction.

The hetter the heat transfer conditions hetween the junctions and the surroundings and the lower the temperature difference with reference to the surroundings required for transferring the power  $Q_h/S$  and  $Q_c/S$ , the lower is the temperature difference  $\Delta T$  at the junctions of the thermoelement and the higher its coefficient of performance.

3.2 Heating. Whilst cooling one set of junctions, a thermoelectric battery rnises the temperature of other junctions. In contrast to direct Joule heating, the electrical energy in a thermoelement serves for transporting additional heat energy from the cold to the hot junctions.

The calculations for such a heating device differ from those for a refrigerator in that the half of the Joule heat which is transferred to the cold junctions reduces their coefficient of performance, whilst that transferred to the hot junctions in a heating device is added to the Peltier heat.

The coefficient of performance in this case is

$$K = \frac{a l T + \frac{1}{2} l^2 r - k (T - T_0)}{l^2 r + a l (T - T_0)} = \frac{a T + \frac{1}{2} V - k r (T - T_0) \frac{1}{V}}{V + a (T - T_0)}.$$

Its maximum is obtained from the condition  $\frac{\partial K}{\partial V} = 0$  which gives

THE OPTIMUM COEFFICIENT OF PERFORMANCE  $K_{opt}$  AND  $\left(T_{o}-T
ight)_{max}$  AS FUNCTIONS OF

TABLE

	-	0.1		1.5	67	2.0	2	2.5		3.0	5	
Stages	-	=	1	111	1	11	-	=	-	=======================================	)   }	-
T <sub>o</sub> -T	m m	90	3	80	28	89	65	108	6.1	1 1	100	I B
ຄາ	3.6	3.7	4.9	5.0	6.3	6.3	7.6	7.6	8	0.0	C.1	3.9
	1.4	9.1	2.2	2.25	2.8	2.85	800	3,4	7.7	10	6.1	60
	0.44	0.52	0.83	0.89	1.1	1.2	1.45	1.5	1.8	1.85	2.7	41
0	0.2	0.30	0.55	0.64	0.78	0.86	1.0	1.05		1.35	0.5	
0.1		0.23	0,33	0.45	0.56	0.65	0.78	0.85	0.96	1.06	1.6	9.0
-	1	0.16	0.21	0.34	0.41	0.50	0.56	99.0	0.74	0.55	1.3	1-
-	_	0.11	0.12	0.26	0.29	0.38	0.44	0.56	0.58	0.70	1.03	6.3
	_	0.07	1	0.21	0.20	0.31	0.33	0.44	0.45	0.58	0.34	10
1	_	0.03	1	0.15	0.11	0.24	0.22	0.33	0.33	0.47	0.58	0

$$V_{opt} = \frac{\alpha (T - T_o)}{M - 1},$$

where 
$$M = \sqrt{1 + \frac{1}{2}z(T_0 + T)}$$
.
At  $V_{opt}$ 

$$K = \frac{T}{T - T_0} \left( 1 - 2 \frac{M - 1}{Tz} \right).$$

At  $z = 2 \times 10^{-3}$ ,  $T_0 = 270^{\circ}$  and  $T - T_0 = 30^{\circ}$ , M = 1.255, Tz = 0.6 we have  $\frac{T}{T - T_0} = 10$  and K = 1.5.

The values of  $K_{opt}$  are tabulated below for various z and  $(T-T_o)$ . The values of K can be raised by using two stages. With three successive stages, each raising the temperature by  $\Delta T/3$ , the coefficient of performance is still higher than with two stages, each raising the temperature by  $\Delta T/2$ . Thus, in raising the temperature by 30° from 300° to 330°K the coefficient of performance is

It follows from table 7 that the advantages of thermoelectric heating for general beating purposes become appreciable at  $z > 2 \times 10^{-3}$ , particularly when the temperature difference between the junctions does not exceed 40°. At  $z = 5 \times 10^{-3}$  and  $\Delta T = 40^{\circ}$  only half of the heat is supplied by the electric power fed into the battery; the other half is pumped by the thermoelements from the cold junctions utilising low temperature heat sources, such as water in rivers or pipelines. When  $\Delta T = 30^{\circ}$  the same result is obtained at  $z = 3 \times 10^{-3}$ .

The smaller  $\Delta T$ , the greater are the advantages of thermoelectric heating. Thus, e.g., when  $z=3\times10^{-3}$  the electric power required to raise the temperature of water by  $10^{\circ}$  and  $5^{\circ}$  is, respectively, five and eight times less than that required by conventional electric heaters.

In the case of cooling by a small  $\Delta T$ , the electric power required to cool by 10° and 5° is, respectively, four and eight times less than that consumed by conventional electrical cooling devices (assuming  $z = 3 \times 10^{-3}$ ).

THE OPTIMUM COEFFICIENT OF PERFORMANCE  $K_{opt}$  AS A FUNCTION OF z AND T

TABLE

				2.	.7		7.3		0.5	0	9		8	n	2	
Stages T-T	-	11	I	11	I	11	<b>⊢</b>	11	=	11	П	11	-	II	-	$L \hookrightarrow L$
2	4.9		ος. (3)		7.0		8.3		9.7		11.6		13.6		21	61
10	3.1		20.		4.0		4.6		5.5		6.2		7.3		10.6	20
15	2.1		2.3		2.7		33.1		3,7		424 424		5.0		63	21
20	1.8	1.8	2.1	2.1	2.3	2.3	2.6		3.0		3.6		0.7		0.0	12
25	1.6	1.65	1.75	8.1	2.0	2.05	2.3		10		3.1		50		1-1	10
30	1.3	1.88	7:-	1.47	1.65	1.68	1.8	1.8	2.15	2.15	67	6.5	ci	ori ori	97	p=q
40	1.0	1.25	5:1	1.00	1,45	1.5	1.6	1.7	1.8	1.0	e;	1:1	c:	er e i	27	83
20	1.0	1.18	1.05	1.22	1.25	1.34	1.45	1.5	1.6	1.6	1.8	1.85	2.0	105	e i	9-

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3.3 Measuring techniques. Thermocouples have been used for temperature and radiant energy measurements for many years. Until the last few decades these were the only applications of thermocouples.

Thermal emf's of semiconductors are at least one order of magnitude higher than in metals. Semiconductors may have  $\alpha$  reaching 1000  $\mu\text{V}/\text{deg}$ , whilst metals give no more than 20  $\mu\text{V}/\text{deg}$ , and metal alloys up to 50  $\mu\text{V}/\text{deg}$ . Measurement of the temperature difference between the junctions is usually carried out with the aid of a potentiometric scheme in which the current is equal to zero. It would appear that semiconductors would give sensitivities ten times higher. In spite of this, semiconductors have not found a wide practical application in temperature measurement.

Semiconductor resistors - thermistors - are finding increasing application.

Thermopiles acting as radiant energy receivers are made of metal alloys. It has been recently found that some of these alloys are typical semiconductors, although not the best ones by far, either with regard to the thermal emf or efficiency. The sensitivity of a thermopile is governed by the electrical energy generated by the absorbed radiant energy, and to permit the amplification of extremely small radiations it is necessary to use emf's as large as possible.

The conditions for the optimum efficiency are the same as those derived for generators, whilst the requirements for thermopiles feeding an amplifier can be reduced to the attainment of the maximum emf's and are far from having been achieved in available instruments. The rational selection of semiconductor materials would make it possible to increase the sensitivity of thermopiles.

Photoconductors and bolometers are finding an increasing application in practice. In addition, the sensitivity of the available radiant energy detectors is already close to the maximum attainable, which is governed by the noise level. Therefore an increase of their efficiency is of no interest for practical purposes.

The existence of semiconductors with melting points up to 4000°C on the one hand, and technical processes involving very high temperatures, which exceed those which can be withstood by metals, on the other hand, leads us to expect that semiconductor thermocouples will find an increasing application in this temperature range.

The form of semiconductor thermocouples will probably differ from the thin wire construction used in the current metallic thermocouples.

3.4 Sound generators. In chapter 2 mention was made of thermal deformations taking place in a semiconducting plate when a current is passed through it; the plate bends into a spherical shape with a radius

$$R = \frac{l}{p(T_1 - T_2)}$$

where l is plate thickness, p coefficient of linear thermal expansion, and  $(T_1 - T_2)$  temperature difference between the two opposite faces of the plate.

In order to calculate this temperature difference we shall consider that an alternating current is passed through the plate, the frequency of the current being such that there will be enough time for the heating of one face and the cooling of the other face to spread to the central plane of the plate, the temperature of which remains constant (since here we are neglecting the Joule beat amounting, in this case, to approximately 1% of the Peltier heat developed at the faces).

Let the current density in the plate be I. The Peltier heat generated and absorbed per 1 sec in a plate with a 1 cm<sup>2</sup> area is then Q = alT. At a frequency of N c/s the heat generated in a half period is equal to  $\frac{1}{2N}alT$  joules. This energy will beat one half of the plate and cool the other half by

$$\Delta T = \frac{1}{2N} a l T \frac{2}{c l},$$

where c is the specific beat (per cm3);

$$T_1 - T_2 = 2\Delta T = \frac{2}{N}alT\frac{1}{cl}$$

un d

$$R = \frac{N}{2} \times \frac{l^2 c}{p \alpha l T}.$$

We shall put, as an example, N=50 c/s,  $l=10^{-2}$  cm, c=2 joule/cm<sup>2</sup>,  $\rho=2\times10^{-5}$  deg<sup>-1</sup>,  $\alpha=2\times10^{-4}$  V/deg, l=40 A/cm<sup>2</sup>, and  $T=300^{\circ}$ K; this gives

$$T_1 - T_2 = 4.8^{\circ}$$
C and  $R \approx 100$  cm.

When the plate is a circular membrane 5 cm in diameter, the amplitude of forced oscillations will in this case be equal to 0.6 mm. Such a membrane may serve as a powerful source of sound waves of the order of 2 W. A membrane 10<sup>-3</sup> cm thick would generate sound waves with a frequency of 10,000 c/s.

3.5 Crystallisation. Peltier heat Q = alT is generated or absorbed at the interface between the solid and liquid phases of one and the same conductor, as well as at the boundary between two different substances.

The heat evolved in crystallisation can be removed not only in the usual manner by thermal conduction, but also, through the l'eltier effect, by the flow of electrons.

Let us consider the conditions of crystallisation at a boundary with an area of 1 cm<sup>2</sup> when the melting point is  $T_0$ . We shall assume that a current with a density of l A/cm<sup>2</sup> is supplied to metallic blocks which are good conductors and the temperature of which is maintained at  $T_0$ .

We shall denote the specific heat of fusion by q cal/gm=4.19q joule/gm==Q joule/gm; the density of the solid phase by d gm/cm³; the thermal emf between the solid and liquid phases by  $\alpha$  V/deg; the resistivity of the liquid by  $\rho_1$  ohm × cm; the resistivity of the solid phase by  $\rho_2$  ohm × cm; the thickness of the liquid layer by  $L_1$  cm; the thickness of the solid phase by  $\frac{\Delta L}{\Delta t}$  cm/sec. The power developed or absorbed at the boundary is

$$W = \alpha l T_0 - \frac{1}{2} l^2 (\rho_1 L_1 + \rho_2 L_2).$$

Since the temperatures at the boundary between two phases and at the electrodes are equal, there is no doubt that the Joule heat will be equally divided between the electrodes and the boundary. The second term represents, here, the power supplied to the boundary from solid and liquid phases; the first term is the Peltier heat removed by current *l*, expressed as power.

The power IV determines the rate of crystallisation:

$$\frac{\Delta L}{\Delta t} = \frac{W}{Qd} = \frac{\alpha l T_0 - \frac{1}{2} l^2 (\rho_1 L_1 + \rho_2 L_2)}{Qd}$$

The rate of crystallisation will be a maximum at a current density  $l_{\it opt}$  satisfying the equation

$$\frac{d\frac{\Delta L}{\Delta t}}{dl} = 0$$

or

$$l_{opt} = \frac{\alpha T_o}{\rho_1 L_1 + \rho_2 L_2}.$$

At this value of  $l = l_{opt}$ 

$$\frac{\Delta L}{\Delta t} = \frac{1}{2} \frac{(\alpha T_0)^2}{Qd(\rho_1 L_1 + \rho_2 L_2)}$$

TABLE B

	4	d	a×104	$T_{\circ}$	$\rho_s \times 10^4$	l <sub>opt</sub> A/cm <sup>2</sup>	$\left(\frac{\Delta L}{\Delta t}\right)_{l=l}$ equ	$\left(\frac{\Delta L}{\Delta t}\right)_{l=100 \text{ A/cm}^3}$
/n	26	7.1	. 8	693	20	280	1.0×10 <sup>-1</sup>	0.63×10 <sup>-1</sup> cm/sec = 2.3 cm/hr
111	14	9.8	29-62	544	240	110	2.6×10 <sup>-3</sup>	2.5 × 10 <sup>-1</sup> cm/sec - 9 cm/hr
Ca	4	1.9	10	300	19	150	7×10-8	0.63×10 <sup>-3</sup> cm/sec - 23 cm/hr
fi.d	120	5.5	-100	1250	1300	~100	2.2×10 <sup>-2</sup>	4.5 ×10 <sup>-8</sup> cm/sec = 16.4 cm/kr at /= 10 A/cm <sup>8</sup>

The May 1957 issue of the Journal of Electronies, pp. 597-608, contains a paper by W. G. Pfann, K. E. Benson and J. H. Wernick concerning the use of the l'eltier effect for the crystallisation of well-conducting liquids and in particular semiconductors.

ilowever, as the authors of the article themselves point ont, their treatment differs substantially from our approach.

l consider the most important advantage of the Peltier effect to consist of the possibility of earrying out crystallisation under Isothermal conditions at the melting point. This prevents the sppearance of thermal atresses and plantle deformations. It is probably also the only method of preparing perfect crystals by some melting. The possibility of ereating p-n junctions by varying the magnitude or direction of the entrent was self-evident.

On the other hand, Pfsnn et al. are mainly interested in this last process. Consequently, there was no need for ns to consider the temperature gradient; all that was necessary was to assess the magnitude of the current which would not appreciably affect the constancy of the temperature, whereas in the aforementioned paper it is equally natural to take into account primarily the transport of the Peltier heat along the temperature gradient.

In the Russian edition of this book the value of the thermal emf at the boundary between solid and liquid germanium was listed as  $\alpha=15\times10^{-6}$  V/deg. At the time of writing of the book our measurements had not been completed and this value appeared to be the smallest of all the possible ones. It was important to show that even at such low values of  $\alpha$  it was possible to attain adequate crystallisation velocities.

The pronounced effect of the plastic deformation of Ge and Si on the value of  $\alpha$  impedes its measurement at the meiting point. However, when  $\alpha$  is determined by extrapolation in the solid and liquid states, the resulting value of  $a_{sol}-a_{llq}$ 

is close to 100  $\mu$ V/deg. It is this value that is used in the calculations of parameters liated in the last line of table 8.

OTHER APPLICATIONS

When  $l << l_{opt}$  the second term in the expression for W becomes small in comparison with the first term and it is sufficiently accurate to assume that  $\frac{\Delta L}{\Delta t} \approx \frac{alT_0}{Qd}$ . The rate of crystallisation is then proportional to the current density.

Table 8 shows the data for some metals and semiconductors. It is assumed that  $L_1$  and  $L_2$  have such values that  $\rho_1 L_1 + \rho_2 L_2 = \rho_2$ .

Peltier heat is absorbed or generated with no inertia at the very surface where the crystallisation or melting process takes place, and the Peltier heat input exceeds the Joule heat input up to current densities of several hundreds A/cm2. Therefore the current flow under these conditions governs the progress of crystallisation over the entire surface across which the current passes.

For the removal of impurities and the production of very pure substances use is made of so-called zone melting, in which a furnace moved along n cylindrical specimen creates a narrow molten zone slowly progressing along the rod together with the furnnce.

The moving furnace can be replaced by passing current through the specimen; the current will continuously fuse the solid rod at one end and crystallise the melt at the same rate at the other end.

The molten zone, without changing its width, will move under the effect of a current, of density I, at a velocity of

$$v = \frac{l}{100} \left( \frac{\Delta L}{\Delta t} \right)_{l = 100 \text{ A/cm}^2}$$

as has been calculated previously.

Without listing other possible applications of the Peltier heat for the crystallisation process it may be noted that the Poltier heat presents us with a new method for controlling the crystallisation process under constant temperature conditions.

3.6 Examples of thermoelectric devices. There are still many remote inhabited places in the world where electrical energy is not available. As a rule, in such places, kerosene is used for providing light. A kerosene lamp provides a large amount of heat which may be utilised for producing enough electrical energy for operating a radio receiver or even a transmitter set.

Fig. 15 shows a photograph of a kcrosene lamp manufactured in the U.S.S.R. over the glass of which is mounted n tube consisting of thermoelements. The inside of the tube is heated by the hot combustion gases and the outside is cooled with the aid of a set of radiators. The tempernture difference created in this way amounts to 250-300°C; this gives a few watts of electrical energy for feeding a radio receiver set.



Fig. 15

Fig. 16 shows a more powerful battery rated at 15-20 W which in mounted on a kerosene burner and used to feed radio transmitters used in agricultural work. Thermoelectric batteries are used in tractors in place of dynamos.

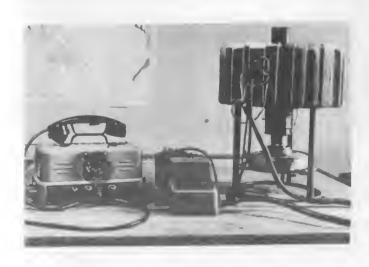


Fig. 16

OTHER APPLICATIONS

More powerful generators with capacities of 200 and 500 W are also being manufactured. These generators use all types of fuels (firewood or petrol) and are intended for the far North. A furnace generating 200 W consumes approximately 2 kg of firewood per hour.

There is also an experimental thermoelectric battery in operation generating 100 W, utilising solar energy.



Fig. 17

Cooling devices utilising thermoelements include a water-cooled domestic refrigerator shown in fig. 17. The total weight of semiconductor materials used in its cooling units is around 50 gm and its energy consumption is approximately 50 W.



Fig. 18

1 ig. 18 shows a thermostatic device for electronic equipment featuring automatic cooling and heating.

APPENDICES

1. Summary of principal formulae for calculating the thermoelectric properties of semiconductors in the presence of a degenerate electron gas. In the most general case, applicable to both a non-degenerate and a degenerate electron gas in semiconductors, the formulae for calculating thermoelectric properties can be written down in the following form.

a. The case of scattering by constant frequency oscillations (r-1):

$$\alpha = \pm \frac{k}{e} [(1 + e^{-\mu^*}) F_0(\mu^*) - \mu^*],$$

$$\sigma = \frac{16\pi m^* e^2}{3h^3} \times \frac{l_0}{1 + e^{-\mu^*}},$$

$$\kappa_{el} = \frac{16\pi \, m^* l_o}{3h^3} \, k^2 T \, [ \, 2F_1(\mu^*) - (1 + e^{-\mu^*}) \, F_o^2(\mu^*) ],$$

$$A = [\ 2F_{_1}(\mu^*) - (1 + e^{-\mu^*}) \ F_{_0}^2(\mu^*)](1 + e^{-\mu^*}),$$

$$\frac{\kappa_{el}}{\sigma} = A \left(\frac{k}{e}\right)^2 T,$$

where  $\mu^* = \frac{\mu}{kT}$  is the reduced chemical potential,  $l = \frac{l_0}{\epsilon}$  is the free path length, and  $F_0(\mu^*)$  and  $F_1(\mu^*)$  are Fermi integrals.

The formula for the coefficient in the Wiedemann-Franz law yields the following limiting values: in the classical case A=1; in the case of complete degeneracy  $A=\frac{\pi^2}{3}$ .

In the intermediate case of partial degeneracy A should be calculated from the general expression.

b. The general case contains all furms of scattering in addition to the preculing one:

$$a = \pm \frac{k}{e} \left[ \frac{r+2}{r+1} \times \frac{F_{r+1}(\mu^*)}{F_r(\mu^*)} - \mu^* \right],$$

$$\sigma = \frac{16\pi \, m^* e^2}{3h^3} \, l_0(T) (kT)^{r+1} (r+1) \, F_r(\mu^*) \,,$$

$$\kappa_{el} = \frac{16\pi m^* l_o(T) k}{3h^3} (kT)^{r+2} \left[ (r+3) F_{r+2}(\mu^*) - \frac{(r+2)^2}{(r+1)} \times \frac{F_{r+1}^2(\mu^*)}{F_r(\mu^*)} \right],$$

$$n = 4\pi \left(\frac{2m^*kT}{h^2}\right)^{3/2} F_{1/2} (\mu^*),$$

here  $F_r(\mu^*)$  are Fermi integrals of the type  $F_r(\mu^*) = \int_0^\infty \frac{x^r dx}{e^{x-\mu^*} + 1}$ .

is the current carrier concentration in the conduction band, and  $l=l_0(T)e^{r}$  is the free path length.

The Wiedemann-Franz coefficient for the general case is given by the

$$A = \left[ \frac{(r+3)}{(r+1)} \times \frac{F_{r+2}(\mu^*)}{F_r(\mu^*)} - \frac{(r+2)^2}{(r+1)^2} = \frac{F_{r+1}^2(\mu^*)}{F_r^2(\mu^*)} \right].$$

It can be shown that A has the following limiting values: in the classical case A = r + 2; in the case of complete degeneracy  $A = \pi^2/3$ .

In the case of partial degeneracy use should be made of the general formulae.

Thus, using combinations of these expressions and the tables of Fermi functions listed in Appendix 2, it is possible to calculate theoretically, taking account of degeneracy, the values of the thermoelectric quantities or their combinations in relation to  $\mu^*$  or the concentration n.

2. Reference tables of Fermi functions. Fermi functions for all the tunes of interest are given in the range  $\mu^*=-4$  to  $\mu^*=4$ . Outside this tange at  $\mu^*<-4$ , farmulae for the non-degenerate case will give results not more than 1% in error, and at  $\mu^*>4$  when the electron gas is highly degenerate use can be made of farmulae of the quantum theory of metals when the errors will not exceed 1.2%

In this case, Fermi functions can be approximated by the following expression:

$$\int_{0}^{\infty} \frac{f(\epsilon) d\epsilon}{\frac{\epsilon - \mu}{kT}} = \int_{0}^{\mu} f(\epsilon) d\epsilon + \frac{\pi^{2}}{6} (kT)^{2} \left(\frac{df(\epsilon)}{d\epsilon}\right)_{\epsilon = \mu} + \frac{7 \pi^{4}}{360} (kT)^{4} \left(\frac{d^{3} f}{d\epsilon^{3}}\right)_{\epsilon = \mu} + \dots$$

* 1.	Fo (µ*)	$F_{\frac{1}{2}}$ ( $i\lambda^*$ )	$F_1(\mu^*)$	$\frac{2}{3}F_{\frac{3}{2}}(\mu^*)$	F2 (µ*)	F 5 (4 *)	F <sub>3</sub> (µ*)	$F_4(\mu^*)$
-4 -3 -2 -1 0 1 2	0.018 0.049 0.127 0.313 0.693 1.313 2.127 3.049 4.018	0.016 0.043 0.115 0.290 0.678 1.396 2.502 3.977 5.771	0.018 0.049 0.131 0.339 0.823 1.806 3.513 6.096 9.627	0.016 0.044 0.117 0.307 0.769 1.774 3.691 6.902	0.037 0.099 0.266 0.705 1.803 4.312 9.445 18.870 34.490	0.20 0.56 1.43 3.68 8.55 17.60 31.90	0.101 0.298 0.805 2.160 5.682 14.390 34.300 75.730 154.300	0.439 1.194 3.231 8.721 28.340 60.981 159.290 363.690 814.640

Data for the function  $F_{5/2}(\mu^*)$  have been obtained by graphic extrapolation.

Part 2
THERMOELECTRIC COOLING

### INTRODUCTION

In 1911 Altenkirch\* developed the theory of thermoelectric cooling and derived thermodynamic expressions for the principal parameters of a thermoelectric refrigerator. Altenkirch, basing his considerations on the assumption that metals, which followed the Wiedemann-Franz law, were the best materials for thermoelements - an assumption which was quite natural at the beginning of this century - reached the incorrect conclusion that thermoelectric refrigerators were uneconomical and therefore could not find practical application.

A. F. loffe\*\* developed the theory of semiconductor thermoelements in 1949, and showed that, from an economical point of view, semiconductor refrigerators could compete with modern refrigerating machines. A year later work was started at the Laboratory (now Institute) for Semiconductors of the Academy of Sciences of the U.S.S.R. with the aim of checking this theory experimentally. The prototype domestic refrigerator constructed in 1953 had a coefficient of performance of 20% when the temperature inside the refrigerator was 24°C below room temperature.

Thermoelements have now been developed which can produce a temperature drop of more than 60°C, which opens the way for a number of practical applications of thermoelectric cooling. The Institute for Semiconductors of the Academy of Sciences of the U.S.S.R. is working, in conjunction with Institutes representing various branches of industry, on the use of semiconductor thermoelements for cooling and thermostatic control of individual blocks of electronic equipment and special instruments.

Our aim here is to outline the current state of the problem of thermoelectric cooling.

\* E. Altenkirch, Phys. Zs., 12, 920, 1911.

<sup>\*\*</sup> A. F. loffe: "Energeticbeskie osnovy termoelektricheskikh batarei iz poluprovodnikov" (Energeticprinciples of semiconductor thermoelectric batteries), published by the Academy of Sciences of the U.S.S.R., 1949,

# THEORY OF THERMOELECTRIC COOLING

1.1 Thermodynamic theory. Thermoelectric generators are based on the use of the Seebeck effect. If the junctions in s circuit consisting of two different conductors are maintained at different temperatures  $T_1$  and  $T_0$ , an emf appears in the circuit

$$E = (a_1 - a_2)(T_1 - T_0), \tag{1}$$

where  $a_1$  and  $a_2$  are the thermal emf coefficients of the arms of the thermoelement with reference to some standard material.

Thermoelectric cooling makes use of the reverse phenomenon, namely the Peltier effect. When an external source of emf is connected to such a circuit, heat is generated at one junction and absorbed at the other junction. The amount of heat generated or absorbed in one second is

$$Q_{\Pi} = \Pi I, \qquad (2)$$

where *l* is the current and Il is the Peltier coefficient, which is related to the thermal emf coefficient by the expression

$$\Pi = (a_1 - a_2)T, \tag{3}$$

where T is the temperature of the corresponding junction.

There also exists a third thermoelectric phenomenon, the Thomson effect, the nature of which is as follows: when there is a temperature drop  $T_1 - T_0$  along a conductor through which an electrical current is flowing, then, in addition to the Joule heat, Thomson heat is generated or absorbed within the conductor

$$Q_{\rm r} = r(T_1 - T_0)I, \qquad (4)$$

where r is Thomson coefficient which is related to the thermal emf coefficient by the expression

$$r = T \frac{da}{dT} , \qquad (5)$$

We shall first of all assume that in the temperature range  $T_0$  to  $T_1$  the thermal emf coefficient is constant and therefore r=0. We shall also assume that the thermal conductivity and electrical conductivity of the arms of the thermoelement are constant.

When the junction at which hent is generated is maintained at a constant temperature  $T_0$ , then the other junction will cool down until the sum of the hent transferred from the surroundings  $(Q_0)$  and the heat flowing along the arms of the thermoelement  $(Q_T)$  becomes equal to the absorbed Politic heat. The steady state condition is therefore

$$Q_{\Pi} = Q_0 + Q_T. \tag{6}$$

The heat flux  $Q_T$  reaching the cold junction along the arms of the thermoelement consists of two parts:

1) the heat transferred by thermal conduction

$$Q_t = K(T_0 - T_1), \tag{7}$$

where K is the thermal conductance of the thermoelement arms; and

2) half of the Jonle heat generated within the arms of the thermoelement

$$Q_f = \frac{1}{2} I^2 R. \tag{1}$$

(It can be readily shown that, irrespective of the value of the temperature gradient, the Jonle heat is equally divided between the hot and cold junctions.) Therefore equation (6) can be written down in the form

$$Q_{0} = \prod I - \frac{1}{2} I^{2} R - K (T_{0} - T_{1}), \qquad (9)$$

OF

$$T_{o} - T_{1} = \frac{\Pi I - \frac{1}{2}I^{2}R - Q_{o}}{K}$$
 (10)

It follows from expression (10) that, under otherwise equal conditions, the temperature difference  $T_0 - T_1$  across the thermoelement is a maximum when the cold junction is perfectly insulated thermally  $(Q_0 = 0)$ ; when, on the other hand, the cold junction is in thermal contact with an object which is to be cooled (e.g. the internal chamber of a refrigerator cabinet

TREORY OF TREEMOLLECTRIC COOLING

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or some other apparatus), the temperature drop will be smaller, in both cases the thermoelement operates as a refrigerating machine with the electron gas playing the part of the cooling agent.

The principal parameter characterising a refrigerating machine is the coefficient of performance

$$\epsilon = \frac{Q_0}{W}$$
, (11)

where  $Q_0$  is the heat removed in unit time from the cooled object and W is the power consumption.

In the case of thermoelectric cooling, the power consumption consists of two parts W, and W,h:

$$W = W_I + W_{th}. \tag{12}$$

W, denotes the power generated in the arms of the thermoelement, i.e.

$$W_J = I^2 R, \qquad (12a)$$

and With the power required for overcoming the thermal emf, i.e.

$$W_{th} = El = (a_1 - a_2)(T_0 - T_1)l.$$
 (12b)

Therefore,

$$W = l[(a_1 - a_2)(T_0 - T_1) + lR]$$
 (13)

and according to (9), (11), and (13)

$$\epsilon = \frac{(a_1 - a_2) l T_1 - \frac{1}{2} l^2 R - K (T_0 - T_1)}{l [(a_1 - a_2) (T_0 - T_1) + lR]}$$
 (14)

It will be seen from expressions (10) and (14) that both the temperature difference across the thermocouple and the coefficient of performance depend on the current l. By equating the derivatives  $\frac{\partial (T_0 - T_1)}{\partial l}$  and  $\frac{\partial \epsilon}{\partial l}$  to zero we can find the optimum values of the current and the corresponding maximum values of the temperature difference and the coefficient of performance. Straightforward calculations yield the following results:

1) the temperature difference  $\Delta T = T_0 - T_1$  reaches its maximum value  $\Delta T_{max}$  at a current

$$I_{m} = \frac{(a_{1} - a_{2}) T_{1}}{R} . \tag{15}$$

When, in addition,  $Q_0 = 0$ 

$$\Delta T_{max} = \frac{(a_1 - a_2)^3}{RK} \times \frac{T_1^3}{2} = \frac{1}{2} \pi T_1^3, \qquad (16)$$

where

$$z = \frac{(a_1 - a_2)^3}{RK};$$
 (16a)

2) the coefficient of performance e reaches its maximum value for a current of

$$l_{0} = \frac{(\alpha_{1} - \alpha_{2})(T_{0} - T_{1})}{\left(\sqrt{1 + \frac{1}{2}z(T_{0} + T_{1})} - 1\right)R}$$

and for a potential difference over the thermoelement of

$$v_{0} = l_{0}R + (a_{1} - a_{2})(T_{0} - T_{1}),$$

$$v_{0} = \frac{(a_{1} - a_{2})(T_{0} - T_{1})\sqrt{1 + \frac{1}{2}z(T_{0} + T_{1})}}{\sqrt{1 + \frac{1}{2}z(T_{0} + T_{1})}},$$
(18)

whence

OF

$$\epsilon_{0} = \frac{T_{1}}{(T_{0} - T_{1})} \times \frac{\sqrt{1 + \frac{1}{2}z(T_{0} + T_{1}) - \frac{T_{0}}{T_{1}}}}{\sqrt{1 + \frac{1}{2}z(T_{0} + T_{1}) + 1}}.$$
(19)

For the sake of simplicity we shall assume initially that both arms of the thermoelement possess equal thermal conductivities  $(\kappa_1 = \kappa_2 = \kappa)$ , equal electrical conductivities  $(\sigma_1 = \sigma_2 = \sigma)$ , and equal, but opposite, thermal emf coefficients  $(|\alpha_1| = |\alpha_2| = a)$ . We shall also assume that the cross-

<sup>\*</sup> See equation (14a) on p. 115.

See equation (19a) on p. 115.

THEORY OF THERMOSLECTRIC COOLING

section areas of the elements  $S_1$  and  $S_2$  and their lengths  $l_1$  and  $l_2$  are equal:  $S_1 = S_2 = S$ ;  $l_3 = l_2 = l$ .

Under these conditions, assuming for the moment that  $\alpha$ ,  $\sigma$ , and  $\kappa$  are independent of temperature, we have

$$z = \frac{a^2 \sigma}{\kappa} \,. \tag{20}$$

Expressions (16) and (19) show that, under prescribed operating conditions ( $T_0$  and  $T_1$ ), the coefficient of performance and the maximum temperature drop depend only on the value of z, which describes the quality of the thermoelement; with increasing z the coefficient of performance tends towards its upper limit:

$$\epsilon_{max} = \frac{T_1}{T_0 - T_1},\tag{21}$$

i.e. to the coefficient of performance of an ideal thermodynamic machine. We should, therefore, investigate the conditions under which z reaches its maximum value.

1.2 Conditions for maximum efficiency of the thermoelements. The properties of the substance which enter into the expression for z (the thermal emf coefficient  $\alpha$ , the electrical conductivity  $\sigma$ , and the thermal conductivity  $\kappa$ ) are not independent of each other; they are all functions of the concentration of free electrons (or holes) n. This relationship is shown qualitatively in fig. 1. The electrical conductivity  $\sigma$  is roughly

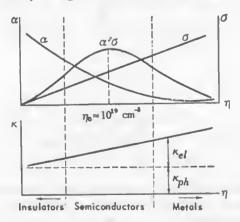


Fig. 1

proportional to the carrier concentration a. The thermal out a, on the other hand, tends to zero with an increase of the number of carriers, and increases indefinitely as the carrier concentration decreases.

The thermal conductivity  $\kappa$  is the sum of a lattice thermal conductivity  $\kappa_{nh}$  and an electronic thermal conductivity  $\kappa_{nl}$ :

$$\kappa = \kappa_{ph} + \kappa_{el}; \tag{22}$$

to a first approximation  $\kappa_{ph}$  is independent of n, whilst  $\kappa_{el}$  is proportional in n.

It is seen from fig. 1 that the numerator of the expression for z has a maximum at carrier concentrations of the order of  $10^{19}$  cm<sup>-2</sup>, i.e. approximately 1000 times smaller than the free electron concentration in metals. The part played by the electronic thermal conductivity is then relatively small in comparison with the lattice thermal conductivity and, therefore, the maximum of the expression for z is only very slightly shifted from the maximum of  $a^2\sigma$  towards lower electron concentrations. The value of z for insulators is small owing to their negligible electrical conductivity, and for metals and alloys owing to their very low thermal emf coefficient.

These qualitative considerations explain the renson why the efficiency of metallic thermoconples is very low and why, consequently, thermoelectric generators and refrigerators have not yet found wide technical applications. By using semiconducting substances as materials for the branches of the thermoelements and by a suitable selection of their carrier concentration it is possible to increase the efficiency of thermoelements by tens of times.

In order to formulate these qualitative considerations quantitatively we ought to use expressions for the thermal emf coefficient, electrical conductivity, and thermal conductivity derived from the quantum theory.

We are giving below the most general expressions for the thermal emf coefficient a, the electrical conductivity  $\sigma$ , the thermal conductivity  $\kappa$ , and the free carrier concentration n which are valid both for semiconductors and metals\*. All these quantities are expressed as functions of the reduced chemical potential  $\mu^*$ :

$$\mu^* = \frac{\mu}{kT} \,, \tag{23}$$

where  $\mu$  is chemical potential, and k the Boltzmann constant. There is no need for deriving the relevant expressions here; the reader will find them

\* A. G. Samoilovich and L. L. Korenblit, Usp. Fiz. Nauk, 57, No. 4, 578, 1955.

in several textbooks, monographs, and articles. We reproduce these formulae in their exact form:

$$\alpha = \pm \frac{k}{e} \left[ \frac{r+2}{r+1} \times \frac{F_{r+1}(\mu^*)}{F_r(\mu^*)} - \mu^* \right],$$
 (24)

$$n = \frac{4\pi \left(2mkT\right)^{\frac{3}{2}}}{h^3} F_{\frac{1}{2}}(\mu^*), \qquad (25)$$

$$\sigma = \frac{16\pi m l_0(T) e^2}{3h^3} (kT)^{r+1} F_r(\mu^*), \qquad (26)$$

$$\kappa_{el} = \frac{16\pi m l_0(T)(kT)^{r+2}}{3h^3} \left[ (r+3) F_{r+2}(\mu^*) - \frac{(r+2)^2 F_{r+1}^2(\mu^*)}{(r+1) F_2(\mu^*)} \right]. (27)$$

We use here the following notation:

1) l is the electron free path length, which depends on the energy  $\epsilon$  of the electron and the temperature; in the general case this dependence has the form

$$l = l_0(T) \epsilon^r, \tag{28}$$

where r is an exponent which depends on the electron scattering mechanism (for atomic lattices r=0; for ionic lattices below the Debye temperature  $r=\frac{1}{2}$  and above the Debye temperature r=1; for scattering by impurity ions r=2);

2)  $F_{\frac{1}{2}}(\mu^*)$ ,  $F_{\frac{1}{2}}(\mu^*)$ , etc. are Fermi integrals:

$$F_r(\mu^*) = \int_0^\infty x^r \int dx, \qquad (29)$$

where  $x=\frac{\epsilon}{kT}$  is the reduced kinetic energy, and f is the Fermi distribution function

$$f = \frac{1}{e^{x - \mu^*} + 1} \tag{30}$$

I studing  $\mu^*$  corresponding to the maximum value of z can be solved numerically. There exists, however, another much more convenient method of solving this problem.

If it is assumed that the optimum  $\mu^*$  lies within the range of carrier concentrations for which classical statistics are still valid (i.e.  $\mu^* < -2$ ), then the expressions for the electrical conductivity, thermal conductivity, and thermal emf coefficient are considerably simplified. In this case  $\mu^*$ ,  $\tau_i$   $\sigma_i$  and  $\kappa_{el}$  can be explicitly expressed as functions of carrier concentration n:

$$\mu^* = -\ln \frac{2(2\pi \, mkT)^{\frac{3}{2}}}{h^3 n} \,. \tag{31}$$

$$\alpha = \pm \frac{k}{e} (r + 2 - \mu^*) = \pm \frac{k}{e} \left[ r + 2 + \ln \frac{2(2\pi m k T)^{\frac{3}{2}}}{h^3 n} \right], \quad (32)$$

$$\sigma = enu, \tag{33}$$

$$\kappa_{el} = (r+2)\left(\frac{k}{e}\right)^2 T\sigma.$$
 (34)

If the condition  $\frac{\partial z}{\partial n} = 0$  in fact gives  $\mu^* < -2$ , then this assumption will be substantiated.

When the above approximate formulae are substituted in the expression for z, then the condition  $\frac{\partial z}{\partial n} = 0$  gives a transcendental equation for determining the optimum carrier concentration; this equation can be solved graphically or by the method of successive approximations.

that, at the optimum carrier concentration, the electronic thermal conductivity is small as compared with the lattice thermal conductivity (which, in general, follows from the graphical solution). If this unsumption is confuctivity as independent of the carrier concentration and neek the maximum of the numerator in the expression for z and, then, to introduce corrections by the method of successive approximations.

<sup>\*</sup> O. Madelung, Zn / Nuturfuranh, 9a, Nun. 7-8, 667, 1954.

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In this form the solution of the problem is extremely simple, From (32) and (33)

$$\alpha^2 \sigma = \left(\frac{k}{e}\right)^2 \left[r + 2 + \ln \frac{2(2\pi mkT)^{\frac{3}{2}}}{h^3 n}\right]^2 enu.$$

The condition

$$\frac{\partial a^2 \sigma}{\partial n} = 0 \tag{35}$$

vields two solutions. One.

$$r + 2 + \ln \frac{2(2\pi mkT)^{\frac{3}{2}}}{h^3} = 0, \qquad (35a)$$

corresponds to the minimum value of  $a^2\sigma$ , and the other is

$$r + 2 + \ln \frac{2(2\pi mkT)^{3/2}}{h^3n} = 2,$$
 (35b)

or

$$\ln \frac{2(2\pi mkT)}{h^3n} = r, \qquad (35c)$$

or

$$\mu^* = r. \tag{35d}$$

Hence the optimum thermal emf is

$$a_0 = 2\frac{k}{e} = 172 \,\mu\text{V/deg},$$
 (36)

the optimum concentration,

$$n_{o} = \frac{2 \left(2\pi \, mkT\right)^{3/2} e^{f}}{h^{3}} \,, \tag{37}$$

and the maximum value of z,

$$a = 1.2 \times 10^{-r} \frac{\mu}{\kappa_{ph}} \left( \frac{m}{m_0} = \frac{T}{T_0} \right)^{\frac{r}{r_0}} e^r,$$
 (37a)

where mo is the free electron mass and To is room temperature, equal to 11 k. (The subscript zero refers, here and further on, to values of a, o, and a corresponding to the maximum value of a<sup>3</sup>o.) We shall now introduce rections taking account of the dependence of the total thermal conduc-Hylly (expression (22)) on the carrier concentration.

According to expressions (32), (33), (34), and (22)

$$z = \frac{\alpha^2 \sigma}{\kappa_{ph} + \kappa_{el}} = \frac{k^2 u}{e \kappa_{ph}} \times \frac{(A - \ln n)^2 n}{1 + Bn}, \tag{38}$$

here

$$A = r + 2 + \ln \frac{2(2\pi mkT)^{\frac{3}{2}}}{h^{3}}$$
 (39)

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$$B = \frac{(r+2)\left(\frac{k}{e}\right)^2 Tue}{\kappa_{ph}} \qquad (40)$$

In has been mentioned earlier, the condition  $\frac{\partial z}{\partial z} = 0$  yields a transcendental equation for determining the optimum value of n, which will be ilmnoted by n,:

$$\ln n_1 = \ln n_0 - 2Bn_1, \tag{41}$$

HE

$$\ln\left(1 + \frac{n_1 - n_0}{n_0}\right) = -2Bn_1. \tag{41a}$$

Since, even for  $n = n_0$ ,  $Bn_0 = \frac{\kappa_{el}}{\kappa_{ob}}$  is usually less than unity, we are entitled to expand the left hand side of expression (41a) into a series

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and confine ourselves to the first term in the expansion (the error in doing this will not exceed a few percent); hence

$$\frac{n_1 - n_0}{n_0} \approx -2Bn_1$$

and

$$n_1 \approx \frac{n_0}{1 + 2Bn_0} \,. \tag{42}$$

Equation (41) can be solved exactly by a graphical method. For this purpose it is most convenient to rewrite it, using equation (32), in the following form

$$a_1 = a_0 + 2\frac{k}{e} \times \frac{\kappa_{el}}{\kappa_{ph}} = 172(1 + Bn_1).$$
 (43)

By plotting a from equation (32) and the right hand side of expression (43) as functions of n, we can find  $n_1$  as the abscissa of the point of intersection of these curves.

Obviously, the correction will be the greater, the higher the ratio of mobility to lattice thermal conductivity.

All the foregoing calculations are based on the approximate expressions (32) and (33) which are valid only for a non-degenerate electron gas. We shall not consider in detail the corrections on taking degeneracy into account, since, as we have already mentioned, a solution cannot be obtained in this case in a simplified general form.

All the calculations were also carried ont by Bok\* using the exact expressions (24), (26), and (27). It was found that the optimum value of the thermsl emf varied within the range from 150 to  $400 \,\mu\text{V}/\text{deg}$ , depending on the mechanism of carrier scattering, i.e. the exponent r in the expression for the free psth length (28), and the ratio of electron mobility to lattice thermal conductivity.

Such great deviations from expression (36) should not cause any surprise. In fact, according to (35d) the approximate theory yields for the optimum conditions  $\mu^* = r$ , i.e.  $\mu = 0$  for an atomic lattice,  $\mu^* = +\frac{1}{2}$  for an ionic lattice at temperatures below the Debye temperature and  $\mu^* = +1$  at temperatures above the Debye temperature. For scattering by impurity ions  $\mu^* = +2$ .

Therefore the optimum value of  $\mu^*$  is found to be, in all cases, outside the limits of applicability of classical statistics ( $\mu^* > -2$ ) on which the

\* B. I. Bok, Unpublished Report. Institute for Semiconductors of the U.S.S.R. Academy of Sciences.

Jungoing approximate theory is based. This unfortunate situation is all a lated by the following two circumstances:

1) expression (32) for the thermal emf derived by l'isorenke for a non-isomerate electron gas  $(\mu^* < -2)$  gives reasonably accurate values of the thermal emf even in the case of relatively high degeneracy, as has been immediated by Kontorova\*; this is because the deviations of numerical situations of the first term in the expression (24) for the thermal cust,

$$\frac{r+2}{r+1} \times \frac{F_{r+1}(\mu^*)}{F_r(\mu^*)}$$
.

and the second term, µ\*, from the approximate values,

$$\frac{r+2}{r+1} \times \frac{F_{r+1}(\mu^*)}{F_r(\mu^*)} \approx r+2$$

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$$\mu^{*} \approx \frac{2 \left(2 \pi \, mk \, T\right)^{3/2}}{h^{3} n}$$

land to compensate each other;

2) in the vicinity of the maximum, the figure of merit of the thermosterment z is a quadratic function of  $n - n_0$ ; therefore, no has been shown by colculations, deviations of 50% from the optimum concentration  $n_0$  reduce the value of z by only 6%.

Consequently, conditions (36) and (37) for  $a_0$  and  $a_0$  are not critical and the foregoing expressions are sufficiently accurate for qualitative analysis, and in the majority of cases also for quantitative calculations; and subsequent considerations will therefore be based on these equations.

According to expression (37s) the figure of merit of the thermoelement is proportional to the ratio of carrier mobility to lattice thermal conductivity. From expression (37) we find that z has a maximum at a certain partier concentration.

The foregoing analysis implies, therefore, that the development of materials for the arms of the thermoelement can be reduced to the solution of two basic problems:

- 1) finding materials with maximum ratios of current carrier mobility to lattice thermal conductivity and methods of obtaining a further increase of this ratio:
- 2) crenting in these materials carrier concentrations satisfying condition (37).

<sup>.</sup> T. A. Kontorava, Phue 1 + 4h Pie , 24, No. 7, 1291, 1954.

From expression (37n) one might also conclude that the figure of merit of the thermoelement increases with increasing effective mass, exponent r in the expression for the electron free path length, and temperature. Such a conclusion would, however, be premature. The reason is that the carrier mobility u entering into expression (37a) also depends to a large extent on these three factors.

The theoretical dependence of mobility on temperature and effective mass has the following form:

a) for atomic lattices

$$u = a_1 m^{-\frac{\theta}{2}} T^{-\frac{\theta}{2}}; (44)$$

b) for ionic lattices at temperatures below the Debye temperature

$$u = a_2 m^{-\frac{3}{2}} e^{\frac{\theta_{1}}{T}}, (45)$$

and at temperatures above Debye temperature

$$u = a_1 m^{-\frac{3}{2}} T^{-\frac{1}{2}}; (46)$$

c) for scattering by impurity ions

$$u = a_4 m T^{\frac{3}{2}}. (47)$$

Comparison of expression (37a) with (44), (45), (46), and (47) demonstrates that for atomic lattices z is inversely proportional to effective mass, for ionic lattices it is independent of effective mass, and for scattering by impurity ions z increases with increasing effective mass;

d) finally, in recent times a wide class of substances has been investigated, the binding in which has an intermediate character between atomic, ionic, and metallic; the temperature dependence of the mobility for these substances is given by the formula

$$u = a_3 T^{-3}, \binom{3}{2} \tag{48}$$

(the dependence of mobility on effective mass for this class of substances has not yet been established). It has not yet been found to be theoretically possible to estimate the value of the constant a which enters the expression for the mobility; it can only be stated that mobility in atomic lattices is tens and even bundreds of times higher than in purely ionic lattices; therefore substances with an ionic lattice are not good materials for thermoelements and we shall not consider them any further.

Considerable experimental unterial, railated and systematized by thuses shows that the mobility is highest in substances in which the Lands are of an intermediate character between atomic and metallic, those substances which include several intermetallic compounds and some materials grouped under (d) are the most suitable materials for the numelements.

The introduction into the lattice of impurity ions, which become miditumal acattering centres for electrons, always reduces the mobility. Ilawever, at the same time the value of the exponent r increases (e.g. from 0 to 2 in an atomic lattice) and therefore according to equation (32) the thermal emf also increases. Therefore, an introduction of a measured amount of impurities may bring about an increase in  $a^2\sigma$  in spite of the attendant drop in mobility. Preliminary experiments in this direction have not no far yielded positive results.

In order to derive the temperature dependence of z from expression t V(n), we must take into account the temperature dependence of the thermal conductivity. Leaving aside the case of temperatures below the Dabye temperature, which have not yet found any practical applications, we find that the thermal conductivity  $\kappa_{ph}$  is inversely proportional to temperature in the case of scattering of phonons by phonons (ideal lattice) and is independent of temperature in the case of scattering of phonons by lattice defects. Both these laws have been confirmed by investigations carried out by E. D. Devyatkova and P. V. Gul'tynev of the lastitute for Semiconductors.

TABLE 1

	ldeal lanice (Kph ∝ T <sup>-1</sup> )	Imperfect lattice (\kappa_{ph} = \const)
Scattering by impurity ions		
u ∝ T /2	z ∝ 74	$z \propto T^3$
Atomic lattice		
$\iota \propto T^{-\frac{3}{2}}$	z ∝ T	z = cons1
substances belonging to		
group (d) (see p. 108) $\mu \propto T^{-3}$	$z \propto T^{-1}/2$	$z \propto T^{-3/2}$

<sup>·</sup> V. P. Zhuze, Zhur. Tekh. Fiz., 25, No. 12, 2079, 1955.

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Thus the temperature dependence of 2 may have the forms shown in table 1.

In substances belonging to group (d) z rises with decreasing temperature; this class of substances is therefore the most suitable for very low temperature cooling.

As follows from expression (37), the optimum concentration of electrons at which z reaches its maximum value is a function of temperatures

$$n_0 \propto T^{\frac{3}{2}}$$
.

Therefore carrier concentration should be made to correspond to the working temperature range. From this point of view the most suitable material for thermoelements would be such a substance in which n would depend on temperature according to the law (37), as a result of which the thermal emf coefficient would retain its optimum value ( $a = 172 \mu V/deg$ ) over a wide temperature range. Such substances, bowever, do not exist in nature.

In addition to conventional semiconducting materials, in which the carrier concentration is an exponential function of temperature, several other substances have recently been investigated in which the carrier concentration remains constant over a wide temperature range.\* Theme substances may serve as materials for semiconductor thermoelements since they satisfy coaditions (36) and (37) better than conventional semiconductors. Conditions (36) and (37) can he exactly satisfied over a wide temperature range by making the arm of the thermoelement from a range of materials or from a single material with a varying impurity concentra tion.

In order to attain the maximum of  $z = a^2 \sigma / \kappa$  we ought to satisfy conditions at which the lattice thermal conductivity of the substance is a minimum. As yet there is no exact theory of thermal conductivity or suffi cient experimental data to permit a straightforward answer to this problem A. F. loffe's qualitative theory leads, however, to the following conclusioas:

\* In these substances the activation energy of impurity centres decreases steeply with increase of their concentration and becomes equal to zero at N= 1000 to 1016 cm-3. Consequently all impurity centres become ionised even in the virt nity of the absolute zero and the carrier concentration n remains constant (n - N)up to temperatures at which intrinsic conductivity appears. The theory of anch substances, known as semi-metals, was developed by K. S. Shifrin (see A. t. Samoilovich and L. L. Korenblit, Usp. Fiz. Nauk, 57, No. 4, 578, 1955).

1) According to experimental data the thermal conductivity of an ideal crystalline lattice at temperatures above Debyc temperature is proporthough to Tet, i.e. to the mensible heat of the crystal. It may therefore be Inferred that the thermal conductivity of various substances at a given tumperature is also governed by the sensible heat, and consequently discreases with decreasing Debye temperature.

$$\theta \propto \sqrt{\frac{f}{M}}$$
, (49)

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where M is the mass of atoms or ions forming the lattice and f is the aluatic hinding coefficient. Therefore, the thermal conductivity would be expected to he minimum in crystals, consisting of heavy atoms or ions, with a low Young's modulus.

2) The finite free path length of phonons is a consequence of the anharmonicity of the atomic and ionic vibrations; the larger the amplitude I vibration the greater is the degree of anharmonicity. Furthermore, for a Alven sensible heat, the lattice thermal conductivity decreases with the reasing anharmonicity factor in the expression for the elastic deformation of the lattice. From the macroscopic viewpoint, anharmonicity manilants itself in thermal expansion of the lattice. Therefore, the minimum thermal conductivity can be expected to occur in crystals with a large thermal expansion coefficient.

3) In non-degenerate semiconductors, the wavelength of electronic waves, at room temperature,  $\lambda_{el}$ , is tens of times larger than the interatomic distance ( $\lambda_{el} \approx 10^{-6}$  cm), whereas most of the normal lattice vibrations occur at a wavelength  $\lambda_{ph}$ , which is of the order of the lattice runstant ( $\lambda_{ph} \approx 10^{-8}$  cm). This difference between  $\lambda_{el}$  and  $\lambda_{ph}$  makes it punnible to create non-homogeneities in the crystal lattice which are effective in scattering phonons but which virtually do not scatter electroa waves, i.e. do not reduce the carrier mobility. Such non-homogeneities in particular, he produced by the introduction into the lattice of neutral impurity atoms or by the formation of solid solutions hased on themical compounds crystallising in similar lattices.

1.3 Taking account of the Thomson heat in the energy balance of the thermoclement. It follows from equations (36) and (37) that the hest unterials for thermoelemeats are those in which the thermal emf coeffi-Figure is constant:

$$a = 2\frac{k}{e} = 172 \,\mu\text{V/deg},$$

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whilst the carrier density varies according to the law

$$n = AT^{\frac{3}{2}}.$$

In the theory presented in the preceding paragraph we have considered the ideal conditions at which

$$r = T \frac{d\alpha}{dT} = 0.$$

As has been mentioned earlier, the materials actually used for the arms of thermoelements are usually semi-metals, i.e. substances in which the carrier concentration is constant and the thermal emf, according to equation (32), rises with rising temperature. In this case the Thomson coefficient is different from zero, and according to equations (5) and (32) can be written in the form

$$r = \frac{3}{2} \times \frac{k}{\epsilon} = 129 \,\mu\text{V/deg.}$$
 (50)

We should now take into account the effect of the Thomson heat on the heat balance of the thermoelement. This effect will manifest itself primarily in a redistribution of temperature along the arms of the thermoelement. Until now we have assumed that the temperature gradient along the arms of the thermoelement is constant and, therefore, that the density of the heat flux towards the cold junction of the thermoelement can be expressed by the formula

$$Q_{h} = \kappa \frac{T_{o} - T_{i}}{l} . ag{51}$$

The effect of Joule heat on the temperature distribution has been taken into account approximately by assuming that half of it proceeds towards the hot junction of the thermoelement and half towards the cold junction.

In order to solve this problem more rigoronsly, it is necessary to find the temperature distribution along the arms of the thermoelement, taking into account both the Joule and Thomson heats, and then find the density of the heat flux from the exact expression

$$Q_{h} = -\kappa \nabla T. \tag{52}$$

Let the x axis be directed along the arms of the thermoelement and let the origin coincide with the cold junction of the thermoelement; equation (52) will now take on the following farm

$$Q_h = -\kappa \left(\frac{dT}{dx}\right)_{x=0}. (52n)$$

In order to calculate  $Q_h$  from equation (52a), we must know the temperature distribution along the arms of the thermoelement

$$T = f(x).$$

As before, we shall neglect the temperature dependence of the thermal implicativity and the electrical conductivity, and replace the true values of these parameters as functions of temperature by average values in the making temperature range. In a thermoelectric generator, both electrons and holes move from the hot junction towards the cold junction; in addition to the Joule heat, Thomson heat is also generated in the eather volume of the thermoelement arms. In a thermoelectric refrigerator the electrons and holes move in the opposite direction and therefore the Thomson heat has to be deducted from the Joule heat. Consequently, the steady-atomic condition for a unit volume of a thermoelement arm will in this case have the firm

$$\kappa \frac{d^2T}{dx^2} - r j \frac{dT}{dx} + j^2 \rho = 0.$$
 (53)

the solution of the differential equation (58), taking account of boundary smalltions ( $T = T_1$  at x = 0, and  $T = T_0$  at x = l), has the form

$$T = T_1 + \frac{T_0 - T_1 - \frac{w_\rho}{w_r} l}{\frac{w_r}{1 - e^{\kappa}} l} \left( 1 - \frac{w_r}{e^{\kappa}} x \right) + \frac{w_\rho}{w_f} x, \qquad (54)$$

where the following notation is used:  $j^2\rho = w_\rho$  and  $j_T = w_T$  Hence we find from (52n) and (54) that the hent flux towards the cold junction is

$$Q_{h} = \kappa \left(\frac{dT}{dx}\right)_{x=0} = \kappa \left(\frac{T_{c} - T_{b} + \frac{w_{p}}{w_{r}}l}{\frac{w_{r}}{k}l} \times \frac{w_{r}}{\kappa} + \frac{v_{p}}{w_{r}}\right). \tag{55}$$

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With the same degree of accuracy we can write for the emf

the mame degree of accuracy we can write for the emf

$$E = \int_{T_1}^{T_0} adT = \overline{\alpha}(T_0 - T_1). \tag{61}$$

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Taking account of expressions (50a) and (61), expression (14) for the coefficient of performance becomes

$$\epsilon = \frac{2\bar{a}IT_1 - \frac{1}{2}I^2R - K(T_0 - T_1)}{I[2\bar{a}(T_0 - T_1) + IR]}.$$
 (14a)

Expression (14a) has the same form as (14), the only difference being that the thermal emf coefficient a, which has been regarded previously as independent of temperature, is now replaced by its mean value in the working temperature range. Therefore, without repeating the steps described in the previous paragraph, we are justified in expressing the maximum coefficient of performance in the form

$$\epsilon_{0} = \frac{T_{1}}{T_{0} - T_{1}} \times \frac{\sqrt{1 + \frac{1}{2} (T_{0} + T_{1}) \overline{z} - \frac{T_{0}}{T_{1}}}}{\sqrt{1 + \frac{1}{2} (T_{0} + T_{1}) \overline{z} + 1}},$$
(19a)

where  $\overline{z} = \frac{\overline{a^2}\sigma}{\kappa} = \frac{\overline{a^2}}{\kappa\rho}$ . It can also be shown that the temperature dependence

of the electrical conductivity and the thermal conductivity can be, to a first approximation, taken into account by replacing the product  $\kappa \rho$  in the value for  $\overline{z}$  by its mean value in the working temperature range. Thus,

$$z = \frac{\overline{\alpha}^2}{KO}$$

where 
$$\overline{\kappa\rho} = \frac{1}{T_0 - T_1} \int_{T_1}^{T_0} \kappa \rho \, dT$$
.

1.4 Multistage batteries. The maximum temperature drop which a thermoelement can provide is

$$(T_0 - T_1)_{max} = \frac{zT_1^2}{2}$$
, or  $T_1 = \frac{\sqrt{1 + 2T_0 z} - 1}{z}$ . (62)

Expanding the expanent in equation (%) into a nation and retaining the first two terms, we obtain

$$Q_h = \kappa \frac{T_0 - T_t}{l} + \frac{1}{2} j^2 \rho l - \frac{1}{2} r j (T_0 - T_t). \tag{56}$$

We have thus shown that, to a first approximation, half of the Joule heat in fact proceeds to the cold junction; we can now use equation (56) to calculate the effect of Thomson heat on the coefficient of performance of the thermoelement  $\epsilon$ . Expression (9) for the cooling capacity of the thermoelement, after taking account of expression (56), takes the form

$$Q_0 = \Pi I - K(T_0 - T_1) - \frac{1}{2}I^2R + r(T_0 - T_1)I, \qquad (57)$$

where  $H = 2a_1T_1$ , and  $a_1$  is the value of the thermal emf coefficient at the temperature  $T_1$ . We can therefore rewrite expression (57) as follows:

$$Q_{o} = 2\overline{a}T_{i} - K(T_{o} - T_{i}) - \frac{1}{2}I^{2}R, \qquad (58)$$

where

$$\bar{\alpha} = \alpha_i + \frac{1}{2} r \frac{T_0 - T_1}{T_1}. \tag{59}$$

We shall now prove that  $\overline{a}$  is in fact equal to the mean value of the thermal emf coefficient in the temperature range  $T_0 - T_1$ . According to (32), we have for semi-metals (i.e. when n = const)

$$a_0 - a_1 = \frac{3}{2} \frac{k}{e} \ln \frac{T_0}{T_1} = r \ln \frac{T_0}{T_1} \approx r \frac{T_0 - T_1}{T_1},$$

whence

$$r \approx \frac{a_0 - a_1}{T_0 - T_1} T_i. \tag{60}$$

Substituting (60) into (59) we obtain

$$\bar{a} = a_1 + \frac{1}{2}(a_0 - a_1) = \frac{a_1 + a_0}{2}$$
.

The temperature can be reduced still further by using multistage cooling. It is obvious, however, that it is not possible to attain the mind mum temperature given by expression (62) which corresponds to  $\epsilon = 0$ , and at the same time reduce the temperature still further using another stage, since the second stage will generate heat, which the first one will have to absorb. For the best utilisation of all stages of a multistage battery intended for the attainment of the lowest temperatures, the batteries should consist of stages of steeply decreasing power. With the aid of a multistage battery, it is also possible to achieve another result, namely to increase the coefficient of performance when the required temperature drop is close to the maximum attainable for the given z.

The coefficient of performance of a multistage battery is calculated as follows.

Let  $Q_1$  be the refrigerating capacity of the battery stage which is in direct contact with the cooled object,  $\epsilon_1$  its coefficient of performance, and  $W_1$  its power consumption. The respective values for the preceding stage will be denoted by  $Q_2$ ,  $\epsilon_2$  and  $W_2$ , etc. From equation (11),  $W_1 = Q_1/\epsilon_1$ : therefore

$$Q_{2} = W_{1} + Q_{1} = Q_{1} \left( 1 + \frac{1}{\epsilon_{1}} \right),$$

$$Q_{3} = Q_{2} \left( 1 + \frac{1}{\epsilon_{2}} \right) = Q_{1} \left( 1 + \frac{1}{\epsilon_{1}} \right) \left( 1 + \frac{1}{\epsilon_{2}} \right),$$

$$\vdots$$

$$Q_{n+1} = Q_{1} \left( 1 + \frac{1}{\epsilon_{1}} \right) \left( 1 + \frac{1}{\epsilon_{2}} \right). \quad \cdot \quad \left( 1 + \frac{1}{\epsilon_{n}} \right).$$

$$(63)$$

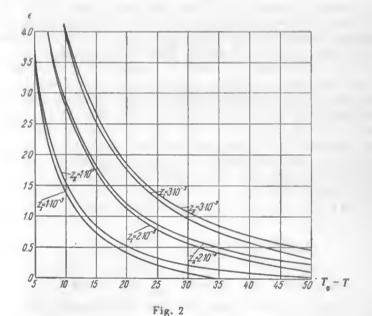
But  $Q_{n+1}$  is composed of two parts, namely the power consumed by the entire battery W and  $Q_1$ :

$$Q_{n+1} = W + Q_1 = Q_1 \left( 1 + \frac{1}{\epsilon} \right). \tag{64}$$

where  $\epsilon$  is the coefficient of performance of the whole battery. Comparison of expressions (63) and (64) yields an expression for the coefficient of performance of a multistage battery:

$$1 + \frac{1}{\epsilon} = \prod_{i=1}^{i=n} \left( 1 + \frac{1}{\epsilon_i} \right), \tag{65}$$

 $= \frac{1}{\prod_{i=1}^{l-n} \left(1 + \frac{1}{\epsilon_i}\right) - 1} \tag{66}$ 



Let us consider an example. When  $z=2\times 10^{-3}$  and  $\Delta T=50^{\circ}$ , then for a single stage  $\epsilon=0.1$  (10%). With two stages  $\Delta T_1=\Delta T_2=25^{\circ}$ ,  $\epsilon_1=\epsilon_2=0.8$ , and the coefficient of performance of the whole battery is  $\epsilon=0.25$ . Similarly, with three stages we obtain  $\epsilon=0.275$ . This shows that the use of a three stage battery in this case is useless. Let us assume that for  $\epsilon=2\times 10^{-3}$  we wish to reduce the temperature by 25° in two stages of 12.5°. The coefficient of performance for each stage would be  $\epsilon_1=2$  and for both stages together  $\epsilon=0.8$ , i.e. the same as for a single stage.

Fig. 2 shows the dependence of the coefficient of performance  $\epsilon$  on temperature difference and z for a single stage and a two-stage thermobattery for  $T_0 = 293^{\circ}$ K

# 1.5 Principles of calculations for thermuelectric hatteries.

Selection of the ratio of the cross-section areas of the thermoelement arms. Until now we have assumed that the arms of the thermoelement consist of substances with equal electrical and thermal conductivity and equal, but opposite, thermal emf coefficients. In practice these conditions are not as a rule realised; even when it is possible to attain the same thermal emf coefficient for both arms of the thermoelement  $|a| = 172 \,\mu\text{V/leg}$ , the electrical conductivity of the arms differs owing to the different mobilities of holes and electrons. The lattice thermal conductivity is also usually different, with the exception of the case when both arms are made of the same substance and the change of the sign of the thermal emf coefficient is achieved as a result of introduction of various impurities.

We should therefore consider now the general case of a thermoelement consisting of arms with different thermoelectric parameters, and find the conditions under which the efficiency of the thermoelement will he a maximum. Anticipating proofs which are given later, we shall state that when the thermal conductivity and electrical conductivity of the positive and negative semiconductors  $(\kappa_1, \kappa_2, \text{ and } \sigma_1, \sigma_2)$ , which constitute the thermoelement, differ, the cross-section areas of the arms of the thermoelement should also differ.

According to equation (16a) z is in this case equal to

$$z = \frac{(\alpha_1 - \alpha_2)^2}{RK} = \frac{(\alpha_1 - \alpha_2)^2}{\left(\frac{S_1 \kappa_1}{l} + \frac{S_2 \kappa_2}{l}\right) \left(\frac{\rho_1 l}{S_1} + \frac{\rho_2 l}{S_2}\right)},$$
 (67)

where  $S_1$  and  $S_2$  are the cross-section areas of the hranches of the thermoelement, l is their length, which will be assumed to he equal for both nrms; and  $\rho_1$  and  $\rho_2$  the electrical resistivities of the materials. When the terms in the first bracket in the denominator of expression (67) are divided by  $S_2$  and in the second bracket multiplied by  $S_2$ , this expression becomes more symmetrical in form, viz,

$$z = \frac{(\alpha_1 - \alpha_2)^2}{(\kappa_1 m + \kappa_2) \left(\frac{\rho_1}{m} + \rho_2\right)} = \frac{\overline{\alpha}^2}{\kappa \rho}, \tag{68}$$

where the following notation has been adopted:  $m = \frac{S_1}{S_2}$ ,  $\bar{a} = \frac{a_1 - a_2}{2}$  and

$$\overline{\kappa\rho} = \frac{\kappa_1 m + \kappa_2}{2} \times \frac{\rho_2 + \frac{\rho_1}{m}}{2}$$
. The denominator  $\overline{\kappa\rho}$  in the expression for z is a

further of m and we can find  $\kappa \rho_{min}$ , and therefore also  $s_{min}$ , from the condition  $\frac{\partial \kappa \rho}{\partial m} = 0$ :

$$4\frac{\partial \overline{\kappa \rho}}{\partial m} = \kappa_1 \rho_2 - \frac{\kappa_2 \rho_1}{m^2} = 0$$

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$$m_0 = \sqrt{\frac{\kappa_2 \rho_1}{\kappa_1 \rho_2}} ; \qquad (69)$$

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audintituting this value of me into expression (68) we obtain

$$4 \overline{\kappa \rho_{min}} = (\sqrt{\kappa_1 \rho_2} + \sqrt{\kappa_2 \rho_1})^2,$$

$$z_{max} = \left(\frac{a_1 - a_2}{\sqrt{\kappa_2 \rho_2} + \sqrt{\kappa_2 \rho_2}}\right)^2. \tag{68a}$$

The following problem is of interest.

$$z_1 = \frac{\alpha_1^2}{\kappa_1 \rho_1}, \qquad z_2 = \frac{\alpha_2^2}{\kappa_2 \rho_2}.$$

We shall find hy how much  $z_{max}$  calculated from expression (68a) is smaller than  $z_1$ , (i.e. hy how much the properties of the thermoelement as a whole are inferior to the properties of the hetter of the two hranches).

Let 
$$\sqrt{z_1} = l_1$$
;  $\sqrt{z_2} = l_2$ ;  $\sqrt{z_{max}} = l_m$ ;  $\sqrt{\kappa_1 \rho_1} = k_1$ ; and  $\sqrt{\kappa_2 \rho_2} = k_2$ . Then

$$l_1 - l_m = \frac{\alpha_1}{k_1} - \frac{\alpha_1 - \alpha_2}{k_1 + k_2} = (l_1 - l_2) \frac{1}{1 + \frac{k_1}{k_2}}.$$

The lower the resistivity of the given material the lower is the value of  $k=\sqrt{\kappa\rho}$  characteristic of this material; at the limit this value tends to the Wiedemann-Franz constant. In order to prevent a large reduction of  $\ell_{max}$ , the carrier concentration should therefore he so selected that  $\rho_1 >> \rho_2$ .

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Design calculations of a single stage hattery the starting quantities for the culculation are:

1) the parameters of the thermoelement arms:  $a_1,\ a_2;\ a_1,\ a_2;\ \kappa_0,\ \kappa$ 

$$z_{max} = \left(\frac{\alpha_1 - \alpha_2}{\sqrt{\kappa_1 \rho_2} + \sqrt{\kappa_2 \rho_1}}\right)^2 \quad \text{and} \quad m_0 = \sqrt{\frac{\kappa_2 \rho_2}{\kappa_1 \rho_1}} ;$$

- 2) the prescribed operating conditions: cold and hot junction temperatures  $T_1$  and  $T_0$ , and the refrigerating capacity  $Q_0$ ;
  - 3) voltage of the power supply source V;
- 4) from design considerations it is also necessary to select the length of the thermoelement arms l (or, what amounts to the same thing, the thickness of the battery).

It can be readily shown that the surface area of the thermobattery for a given refrigerating capacity is proportional to l, whilst its volume is proportional to  $\ell^2$ ; therefore in order to reduce the consumption of materials and weight of the thermobattery it is necessary to make l small. This, however, complicates the removal of heat from the hot junctions. In each specific case it is therefore necessary to select a certain optimum arm length.

Calculation steps:

- 1) expressions (18) and (19) are used to calculate the values of  $\epsilon_0$  and  $v_{\rm o}$ , the power required for the battery  $W=Q_{\rm o}/\epsilon_{\rm o}$ , and the operating current l = W/V:
  - 2) the number of thermoelements is now calculated

$$N = \frac{V}{v_0}, \qquad (70a)$$

and then from expressions (17) and (18) the resistance of each thermoelement;

3) moreover, we have

$$R = l\left(\frac{\rho_1}{S_1} + \frac{\rho_2}{S_2}\right) = \frac{l}{S_1} \left(\rho_1 + m_0 \rho_2\right). \tag{70b}$$

Knowing R, l,  $\rho_1$ ,  $\rho_2$ , and  $m_0$ , we find from equation (70b)  $S_1$  and  $S_2 = \frac{S_1}{2}$ .

It can be readily shown that the power consumption of the battery and its refrigerating capacity do not depend on the voltage of the power supply source V, the number of couples N, the surface area of the thermobattery

F, and its thickness l, but they depend only on the ratio of the last two pointities  $F/I_t$  each of which can, by itself, be orlding, The ariginal of "cald" removed from 1 cm' of the linttery  $q \sim Q_{\rm o}/F$  dispends on the thick ness of the buttery, i.e. the length of the thermoelements I. This permits us to decrease l and F simultaneously, each by a times, which leads to a reduction of the volume, and an economy of material by at times for the same capacity. The length of the thermoelement cannot be reduced tolow a certain limit because of junction resistances in the thermoelement and temperature drops across the layers of insulation between the buttery and the radiators (which serve for heat exchange with the nurroundings), litted to the hot and cold thermoelement junctions. The reduction of lin equalient as long as the aforementioned junction resistances do not became comparable with the resistances of the arms, and the temperature hops at the thermal contacts of the battery with the radiators, and in the caddators themselves, are not comparable with the working temperature difference.

We have not yet taken into account the junction resistances r of the two junctions of the thermoelement. In practice they may always usint, and when they are taken into account the resistance of the thermaelement in expressed by the following formula:

$$R = 2r + 2\rho \frac{l}{S} = 2\frac{l}{S} \left( \frac{rS}{l} + \rho \right) = \frac{2l}{S} \left( \frac{r_0}{l} + \rho \right). \tag{71}$$

The quantity  $r_0 = rS$  characterises the quality of the junction since 1 . S-1 and ro does not depend on the contact surface area. (Since the contact between the arms can be achieved by welding or pressing, the term "soldering" will be replaced by the more general term "commuta-

It can be readily shown that when the junction resistances are taken into account the expression for z takes on the form

$$z = \frac{\alpha^2}{\kappa \left(\rho + \frac{r_0}{l}\right)} .$$

Flows, from the viewpoint of attaining maximum z, l can be decreased as long as the condition  $l
ho >> r_0$  or  $l >> r_0/
ho$  is fulfilled. In order to avoid an appreciable temperature drop at the thermal contact between the battery and the radiator the following analogous candition should obtain:  $I/\kappa \gg k_0^{-1}$ or  $l\gg\kappa/k_0$  where  $\kappa$  is the thermal conductivity of the substance and  $k_0$ the heat transfer by conduction nerons a unit contact surface area

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To eliminate the temperature drop in the redictors proper, the latter should have a large well-finned contact surface area with the surrounding medium. Ileat transfer from the thermobattery to the outer surfaces of the radiators is achieved with the aid of good thermal conductors such as copper or aluminium, or even more effectively by a stream of liquid or vapour distilled in vacuo from the hot to the cold surface.

Apart from its power conversion aspects, the thermobattery should also satisfy specific mechanical requirements.

The temperature difference, which is unavoidable in all thermoelectric devices, produces a bending moment. For a coefficient of thermal expansion equal to approximately  $2 \times 10^{-5}$  and a temperature difference of  $50^{\circ}$ C, the linear dimensions of the hot junction are larger than those of the cold junction by  $10^{-5}$  times the width of the battery. A battery with a 10 cm long side expands by 0.1 mm, so that when the thickness of the battery is 1 cm, the resulting bending has a radius of curvature equal to 10 m. To prevent cracking it is necessary to make the batteries somewhat elastic.

The effect of departures from optimum conditions. We have determined the ratio of the cross-section areas of arms of the thermoelement  $(m_0)$  for which z has the maximum value; earlier we have also found the optimum carrier concentration  $n_0$  (equation (37)), electrical conductivity  $o_0$  (equation (33)), and optimum voltage drop across the thermoelement (equation (18)).

In practice, owing to uncontrollable variations in the technological processes, the specimens from which the battery is constructed have varying themoelectric parameters a,  $\sigma$ , and  $\kappa$ . In general, the scatter of these parameters is within the limits of 10%. It is therefore important to find out how departures from the optimum conditions affect the properties of the battery.

Departures from the optimum ratio of cross-section areas of the arms. Expanding  $\kappa\rho$  as a Taylor series in powers of m close to  $m_0$ , and remem-

bering that 
$$\left(\frac{\partial \kappa \rho}{\partial m}\right)_{m=m_0} = 0$$
, we find

$$\overline{\kappa\rho} - \overline{\kappa\rho}_{min} \approx \frac{1}{2} \left( \frac{\partial^2 \overline{\kappa\rho}}{\partial m^2} \right)_{m=m_0} (m - m_0)^2. \tag{72}$$

From equation (69)

$$\frac{\partial^2 \overline{\kappa \rho}}{\partial m^2} = \frac{2\kappa_2 \rho_1}{m^3} ; \qquad (73)$$

using equations (7.1) and (73) we obtain

$$\frac{\kappa \mu - (\kappa \rho)_{m \ln}}{(\kappa \rho)_{m \ln}} = \rho \left(\frac{m - m_0}{m_0}\right)^{\frac{1}{2}}.$$
 (74)

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where the caefficient

$$\mu = \frac{\sqrt{\kappa_1 \rho_1 \kappa_2 \rho_2}}{\left[\sqrt{\kappa_1 \rho_1} + \sqrt{\kappa_2 \rho_2}\right]^2} \leqslant \frac{1}{4} ,$$

wince the geometric mean of two numbers is always smaller than or equal to the arithmetic mean, and so

$$\frac{\overline{\kappa\rho} - (\overline{\kappa\rho})_{min}}{(\overline{\kappa\rho})_{min}} \leqslant \frac{1}{4} \left(\frac{m - m_0}{m_0}\right)^2. \tag{75}$$

It follows from (75) that the value of  $\overline{\kappa\rho}$  and therefore also of z depends very little on m. Thus, e.g., when  $(m-m_0)/m_0=0.2$ ,  $\overline{\kappa\rho}$  increases by only 1%. According to expression (75)

$$\frac{z_{max} - z}{z_{max}} \leqslant \frac{1}{4} \left( \frac{m - m_0}{m_0} \right)^2 . \tag{75a}$$

Departure from the optimum carrier concentration. According to expression (37), the numerator  $a^2o$  in the expression for z has a maximum at a certain carrier concentration. An optimum electrical conductivity corresponds to this optimum carrier concentration

$$o_0 = e n_0 u = \frac{2(2\pi mkT)^{3/2}}{h^3} e^r ue.$$
 (33a)

Let us find out by how much the efficiency of the thermoelement decreases when the electrical conductivity of the branches differs slightly from the optimum value. From (32), (33n), and (35) we have

$$a^{2}\sigma = \frac{k^{2}}{e^{2}}(A - \ln \sigma)^{2}\sigma,$$

$$\frac{\partial(a^{2}o)}{\partial o} = \frac{k^{2}}{e^{2}}[(A - \ln \sigma)^{2} - 2(A - \ln \sigma)],$$

$$\frac{\partial^{2}(\alpha^{2}o)}{\partial \sigma^{2}} = \frac{k^{2}}{e^{2}}\left[\frac{2}{o} - \frac{2(A - \ln \sigma)}{o}\right].$$
(76)

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For  $A - \ln \sigma_0 = 2$ , i.e.  $\sigma_0 = e^{A-2}$ , we have

$$(\alpha^2 \sigma)_{max} = 4 \frac{k^2}{e^2} \sigma_0 . {(77)}$$

Expanding  $a^2\sigma$  into a series in terms of  $(\sigma - a_0)$  and confining ourselves to the first three terms of the expansion, we obtain

$$(\alpha^2 \sigma)_{max} - \alpha^2 \sigma \approx \frac{1}{2} \left[ \frac{\partial^2 (\alpha^2 \sigma)}{\partial \sigma^2} \right]_{\sigma = \sigma_0} (\sigma - \sigma_0)^2.$$

From (76) and (77) we have

$$\left[\frac{\partial^2 (\alpha^2 \sigma)}{\partial \sigma^2}\right]_{\sigma = \sigma_0} = \frac{2}{\sigma_0} \frac{k^2}{e^2}.$$

Therefore.

$$(a^2\sigma)_{max} - a^2\sigma = \frac{k^2}{e^2} \times \frac{1}{\sigma_0} (\sigma - \sigma_0)^2$$

or, from (77)

$$\frac{\left(\alpha^2\sigma\right)_{max} - \alpha^2\sigma}{\left(\alpha^2\sigma\right)_{max}} \approx \frac{1}{4} \left(\frac{\sigma - \sigma_0}{\sigma_0}\right)^2 . \tag{78}$$

Expression (78) shows that the dependence of  $a^2\sigma$ , and therefore also of z, on  $\sigma$ , close to the point  $\sigma = \sigma_0$ , bears the same character as the dependence of z on m close to the point  $m = m_0$ , i.e. a change of  $\sigma$  by 20% leads to a decrease of z by only 1%.

As may be seen from (75a) and (78),  $\frac{z_{max}-z}{z_{max}}$  depends in exactly the ame way on departures of m from the value  $m_0$ , as on departures of  $\sigma$ 

same way on departures of m from the value  $m_{\rm o}$ , as on departures of  $\sigma$  from  $\sigma_{\rm o}$ .

Fig. 3 shows the dependence of  $\frac{z_{max}-z}{z_{max}}$  on  $\frac{o-\sigma_0}{\sigma_0}$ . The same graph

can be used for finding the dependence of  $\frac{z_{max}-z}{z_{max}}$  on  $\frac{m-m_0}{m_0}$ .

Dependence of a<sup>2</sup>o on temperature. According to (32), (33), and (35)

$$a^2\sigma = \left(B + \frac{3}{2}\ln T\right)^2 CT^{-\beta}, \qquad (79)$$

where  $\beta=3$  for an ionic lattice and  $\beta=3$ , for an atomic lattice (II is assumed here that the varrier vancentration n is independent of temperature). It has been mentioned earlier that experimental investigation of the ispendence of the mobility on temperature has shown that for a number of semiconducting substances used for thermoelements the mubility is toversely proportional to the cube of the temperature; thus the case  $\beta=3$  is also of interest to us.

From (79) we have

$$\frac{\partial \left(a^2\sigma\right)}{\partial T} = 3\left(B + \frac{3}{2}\ln T\right)CT^{-\beta-1} - \beta\left(B + \frac{3}{2}\ln T\right)^2CT^{-\beta-1}, \quad (80)$$

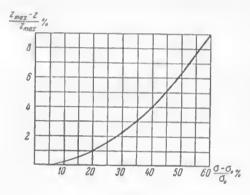


Fig. 3

$$\frac{\partial^{2}(\alpha^{2}\sigma)}{\partial T^{2}} = CT^{-\beta-2} \left[ \frac{9}{2} - 3(2\beta+1) \left( B + \frac{3}{2} \ln T \right) + \beta(\beta+1) \left( B + \frac{3}{2} \ln T \right)^{2} \right].$$

$$(81)$$

According to (80),  $\frac{\partial (a^2 \sigma)}{\partial T} = 0$  at the temperature  $T_0$  for which  $B + \frac{3}{2} \ln T_0 = \frac{3}{\beta}$ , whence  $T_0 = e^{2/\beta - \frac{3}{2}B}$  and

$$(a^2\sigma)_{max} = \frac{9}{\beta^2} CT_0^{-\beta}. \tag{82}$$

Comparing (77) and (82) we find that the respective maxima of  $\alpha^2 \sigma$  in elements with T = const,  $\alpha^2 \sigma = f_1(\sigma)$ , and with n = const,  $\alpha^2 \sigma = f_2(T)$  do not

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coincide. Only for an atomic lattice ( $\beta = \frac{1}{4}$ ) are both maxima at the same point

$$A - \ln \sigma = B + \frac{3}{2} \ln T = 2,$$

i.e. in this case we are not dealing with a relative maximum but with an absolute maximum. In this case according to (81)

$$\left[\frac{\partial^2(\alpha^2\sigma)}{\partial T^2}\right]_{T=T_0} = \frac{9}{2} C T_0^{-\frac{7}{2}}.$$

Expanding  $a^2\sigma$  into Taylor series close to the point  $T_0$  we obtain

$$\frac{(a^2\sigma)_{max} - a^2\sigma}{(a^2\sigma)_{max}} = 1.25 \left(\frac{T_0 - T_1}{T_0}\right)^2.$$
 (83)

For  $T_0 - T_1 = 0.2 T_0$ , which at room temperature amounts to about  $50^\circ$ ,  $a^2\sigma$  drops only by 5%. It is easy to see that when the remaining terms of the Taylor series are taken into account the dependence close to the maximum of  $a^2\sigma$  on m,  $\sigma$ , T, and other parameters becomes even weaker. However, in the case of a thermoelectric generator  $(T_0 - T_1)/T_1$  usually exceeds unity and expression (83) cannot therefore be applied.

An investigation of the behaviour of  $\alpha^2 \sigma = f_2(T)$  close to the maximum for the cases  $\beta = \frac{1}{2}$  and  $\beta = 3$  is of no great interest since this point liem beyond the working temperature range.

In fact, at the temperature  $T_w$  specified by the working conditions we select a carrier concentration at which  $a^2\sigma = f_1(\sigma)$  would reach a maximum; according to equation (35b) this corresponds to the condition

$$B_w + \frac{3}{2} \ln T_w = 2. ag{84}$$

But at a given  $B_w$  the value of  $\alpha^2 \sigma = f_2(T)$  has a maximum when condition (82) is fulfilled

$$B_w + \frac{3}{2} \ln T_0 = \frac{3}{\beta} . ag{82a}$$

From (84) and (82a) we obtain

$$\frac{T_0}{T_{uv}} = e^{2/\beta - \frac{4}{2}}, \qquad (85)$$

whence, for  $\beta=\%$  , we find  $T_a=T_{to}$  , for  $\beta=\%$  we have  $T_a\simeq 10T_{to}$  , and for  $\beta=3$ 

$$T_0 = T_{ii} e^{-\frac{3}{2}} \approx 0.53 T_{ii}$$
, (85a)

In order to establish the temperature dependence of  $a^2\sigma$ , we shall expand  $a^3\sigma$  in a Taylor series in the vicinity of the point  $T_{\mu\nu}$ , and, since at this point the first derivative is not equal to zero, we shall limit the expansion to the first two terms

$$\alpha^2 \sigma = (\alpha^2 \sigma)_{T=T_w} + \frac{\partial (\alpha^2 \sigma)}{\partial T} (T - T_w).$$

From (80) we find that for  $\beta = 3$ 

$$\left[\frac{\partial (a^2 \sigma)}{\partial T}\right]_{T=T_w} = -6 \ C T_w^{-4} \ ,$$

$$a^2\sigma = 4CT^{-1}$$

and, therefore,

$$\frac{(a^2\sigma)_w - (a^2\sigma)}{(a^2\sigma)_w} = \frac{3}{2} \times \frac{T - T_w}{T_w} \,. \tag{86}$$

Effect of departures of the current l from the optimum value  $l_0$  on  $\Delta T_{max}$ . When the thermoelement operates with the cold junction perfectly thermally insulated, we find from (10)

$$\Delta T = \frac{\Pi I - \frac{1}{2}I^{2}R}{K}$$

$$\frac{\partial \Delta T}{\partial I} = \frac{\Pi}{K} - \frac{IR}{K},$$

$$\frac{\partial^{2}\Delta T}{\partial I^{2}} = -\frac{R}{K},$$

$$\frac{\partial^{3}\Delta T}{\partial I^{3}} = 0.$$
(87)

Expanding  $\Delta T$  into a Taylor series these to the point  $l=l_0$ , we find, after straightforward transformations

$$\frac{\Delta T_{max} - \Delta T}{\Delta T_{max}} = \left(\frac{I - I_0}{I_0}\right)^{\delta}.$$
 (18)

According to (88), a departure of the current density from the optimum value by 20% results in a reduction of  $\Delta T$  by 4%.

Effect of the change of supply voltage on the coefficient of performance. In a similar way we arrive at the following expression:

$$\frac{\epsilon_0 - \epsilon}{\epsilon_0} = 2\left(\frac{\upsilon - \upsilon_0}{\upsilon_0}\right)^2 \left(1 + \frac{1}{2\epsilon_0}\right). \tag{89}$$

#### CHAPTER 2

# EXPERIMENTAL INVESTIGATION OF THE THERMOELECTRIC PROPERTIES OF SEMICONDUCTORS

The theory of thermoelectric cooling expounded in Chapter 1 is based on a number of deductions of theoretical physics: Thomson's thermodynamic relationships (3) and (5), Pisarenko's expressions for the thermal and (32), the temperature dependence of the mobility (44) and (46), etc. All these deductions were to a greater or lesser extent in need of experimental verification.

Thomson's relationships do not follow directly from thermodynamics, but they can be deduced either by postulating the reversibility of thermodictric processes, or on the basis of the principle of the symmetry of blactic coefficients, the introduction of which involves additional hypotheses. Several investigations have been devoted to the measurement of a. II. and r and the verification of Thomson's relationships for metals. In the majority of these investigations the relationship (3) has been adequately substantiated, although very conflicting results have been obtained with regard to relationship (5).

Despite this we know only of two investigations in which the Peltier and Thomson effects have been studied for semiconductors. Königsberger and Weiss measured the Thomson coefficient for two semiconductors: Si and MoS<sub>2</sub>. Gottstein\* measured the thermal emf coefficient and the Peltier coefficient for these substances and used his and Königsberger's results for checking Thomson's relationships.

Relationship (3) was found to be in accordance with the experimental data; the quantities entering into expression (5), i.e.  $\tau$  and  $T\frac{d\alpha}{dT}$ , were found to differ by a factor of 2 to 3.

It was therefore of interest to find out how semi-metals, which are at present used in thermoelectric generators and refrigerators, obey these relationships.

G. Gottstein, Ann. d. Phys., 43, 1079, 1914.

It was also of interest to determine the temperature dependence of the thermal emf and the mobility. Investigations of the temperature dependence of the mobility for semiconductors with an atomic lattice (Si, Ge, Zn, Sk, etc.) had yielded relatively good agreement with expression (44); however, there was no investigation confirming relationship (46).

For the majority of semiconductors Pisarenko's formula gives an unsatisfactory agreement with the experimental data. Since the substances used in thermoelements (PbS, PbSe, PbTe, Bi<sub>2</sub>Te<sub>3</sub>) occupy an intermediate position between purely ionic and atomic compounds, neither theoretical nor experimental investigations have yielded unequivocal answer to the problem of the temperature dependence of mobility in such substances. Some importance was therefore attached to a direct determination of the temperature dependence of the thermal emf and the mobility for such substances.

Finally, it was essential to verify the principal hypotheses of the theory of thermoelectric cooling experimentally.

2.1 Methods of investigating the thermoelectric properties of semi-conductors.

Measurement of the Peltier and Thomson coefficients. For the simultaneous measurement of the Peltier and Thomson coefficients an instrument, which is shown schematically in fig. 4, was constructed.

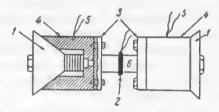


Fig. 4

The investigated specimen 6 was soldered to two plates 3 which were then screwed to cylindrical cups 4 with conical lids 1. All parts of the instrument (cups, lids, and plates) were made of red copper with ground contact surfaces. Inside each of the cups was housed a 0.1 mm diam. constantan wire heater with a resistance of 16 ohms, wound on a cylindrical extension of the lid. To each of the cups were soldered insulated copper and constantan wires 5, forming thermocouples for measuring the temperature difference across the specimen. The thermal emf of the specimen was measured with reference to copper using copper leads. Good contact at the interface between the specimens and the plates was achieved by careful tinning and soldering over the entire contact surface.

The Peltier heat was measured by the null method evolved by Gottstein. Current was allowed to flow through the specimen and at the same time the electric heater mounted in the cup was switched on. The lutter was ranked owing to the Peltler heat keing absorbed at the cald junction. When the currents were such that the temperatures of both cups were equal, the Joule heat generated by the electric heater balanced the heat almorbed by the adjacent junction, heating the corresponding cup to the same temperature as that of the other cup, which was heated by the Peltler heat. Therefore, under these conditions the Joule heat was equal to twice the Peltler heat. The Peltier coefficient was determined from the formula

$$II = \frac{I_h^2 R_h}{2I_o} , \qquad (90)$$

where  $l_h$  and  $R_h$  are the current and resistance of the henter respectively and  $l_0$  the current flowing through the specimen.

Mensurement of the Thomson coefficient was carried out with the same instrument by comparing the Joule heat generated in the specimen with the Thomson heat. For this purpose one of the heaters was first switched an until a stationary temperature drop of 10-30° was established across the specimen. A current was then passed through the specimen for 1.2 minutes in a given direction, and after a pause of 10-15 minutes, required for allowing the apparatus to return to its initial stationary state, the current was passed in the opposite direction.

The temperature of the specimen when the current was flowing through it was measured with the aid of thermocouple 2, soldered to a capper foll strip 0.1 mm thick, which was in turn glued with Glyptul varnish to the centre of the specimen. Before taking the measurements, the emf of the thermocouple was balanced with the aid of a potentiometer. When the current started to flow the balance was upset by the heat generated in the specimen, the deflection of the galvanometer  $\gamma_1$  with the current flowing in a given direction being proportional to the sum of the Joule heat

$$Q_I = I^2 R dt (91)$$

(where R is the resistance of the specimen and r the time), and the Thomson beat

$$Q_{\mathbf{r}} = rI(T_1 - T_0)dt; \qquad (92)$$

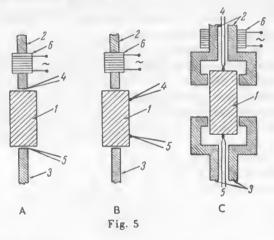
when the current was flowing in the opposite direction, the galvanometer deflection  $\gamma_2$  was proportional to the difference between these heats. The resistance of the specimen was measured before the tests. Galvanometer deflections were recorded at 15 second intervals from the location of

switching on the current. Using expressions (91) and (92), the Thomson heat was calculated from the formula

$$Q_{r} = \frac{\gamma_{2} - \gamma_{1}}{\gamma_{1} + \gamma_{2}} I^{2} R . \tag{93}$$

Measurement of the thermal emf. Fig. 5a shows a diagram of un instrument usually employed for the measurement of the thermal emf of semiconductors.

The investigated specimen 1 is clamped with the aid of a load or a spring between two metal rods 2 and 3. On one of these rods (2) an electric heater 6 is wound so that it serves as a heat source, whilst the other



rod (3) serves as a heat sink. To the tips of the hot and cold rods are soldered, or pressed in, metallic measuring thermocouples 4 and 5. The temperatures of the ends of the specimen  $T_1$  and  $T_2$  and its thermoelectric emf  $E_{\infty}$ , with reference to one of the branches of the measuring thermocouples, are measured by a null method. The thermal emf coefficient in then calculated from the formula

$$\alpha = \frac{E_x}{T_1 - T_2} . \tag{9.1}$$

This very simple method suffers from a substantial defect, namely, a temperature drop always exists between the specimen and the rods; this drop is proportional to the heat flux and the thermel resistance of the

contacts. As a result of this, the measured temperature difference across the specimen is higher than the true case, and farmula (94) gives too low a value for the thermal emf coefficient. This error can be apprecially reduced by arranging the thermocouples at one side of the 'main' heat flux, i.e. on one of the side faces of the specimen, as shown in fig. 5h.

The error is elmost completely removed by eliminating the heat flux arross the contact surface between the thermocouple and the specimen. Fur this purpose the portions of the thermocouple adjoining the contact surface should be meintained at a temperature equal to that of the ends of the specimen. Fig. 5c shows an instrument for measuring the thermal sumf coefficient based on the above principle which was employed in this lavestigation. For studying the temperature dependence of the thermal sumf, the entire instrument is mounted in an electrical forence or in a supecial jacket in a Dewar vessel filled with liquid nitrogen.

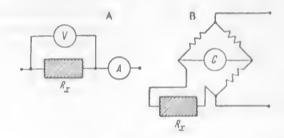


Fig. 6

The instrument shown in fig. 5b has an additional advantage in allowing the simultaneous measurement of the thermal emf coefficient and electrical conductivity; the heat source and sink act in this case on current conductors, and one of the branches of the thermocouples as probes for measuring the voltage drop.

Measurement of the electrical conductivity. The electrical combine-

$$\sigma = \frac{l}{R_x S}, \tag{95}$$

where l is the length of the investigated specimen, S its cross-section and and  $R_x$  its resistance. The measurement of the electrical conductivity of semironductors differs from that of metals in that in the former tase  $R_x$  cannot be measured by the numeter and voltmeter method (fig. 6a) or a bridge scheme (fig. 6d), since in both resest the results of measurement include a contribution from the contact resistances, which in the

case of semiconductor materials may exceed the instatonce of the specimen itself many times. Therefore the electrical conductivity of semiconductors is usually mensured by a probe method using the null arrangement shown in fig. 7.

Measurements may be carried out both with d.c. and a.e.; in the first case, in order to eliminate the thermal emf between the probes,  $E_{\rm x}$  should

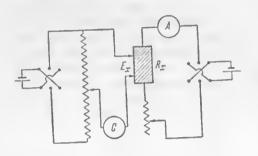


Fig. 7

be taken as a menn of two measurements taken with the current flowing in opposite directions. When making measurements with a.c., the null instrument may consist of a vibration galvanometer or a narrow band amplifier with a millivoltmeter connected to its output.

Measurement of mobility and carrier concentration. The mobility and the con-

centration of majority carriers are usually determined by the simultaneous measurement of the electrical conductivity and the Hall constant.

Fig. 8 shows a scheme of the simplest apparatus for the measurement of these quantities with d.c. using a null method. Probes 1 and 2 serve for the measurement of the Hall emf, and probes 3 and 4 for the measurement of the electrical conductivity. In order to eliminate thermomagnetic effects and the potential difference between probes 1 and 2 due to their asymmetry, the Hall emf is determined as an average of four measurements, with opposite directions of the magnetic field, and opposite directions of current flow through the specimen.

Fig. 9 shows an apparatus for the measurement of the llall effect with a.c., in which the thermomagnetic effects are eliminated, thus permitting a substantial simplification of the measurements; this scheme was used in the work described here. The a.e. source of 500 c/s consisted of a sound (frequency) generator. In order to match the load to the output impedance of the generator a step-down transformer was connected at the output of the generator which had a transformation ratio of 0.01. The current flowing through the specimen was mensured by determining the voltage drop over a standard resistance of 10<sup>-3</sup> ohm connected in series with the specimen. The voltage drop between the probes, the Itall emf, and the voltage drop across the standard resistance were measured using

an amplifier. The initial potential difference due to the asymmetry of their probes was inlanced by feeding an alternating voltage tapped from a

phase shifting bridge into the liall and circuit (both the umplitude and the phase had to be indenced). The measuring instrument consisted of a narrow band amplifier (see Vinsova and bill'bans') with a selenium rectifier and a d.c. millivoltmeter connected at its output.

In order to make the transminnion band narrower, the uncond stage of the amplifier wan lased on a narrow transmiswhom haad RC phase filter circuit with combined positive and nega-Hvr feedback. The width of the transmission band provided by this circuit was approximately 6 c/s and the noise level 0.3 µV, which permitted the measurement of the Hall emf to an accuracy 11 μV. The amplifier output land provisions for connection to un oscillograph, making it poswible to determine the earrier wign from the phase of the Hall

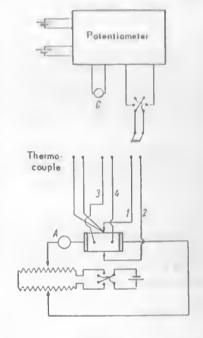


Fig. 8

rmf. The carrier sign could also be determined by feeding a low alternating voltage, having a frequency of 500 c/s, to the input of the third stage.

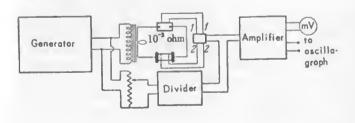


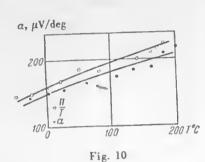
Fig. 9

R. M. Vlasova and L. S. Stil'bans, Zhur. Tekh. Fiz., 25, No. 4, 571, 1955.

The power supply consisted of an electronic voltage stabiliser.

2.2 Results of the experimental investigations of the thermoelectric properties of semiconductors.

Results of measurements of the Peltier and Thomson effects. Fig. 10 shows results of measurements of Il and a for a ZnSb specimen in the tem



In order to carry out measurements at low temperatures the instrument described above was mounted in a Heppler-type thermostat; measurements at elevated temperatures were carried out in a specially designed furnace fed from a ferromagnetic voltage stabiliser. Fig. 11 shows the results of measurements of II and a for a PbTe specimen in the temperature range from 21 to 110°C.

It is seen from the graphs that in both cases the results agree with the theory to within 3-5%, which is within the experimental error.

The results of the measurements of the Thomson coefficient r for Znbb and Pb'l'e are shown in figs. 12 and 13 (curve 1); for the purpose of comparison these figures also

show  $T\frac{da}{dT}$  (curve 2) based on the data plotted in figs. 10 and 11, and theoretical curves (3) based on the measurements of the liall effect. In the temperature range

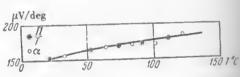


Fig. 11

from -40°C to +180°C, the carrier concentration in ZnSb is constant and therefore the theoretical curve becomes a straight line. As may be near from the graphs, the values of the Thomson coefficient for PbTe and ZnSb differ somewhat from the theoretical values, but the deviations lie within the limits of the experimental error, estimated in this case at approx. 10%

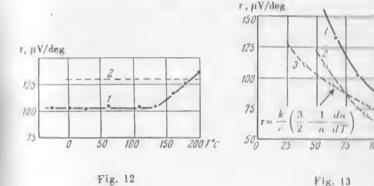
Investigation of the thermoelectric properties of lead telluride and lead selenide.\* As has been mentioned earlier (32), the thermal emf of a non-degenerate semiconductor with a single type of carrier can be expressed by the formula

$$a = \pm \frac{k}{e} \left[ r + 2 + \ln \frac{2(2\pi mkT)^{\frac{3}{2}}}{h^{3}n} \right].$$

 N. V. Kalomoets, T. S. Stavitskayn, and I. S. Stillbonn, Inv. Akad. Nauk. SSSR, Ser. Fiz., 27, No. 1, 73, 1957. where the carrier free path length in, in the general came, given by

$$l = f(T) e^{t}, (96)$$

Both the function f(T) and r are governed by the mechanism of carrier meathering in the lattice of the substance.



For scattering by thermal lattice vibrations and at temperatures above the Debye temperature

$$l \propto \frac{\epsilon^r}{T}$$
, (97a)

where r=1 for an ionic lattice and r=0 for an atomic lattice; for scattering by lattice defects, f(T) = const, and

In particular, for scattering by impurity ions r = 2, etc.

The temperature dependence of mobility is also governed by the expression for the free path length (96). The general expression for the mobility of non-degenerate carriers has the form

$$u \propto T^{-\frac{s}{2}} \int_{0}^{\infty} l(\epsilon) e^{-\frac{\epsilon}{k}T} \epsilon d\epsilon.$$
 (98)

Therefore, according to (98) and (97a), we have for scattering by thermal lattice vibrations

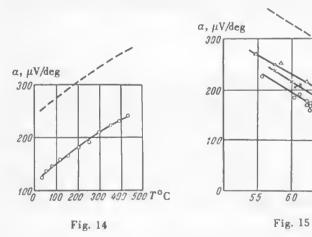
$$u = T' - \% \tag{99}$$

For scattering by defects, we have, according to (90) and (97b),

$$u \propto T^{r-\frac{1}{2}}. (100)$$

The above relationships show that the simultaneous measurement, in one and the same material, of the temperature dependence of the thermal emf, electrical conductivity, and carrier concentration makes it possible to arrive at a number of important physical conclusions. The temperature dependence of mobility in the high temperature range makes it possible to obtain an idea on the nature of bonds in the lattice, whilst the temperature dependence of mobility in the low temperature range indicates the character of the defects. Having determined the carrier concentration from the Hall effect, and the exponent r from the temperature dependence of mobility, we can determine the effective mass of the carriers from the value of the thermal emf. The investigation described in this paragraph represents an attempt to solve this problem.

As materials for the investigation we have selected lead telluride and lead selenide, as well as the solid solution PbTe-PbSe, since these substances were until very recently the best materials for the negative branch of the thermocouples. Apart from its theoretical interest, the investigation of the thermoelectric properties of these materials was also of major importance. The investigations were carried out on polycrystalline specimens prepared by sintering. Measurement of the thermal emf, electrical conductivity, and Hall effect, was carried out employing the usual methods described previously.



The high temperature range. Fig. 14 shows the temperature dependence of the thermal emf for a specimen of n-type lead telluride with a carrier

65

70 ln (n×10-16)

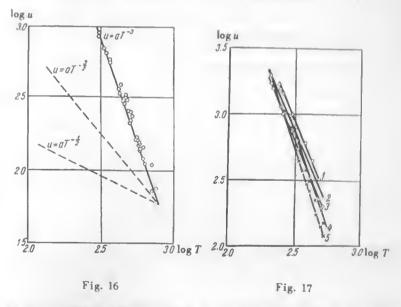
concentration of  $n=0.9 \times 10^{40}$  cm. in the temperature range 0-450°C. The hatched line shows the theoretical dependence according to expression (02) on the assumption that A=2 (both here and in subsequent considerations we shall denote by A the first term in Plearenko's formula: A=r+2 and  $m=m_0$ .

Fig. 15 shows the dependence of the thermal end on currier concentration at room temperature for n-type lend telluride (curve 1), and n-type (turve 2) and p-type (curve 3) lead selenide; the hatched line represents the theoretical curve constructed according to expression (32), assuming again that A=2,  $m=m_0$ .

From figures 14 and 15 we can infer that:

1) the dependence of the thermal emf on temperature and carrier conrentration agrees approximately with that given by theory;

2) the absolute experimental values of the thermal emf differ from the theoretical values by 120  $\mu$ V/deg for lead telluride and somewhat land for lead selenide. This disagreement between the theoretical and superimental values of emf can be attributed to one of two causes: either, (a) the effective mass of the carriers is approximately 2.5 times lower than the free electron mass, or (b) the value of the first term in formula (1), taken in fact quite arbitrarily as A = 2, is incorrect.



We have already mentioned that a relationship between A and the temperature dependence of mobility exists. For an atomic lattice r = 0,

DAPEREMENTAL INVESTIGATION

A = 2, and

$$u = T^{-\frac{N}{2}},\tag{101}$$

whilst for an ionic lattice at temperatures above the Debye temperature r = 1, A = 3, and

$$u \propto T^{-1/2} . \tag{10.1}$$

With regard to their bond character, lend telluride and lend selection occupy an intermediate position between these two limiting cases and it could have been predicted in advance that the value of r would like between 0 and 1.

Fig. 16 shows, with logarithmic co-ordinates, the temperature dependence of the mobility for four specimens of lead telluride in the temperature range 300-700°K (curve 1). For the sake of comparison, the hatched curves represent the theoretical relationships (101) and (102). It follows from this graph that lead telluride obeys, with great accuracy, the law

$$u \propto T^{-3}. \tag{103}$$

Comparison of expressions (99) and (103) gives, for n-type Ph'l'o, r=-1.5 and, correspondingly, A=r+2=0.5. On putting A=0.5 and  $m\approx m_0$ , the theoretical values of the thermal emf given by expression (32) coincide with the experimental data.

Fig. 17 shows the temperature dependence of the mobility for specimens of lead selenide; n-type PbSe (curves 1, 2, and 3) obeys the law

$$u \propto T^{-\frac{5}{2}}$$
.

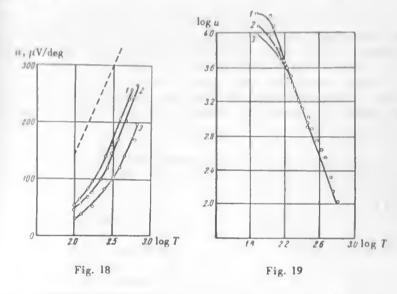
In this case the temperature dependence of mobility gives the values r=-1 and A=1. A comparison of the experimental values of the thermal emf with the theoretical values for A=1 gives, as in the case of leud telluride,  $m \approx m_0$ .

For p-type PbSe (curves 4 and 5)  $u \propto T^{-3}$ , whence r = -1.5.

The low temperature range. Figs. 18 and 19 show the temperature dependence of the thermal emf and mobility for a number of specimens of lead telluride and lead selenide with various carrier concentrations ( $\lambda - 0.48 \times 10^{10}$ ,  $2 - 3.8 \times 10^{10}$ ,  $3 - 7.8 \times 10^{10}$ ) in the temperature range  $100-700^{\circ}$  K. It is seen from these figures that at temperatures below  $200^{\circ}$  K the temperature dependence of the thermal emf deviates from the theoretical curve constructed according to expression (32) (hatched curve) and the temperature dependence of the mobility deviates from the

tow (103) The higher the carrier concentration, the higher the temperature to which the deviations from the laws established in the preceding paracular are abserved.

These deviations can be attributed to two causes: (a) the onset of lageneracy, and (b) a change in the scattering mechanism, i.e. transition is menttering by thermal lattice vibrations to scattering by louised impurities.



The carrier concentration in the investigated specimens varied from  $n_1 = 10^{10}$  to  $n_2 = 10^{10}$  cm<sup>-3</sup>.\* At these concentrations one would expect the onset of degeneracy at low temperatures. Since the carrier concentration in the investigated specimens varied by a factor of more than 10, the temperatures of the onset of degeneracy should also have been quite different:

$$\frac{T_1}{T_2} = \left(\frac{n_1}{n_2}\right)^{3/2} .$$

In reality, the changes in the temperature dependence of the mobility took place, for all specimens, within a narrow temperature range. Therefore, the cause of the departure of the experimental temperature dependence of the thermal emf from the theoretical dependence cannot be attributed to degeneracy.

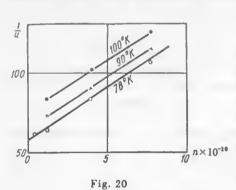
<sup>a</sup> E. Z. Gershiein, T. S. Slavitskaya and L. S. Stil'bans (*Zhur. Tekh. Fiz.*, 27, No. 11, 2472-2483, 1957) later extended this range to  $5 \times 10^{17}$  to  $2 \times 10^{20}$  (Translator's note).

The carrier mobility, for scattering by thermal vibrations only, decreases with decrease of temperature on one would expert that neutrering by lattice defects should become more noticeable at low temperature. The reciprocal of the mobility should then represent the sum of two terms:

$$\frac{1}{u} = aT^3 + bn_d , \qquad (104)$$

where  $aT^3$  is the resistance to the movement of electrons due to the thermal vibrations of the lattice, and  $bn_d$  the resistance due to scattering by impurities, where b is a coefficient which in general may depend on temperature, and  $n_d$  is the concentration of defects.

It may be considered that the scattering centres in n-type lead telluride consist of ionised excess lead atoms, the number of which is equal to the number of conduction electrons. Fig. 20 shows the corresponding relationship  $\frac{1}{u} = f(n)$  for a few temperatures close to the temperature of liquid nitrogen. The fact that this relationship is represented by a number



of straight lines favours the scattering mechanism postulated by us. From the fact that these lines are parallel it follows that the coefficient b is independent of temperature. The departure of the temperature dependence of the thermal emf from the theoretical value observed in this temperature range may also be related to the change of the character of the scattering of electrons.

As bas been mentioned earlier, when the mobility follows the law  $u=\alpha T^{-3}$ , the value of A in expression (32) should be close to unity. For scattering by impurity ions  $l \ll \epsilon^2$ , which should make the value of A in expression (32) equal to four. To each scattering mechanism there corresponds a certain value of A. The intermediate temperature range, in which the character of scattering changes, should be characterised by a gradual change in the value of A.

Thermoelectric properties of the PbTe-PbSe solid solution. According to equation (37a) the figure of merit of semiconductor thermoelements is proportional to the ratio of the carrier mobility u to the thermal conductivity of the crystalline lattice  $\kappa_{ph}$ . For lead telluride and lead selenide this ratio is relatively high, so these substances are good materials for

the branches of thermoelements. From this viewpoint, an even better substance is the solid substinue PhTe-PhSe.

According to the Ideas of A. V. laffe, at whose initiative a study of the aforementioned system was undertaken, replacement of a certain number of tellurium atoms by selenium atoms in lead telluride must lead to relatively small distortions of the crystalline lattice, owing to the Isomorphism of PbTe and PbSe.

These distortions should be very ineffective for the scattering of electronic waves, the length of which renches a few tens of augstrous at most temperature, but they should be quite effective for scattering thermal lattice vibrations, the wavelength of which is much shorter (at temperatures above the Debye temperature it is of the order of the lattice cunstant). Consequently, the ratio  $u/\kappa_{ph}$  should be higher for the solid solution than for the starting materials.

Experimental investigation confirmed this hypothesis: the value of  $u/\kappa_{ph}$  in the solid solution PbTe-PbSe was 1.5 times as high as in PbTe and twice as high as in PbSe.

We shall not reproduce the data relating to the temperature dependence of the thermal emf for the solid solution here, since it differs little from

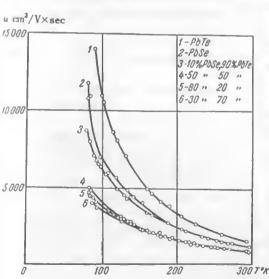


Fig. 21

the temperature dependence of the thermal emf for the starting materials. We shall confine nurselves only to the discussion of the dependence of the carrier mobility on alloy composition and temperature.

Fig. 21 shows the dependence of mobility on temperature for speciment of various compositions. It is seen from this figure that the carrier mobility decreases with increasing departure of the composition of the specimens from that of the starting components. An exception here is the 50% PbSe-50% PbTe specimen (curve 4)

in which the mobility at low temperatures is higher than in 30% PhSe-70% PbTe (curve 6) and 80% PbSe-20% PbTe (curve 5) specimens. This may

10000

5000

90°K

300°K 500°K

50%

Fig. 22

Pose

be attributed to the oaset of ordering in specimens with 1:1 composition.

Fig. 22 shows the dependence of mobility on composition at various temperatures. These curves permit us to reach certain conclusions concerning the mechanism of electron scattering by neutral defects.

It is known that the carrier mobility for specimens of any composition may be expressed by the following general formula:

$$u = \frac{e}{m}\tau = \frac{e}{m}\frac{1}{\nu}, \qquad (105)$$

where r is the relaxation time and  $\nu = \frac{1}{r}$  is the number of collisions in n second. For a low percentage of lead selenide in lead telluride, it may be considered, to a first approximation, that the number of collisions per

second  $\nu$  represents the sum of collisions with thermal lattice vibrations  $\nu_{ih}$  and collisions with impurity atoms  $\nu_{i}$ 

nd collisions with impurity atoms

$$\nu = \nu_{ih} + \nu_i \; ; \tag{106}$$

 $u_{th}$  may be calculated from the mobility in lead telluride containing no impurition

$$u_{\rm PbTe} = \frac{e}{m} \times \frac{1}{\nu_{th}} . \tag{107}$$

Substitution of  $\nu_{th}$  from (107) and 1 from (105) into (106) permits the calculation of  $\nu_i$ .

Moreover, the rate of collision with impurity atoms may be expressed uning the following formula:

$$\nu_i = \overline{v} SN_i, \qquad (1011)$$

where S is the effective cross-section for scattering by impurity atoms,  $N_i$  the number of impurity atoms in cm<sup>3</sup>; and  $\overline{v}$  the mean thermal velocity

$$\overline{v} = \sqrt{\frac{2kT}{m}} \times \frac{F_{i}(\mu^{*})}{F_{i/2}(\mu^{*})},$$
(10))

where  $F_1(\mu^*)$  and  $F_{1/2}(\mu^*)$  are Fermi integrals, and  $\mu^*$  is the reduced rhemical potential.

Thus, having found  $\nu_i$  as a function of temperature from the temperature dependence of the mobility, it becomes possible to obtain the effective scattering cross-section S as a function of temperature

$$S = \frac{v_l}{\overline{v}N_l}$$
.

Fig. 23 shows the dependence of the effective scattering cross sortion on temperature for specimens of different compositions with a entire concentration  $n=6.5\times 10^{10}$ . It will be seen from the curves that the

offective nenttering cronn-nection decreases with decreasing temperature. This fact can be qualitatively explained no a result of the drop in the thermal velocity of electrons, and therefore an increase of the wavelength, with decreasing temperature. At temperatures below 200°K the decrease of the effective crossmertion becomes less steep, which can be attributed to degeneracy. With the onset of degeneracy, the velocity and wavelength of electrons tenne to depend on temperature, and ronnequently the effective scattering proma-section also becomes indepenilent of temperature.

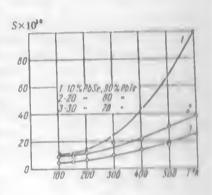


Fig. 23

To check this hypothesis, measurements were made of these relationships for two specimens of the same composition but with different corrier concentrations, viz  $n_1 = 1.5 \times 10^{10}$  and  $n_2 = 1.5 \times 10^{20}$ , (see curves 1 and 2, respectively, of fig. 24). The effective cross-section for the specimen with the lower carrier concentration continues to drop down to the lowest temperatures, whilst for the specimen with the higher concentration the effective cross-section is found to be constant over the entire temperature range. The absolute value of the effective scattering cross-section does not exceed  $2 \times 10^{-16}$  cm<sup>2</sup>, which is at least 10 times less than the cross-section of the impurity atom. This can be explained by the fact that distortions are introduced only by differences between the cross-sections of the impurity and normal atoms of the lattice.

Fig. 25 shows, using logarithmic co-ordinates, the dependence of the effective scattering cross section on the electron velocity calculated according to expression (109). From the slope of the straight lines we find that

$$S = v^* \tag{111}$$

and since v a 1/\(\lambda\) (where \(\lambda\) in electron wavelength), we have

$$S = \frac{1}{\lambda^4}.$$
 (110a)

Thus, in the case investigated here, we have found a formal aunlumwith Rayleigh's law for the scattering of light in the atmosphere.

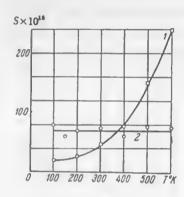


Fig. 24

Introduction of balanced impurities We have established that for lead to luride the exponent r in the expression giving the dependence of free just length on energy is equal to 1.5 and therefore, A = 0.5; for impurity law r = 2 and A = 4. Therefore by introducing a sufficient amount of impurity ions into lead telluride it is possible to increase the first term in expression (32) by 3.5 units, which corresponds at a given carrier concentration, to an increase in the thermal emf of

$$\frac{K}{e}3.5 = 86 \times 3.5 \approx 300 \ \mu\text{V/deg}.$$

On the other hand, introduction of impurity ions brings about a decrease of mobility. Calculations show, however, that by introducing a measured

amount of ions it is possible to attain a certain  $\log S$  increase of the value of  $\alpha^2\sigma$ . In order to prevent the carrier concentration from changing it is necessary to introduce simultaneously equal quantities of donors and acceptors, to make both types of impurities balance each other as regards their effect on carrier concentration (hence the term 'balanced impurities').

Initial experiments, aimed at increasing  $\alpha^2\sigma$  by the introduction of balanced impurities, carried out on lead telluride, did not yield positive results. Fig. 26 shows the experimentally obtained relationship between the first term in expression (32) and the logarithm of the electron concentration which could be explained by a change in the scattering mechanism. Later on, it was found, however, that

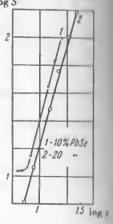


Fig. 25

the curve in fig. 26 served equally well for specimens with balanced and unbalanced impurities. Comparison of the experimental results with theory showed that the increase in the value of the first term in expression (32) was entirely due to degeneracy.

2.3 Comparison of the theory of thermoelectric couling with the experimental results.

Study of the temperature dependence of the figure of merit of thermolements. The temperature dependence of the figure of merit of thermolements z is governed by the temperature dependence of  $\alpha^2\sigma$  and  $\alpha^2\sigma$  and  $\alpha^2\sigma$  and  $\alpha^2\sigma$  and  $\alpha^2\sigma$  and  $\alpha^2\sigma$  and  $\alpha^2\sigma$ 

The lattice thermal conductivity  $\kappa_{ph}$  depends on the phonon scattering mechanism. At temperatures above the Debye temperature: 1)  $\kappa_{ph} \propto T^{-1}$  in Ideal crystals, i.e. for the scattering of phonons by phonons; 2)  $\kappa_{ph}$  independent of temperature for the scattering of phonons by lattice defects. Intermediate cases may, of

mechanisms participating; in this case the numbers of collisions of phonons with phonons, and with defects, i.e. the reciprocals of the free path lengths, are additive.

The electronic thermal conductivity and its temperature dependence at low temperatures are related to the electrical conductivity by the Wiedemann-Franz law. At high temperatures an exciton

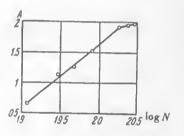


Fig. 26

mechanism of thermal conduction also begins to play an important part. These problems will not be considered here, since they have been discussed in detail in the paper by Ioffe and Ioffe.

The temperature dependence of the numerator  $\alpha^2\sigma_{\rm o}$  in the expression for a is governed, according to expressions (32) and (33), by the temperature dependence of the carrier concentration and of the mobility. It has been mentioned earlier that in order that  $\alpha^2\sigma_{\rm o}$  should preserve its maximum value over a wide temperature range, the carrier concentration should, according to expression (37), rise gradually with temperature:  $n_0 \propto T^{\frac{1}{2}}$ . However, there are no substances in nature which follow such a law and, therefore, the materials for thermocouple arms consist as a rule of seminature in which the carrier concentration is constant. Depending on the

.. A. V. folle and A I toffe, for Akad Nauk SSSR, Ser. Fiz., 20, No. 1, 1956.

<sup>T. L. Koval'chik and Ya. P. Masiakovets, Zhur. Tekh. Fiz., 26, No. 11, 2417-2431, 1956; E. Z. Gershtein, T. S. Stavitskaya, and L. S. Stil'bans, ibid, 27, No. 11, 2472-2403, 1957, consider this in greater detail.</sup> 

working temperature range, a suitable another of donors or acceptors in introduced into the semi-metal no un to fulfil candition (37) approximately within this particular temperature range,

Therefore the temperature dependence of alo in memi-metals in cutting governed by the temperature dependence of mobility.

The negative arm of the thermoelement may be made of lead tellution in which the mobility is inversely proportional to the cube of the tempera

 $\alpha^2 \sigma \times 10^6$ 

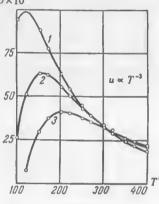


Fig. 27

ture, and the positive nrm of outlineary telluride with additions of some uther materials; for this arm  $u \propto T^{-\frac{1}{2}}$ , Figure 27 and 28 show the temperature depen dence of a20 in these two cames (a) three carrier concentrations giving maxima of  $a^2\sigma$  in different temperature ranges, curve 1 at  $220^{\circ}$ K ( $n = 3.5 \times 10^{14}$ ) curve 2 at  $360^{\circ}$ K ( $n = 5.5 \times 10^{10}$ ), and curve 3 at  $400^{\circ}$ K ( $n = 8.5 \times 10^{10}$ ).

It is seen from these graphs that the temperature at which  $a^2\sigma$  at a given TOK carrier concentration has the highest value need not coincide with the tem perature for which this concentration gives the maximum value of  $a^2\sigma$ ; in the

first case  $(u \propto T^{-3})$  these temperatures differ by a factor of 2, whilst in the second case  $(u \propto T^{-3/2})$  they coincide.

Figs. 29, 30, and 31 show, respectively, the temperature dependences of a, o, and a2o for six specimens of lead telluride with different carrier

concentrations. Fig. 32 shows a comparison with the theoretical relationship of the experimentally determined temperature dependence of a20 for specimens No. 2 and No. 5.

Figs. 33, 34, and 35 show similar curves for three specimens of antimony telluride. and fig. 36 gives a comparison between experimental and theoretical relationships.

These curves indicate qualitative agreement between

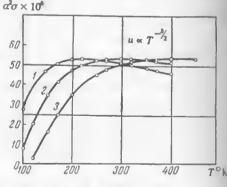


Fig. 28

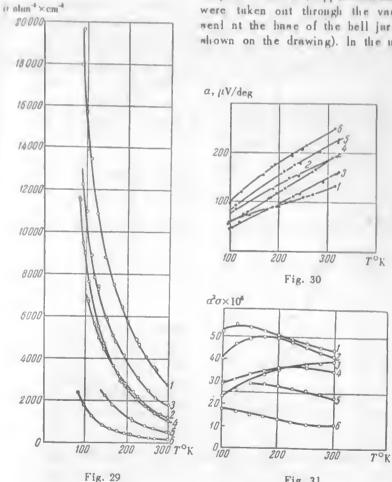
the theoretical and experimental data, as well as substantial discrepancies, the explanation of which requires further study.

Measurement of the coefficient of performance and the maximum tem perature drop. Tents on the thermaelements were curried out with the apparentus shown in fig. 37.

the thermaelement 7-7 was placed inside a brass hell fur I with a rubber vacuum seal at its base 14. The leads for the measuring thermo-

couples 2 and 3 (copper countrition) were taken out through the vacuum mend at the hanc of the hell for (not shown on the drawing). In the unper

Fig. 31



part of the bell jar there was a connection 4 to a forevacuum pump. On the outside of the bell jar, on an asbestos sheet, was wound a nichrome wire heater 5. The temperature of the wall of the bell jar was measured with the thermocouple 6.

The semiconductor thermoelement under investigation 7 was suddered to two brass bolts 8 insulated from the base. The heads of these bolts consisted of the chambers 9, through which was circulated a heat-absorbing liquid from a thermostat. The temperature of these chambers was measured with the thermocouple 10. A small constants heater 12

 $a^2 \sigma \times 10^6$ providing the working load wan cemented to copper plate 11, which bridged the cold junctions of the semiconductor thermoelement 7-7. 50 The cross-sections of the wires feeding the current to the heater 12 40 and of the thermocouple arms 2 were 30 20 a, µV/deg 10 100 200 300 TOK 200 Fig. 32  $\sigma$ , ohm  $\times$  cm  $^{-1}$ 100 8000 100 200 300 T°K Fig. 33 6000  $a^2 \sigma \times 10^6$ 4000 30 2000

selected so as to make the hent flux along their length negligible; the entire heat generated by the heater was therefore transferred to the cold junction of the thermoelement. Contacts 13 inserted through the vacuum seal served for introducing the current and measuring the voltage drop across the thermoelement under operating conditions.

200

Fig. 34

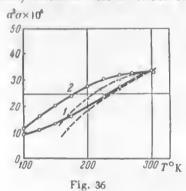
100

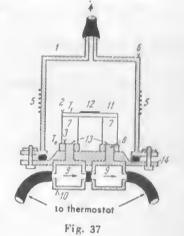
200

Fig. 35

During the experiments simultaneous readings could be taken of the but junction temperature  $T_0$ , the culd junction temperature  $T_1$ , the heater power consumption W, the current through the thermoelement I, and the

voltage drop across the thermoelement V. The thermoelement consisted of lead telluride (negative arm) and antimony telluride with additions of





other elements (positive arm) and possessed the following propertion:

PbTe: 
$$a_1 = -130 \ \mu\text{V/deg}, \quad \sigma_1 = 2000 \ \text{ohm}^{-1} \times \text{cm}^{-1},$$

$$\kappa_1 = 9 \times 10^{-3} \ \text{cal/cm} \times \text{scc} \times \text{deg};$$

Sb<sub>2</sub>Te<sub>3</sub>: 
$$\alpha_2 = +130 \ \mu\text{V/deg}, \quad \sigma_2 = 2000 \ \text{ohm}^{-1} \times \text{cm}^{-1},$$

$$\kappa_2 = 7 \times 10^{-3} \ \text{cal/cm} \times \text{sec} \times \text{deg}.$$

Hence

300 T°K

$$z = \frac{(\alpha_1 - \alpha_2)^2}{(\sqrt{\kappa_1 \rho_1} + \sqrt{\kappa_2 \rho_2})^2} = 1.2 \times 10^{-3} \text{ deg}^{-1}.$$

Fig. 38 shows the maximum temperature drop as a function of the hot junction temperature; the hatched line is the theoretical curve constructed on the basis of expression (16) taking into account the temperature dependence of z. It is seen from the graph that there is good agreement between the theoretical and experimental data.

The temperature drop across the themoelement was also investigated as a function of the working current at different hot junction temperatures

EXPERIMENTAL INVESTIGATION

(fig. 39). In fig. 40 a comparison is made between the experimental results (full lines) and theoretical relationships (hatched lines) for hat junction temperatures of  $+45^{\circ}$ ,  $+15^{\circ}$ , and  $-10^{\circ}$  C.

Fig. 41 shows the dependence of the optimum current on the cold junction temperature (the theoretical curve is shown by a hatched line)

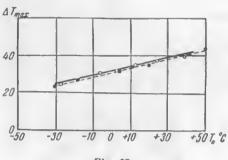


Fig. 38

It should be noted that the experimental values of  $l_{opt}$  contain large errors due to the very flat maximum on the curve showing  $\Delta T$  as a function of l

A study was also made of the dependence of the coefficient of performance on the value of the current and the difference between the junction temperatures. For this purpose measurements of the difference between the junction tempera-

tures  $(\Delta T = T_0 - T_1)$  were made as a function of the load (the load was provided by the heater mounted at the cold junction). Variations of  $\Delta T_0$  (temperature difference in the absence of load) were achieved by adjusting the value of the current flowing through the thermoelement; measurements were also made of  $\Delta T$  as a function

of the load Q at constant values of I.

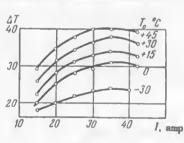


Fig. 39

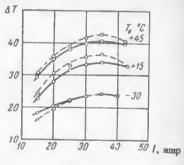


Fig. 40

According to equation (10) these relationships should be linear:

$$\Delta T = \Delta T_{\rm o} - \frac{Q_{\rm o}}{K}.$$

The thermal conductivity of the thermoelement could be determined from the slope of these straight lines.

Fig. 42 shows a family of such lines for a thermaelement operating at a bot junction temperature  $T_{\rm o}=145^{\circ}{\rm G}$ . The lines are parallel to each other. From the points of intersection of these lines with lines parallel

to the uxis of abscissne it is possible to determine the experimental dependence of  $\epsilon$  on l at given  $T_0$  and  $T_1$  and to compare it with the theoretical expression (14). Having found, for each  $\Delta T$ ,

optimum

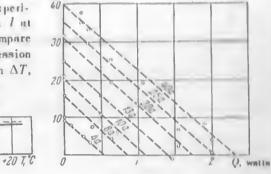


Fig. 41

Fig. 42

the value of  $\epsilon_{max}$  and drawn the curve of  $\epsilon_{max}$  as a function of  $\Delta T$ , the latter could be compared with expression (19).

Fig. 43 shows the experimental dependence of  $\epsilon$  on l, with the values of  $\Delta T^{\circ}$ K marked by the side of each curve. The maximum of these curves shifts towards lower currents with decreasing  $\Delta T$ .

In fig. 44 a comparison is made between the theoretical (hatched lines) and experimental (full lines) dependences of  $\epsilon$  on l for  $\Delta T_1 = 20^\circ$  and

 $\Delta T_2 = 12^{\circ}$ . For  $\Delta T_1 = 20^{\circ} \epsilon_1$  was also measured directly as a function of I; this was done by

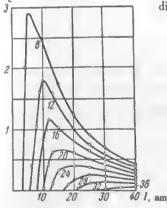


Fig. 43

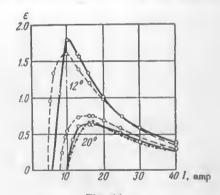


Fig. 44

varying l and  $Q_0$  and maintaining  $\Delta T$  constant and equal to  $20^{\circ}$ , and then calculating  $\epsilon$  for each  $Q_0$  from the measured values of  $Q_0$ , l, and V. This

curve is shown in fig. 44 by dashes and dots it is seen that the two experimental curves corresponding to  $\Delta T = 20^\circ$  are in good agreement. The theoretical curve for  $\Delta T = 20^\circ$  has an identical shape, but lies

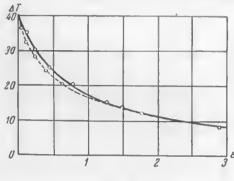


Fig. 45

everywhere above the experimental curve; the theoretical curve for  $\Delta T = 12^{\circ}$  is slightly below the theoreticurve.

The large discrepancies between experimental and theoretical values of colusered on the low-current side of the maximum may be attributed to the fact that the errors in calculating care found to be much higher in this region.

Fig. 45 shows the experimental (full line) and theoretical (hatched line) dependences of  $\epsilon_{max}$  on  $\Delta T$  for the temperature range  $T_0 = 45^{\circ}$ C to  $T_1 = +5^{\circ}$ C; the two curves are in good agreement.

On the basis of the evidence presented in this chapter it may be concluded that all the postulates listed in the preceding chapter, i.e. all the postulates of the theory of thermoelectric cooling, are in good agreement with experiment.

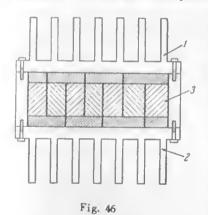
S. V. Airapetyants et al. (Zhur. Tekh. Fiz., 27, No. 9, 2167-2169, 1957) made a atndy of the properties of solid solutions based on lead telluride and bismuth telluride. The mobility of holes was found to depend on the regular periodicity of negative ions, whereas disturbances of the periodicity of positive ions were found to lead to a reduction of the mobility of electrons. Thus, in order to improve the quality of materials used in thermoelements by reducing their thermal conductivity without reducing the mobility, it is necessary to replace part of the positive ions in the material for the positive branch and part of the negative ions in the material for the negative branch. For example, a snitably doped solid solution of Bi<sub>2</sub>Te<sub>3</sub>-Sb<sub>2</sub>Te<sub>3</sub> used for the positive branch has a value of z more than twice that for pure p-Bi<sub>3</sub>Te<sub>3</sub>. On the other hand, as shown by S. S. Sinani and G. N. Gordyakovn (Zhur. Tekh. Fiz., 26, No. 10, 2398-2399, 1956), 80% at. Bi<sub>2</sub>Te<sub>3</sub>-20% at. Bi<sub>2</sub>Se<sub>3</sub> solid solution doped with 0.05% wt. CuBr has a value of z of around 2.5 and is eminently anitable for negative branches. (Translator's note)

## CHAPTER 3

# APPLICATIONS OF THERMOELECTRIC COOLING

## 3.1 Domestic refrigerators.

Construction of the thermobattery. The thermobattery should cannot of the following main elements (fig. 46): a block of thermoelements 3 connected in series, which has until now been called the thermobattery, an external radiator 1, i.e. a device for dissipating the heat from the hot junctions of the thermocouples; and an internal radiator 2 for the heat exchange between the cold junctions and air inside the refrigerated



chamber. We shall denote the temperature drop of the nir inside the chamber with respect to the temperature of the surroundings by  $\Delta T_A$ , the temperature difference between the internal radiator and air in the refrigerated chamber by  $\Delta T_B$ , the temperature difference between the external radiator and the surrounding air by  $\Delta T_C$ , the temperature difference between the cold junctions of the thermocouples and the internal radiator by  $\Delta T_B$ , the temperature difference between the hot junctions

and the external radiator by  $\Delta T_C^n$ , and the temperature difference across the thermocouple under operating conditions by  $\Delta T_o$ . Then

$$\Delta T_0 = \Delta T_A + \Delta T_C' + \Delta T_B' + \Delta T_C'' + \Delta T_B''.$$

Since  $\Delta T_A$  depends on the conditions of operation of the refrigerator and the coefficient of performance decreases with increasing  $\Delta T_0$ , it is obvious that the main problem in the construction of a battery is the reduction of the detrimental temperature drops  $\Delta T_C^*$ ,  $\Delta T_B^*$ ,  $\Delta T_C^*$  and  $\Delta T_B^*$ .

Thermal contacts between radiators and thermoelements. The simplest way to eliminate  $\Delta T_C^{"}$  and  $\Delta T_B^{"}$  completely consists of soldering a copper or an aluminium plate to each internal and external thermoelement junction.

APPLICATION II

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In this case the radiators would consist of a number of plates insulated from each other.

This design, which was used in the first thermolattery models, has a number of important shortcomings. Firstly, the free end of the plate forms a large lever with respect to the junction of the thermoelement, and there fore accidental contact with the plate may disturb commutation. Secondly, the current consumed by the thermoelement decreases with the decreasing cross-section area of the branches and such a construction mukes it impossible to reduce this area, since when this is done the distance between the plates becomes too small for satisfactory heat exchange; the reduction of area is desirable from the point of view of selecting economical power supply sources. Finally, this design does not make it possible to extend the surface of the radiators sufficiently and thus keep the values of  $\Delta T_C^i$  and  $\Delta T_R^i$  within acceptable limits.

Good thermal contact between the stages of a multi-stage battery and between the batteries and the radiators is relatively difficult to achieve, particularly at high thermal loads, when the detrimental temperature drop across the layers of electrical insulation increases. The difficulty lien in the fact that, in order to decrease the thermal resistance, the layer of the electrical insulation must be made in the form of a very thin strong film with high thermal conductivity. The problem is further complicated because conventional electrical insulators have relatively low thermal conductivities. Moreover, in spite of the thorough treatment of the surface of the radiators and the batteries, thin films (even mica plates) are pierced under high loads.

Tests were carried out in which the thermal resistance and strength of thin films (mica, teflon, vinyl chloride wetted with oil, silicone vnrnishes) were investigated. The following method gave good results. A mica plate, 20-30  $\mu$  thick, was inserted between the radiators and the thermobattery after wetting it on both sides with a silicone varnish containing a suspension of aluminium powder. The radiators were then drawn together with the aid of bolts screwed into ebonite plates. Measurements showed that with this construction  $\Delta T_B^n$  did not exceed 0.5°, and  $\Delta T_C^n$  did not exceed 1-2°. The lowest thermal resistance was exhibited by films prepared from FG-9 silicone varnish containing 6% aluminium powder. The films were deposited on the surface, and dried for two hours in a thermostat in which the temperature was gradually raised from 50° to 200°C.

Detrimental thermal resistances across insulating layers between two stages may be avoided by the simultaneous sinteriag of two-stage thermoelements.

As has been mentioned earlier, the first (lower) stage should have a refrigerating capacity of

$$\langle \mathcal{V}_1 = \langle \mathcal{V}_0 \left( 1 + \frac{1}{\epsilon_0} \right),$$

At  $\epsilon_1 = \epsilon_2 = \epsilon$  we find

$$W_1 = \frac{Q_1}{\epsilon}$$

and

$$W_2 = \frac{Q_2}{\epsilon}$$

and therefore

$$\frac{\overline{W}_1}{\overline{W}_2} = \frac{l_2}{l_1} \bigg|_{S = \text{cons}}$$

It is thus possible to vary the ratio of the capacities of the two stages by using branches of different length, which makes it possible to carry out simultaneous siateriag of a two-

stage thermoelement.

The coastruction of such a battery is shown in fig. 47.

Fig. 48 shows the design of a battery in which the detrimental resistances across the insulating layers between the battery and the radiator attached to it are eliminated. The

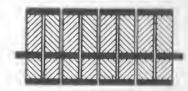
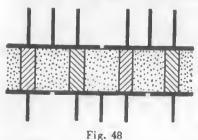


Fig. 47

junction electrodes also perform the function of heat transfer radiators. In the preparation of such a battery it is necessary to take into account

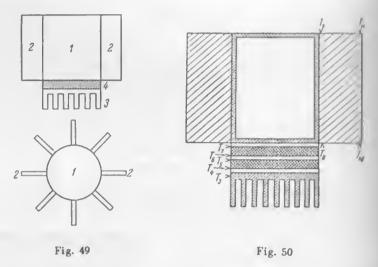
the electrical resistance of the electrode-radiators, which should not



constitute more than 2-3% of the resistance of each thermoelement.

Calculations show that the design of the external radiator as shown in fig. 46 is unsatisfactory and it should be modified so as to increase the area of the surface on which the fins are mounted by at least 5 times as

compared with that for the first prototype refrigerator. A variation of such a design is shown in fig. 49. The base 1 of the external radiator 2 represents a solid aluminium plate, a tank filled with a liquid, or a train which heat exchange is achieved by evaporation and condensation of some liquid. The base of the tank is in contact with the hat junctions of the thermobattery 4, whilst an internal radiator 3 is pressed against the cold junctions.



The second and the third of these alternatives were tried out. In the second alternative the tank was filled with water and in the third with saturated steam. In the last case the tank containing a small amount of water (approx. 100 cc) was evacuated. Under these conditions a high rate of heat transfer was ensured owing to the fact that the water "boiled" at the bottom of the tank and condensed at its side walls.

It was found that under operating conditions the temperature drop across the tank filled with water was only slightly higher than in the tank filled with steam. Since the former method is much simpler, all subsequent tests on refrigerators were carried out with a water-filled tank.

Design calculations for the thermobattery of the 1953 domestic refrigerator. Domestic refrigerators require a temperature drop of  $\Delta T_A \approx 25^{\circ}$ . Conforming with previous calculations  $\Delta T_C = \Delta T_B = 5^{\circ}$ .

Thus, neglecting the temperature drops between the radiators and the thermocouple block, the temperature difference between the junctions should be

$$\Delta T_{\circ} = 25^{\circ} + 5^{\circ} + 5^{\circ} = 35^{\circ}.$$

The materials from which the thermolectery was constructed had the following characteristics:  $a = 150~\mu\text{V/deg}$ ,  $\sigma = 2000~\text{ohm}^{-1} \times \text{cm}^{-1}$ ,  $\kappa = 9 \times 10^{-3}~\text{cal/cm} \times \text{sec} \times \text{deg}$ ,  $z = 1.23 \times 10^{-3}~\text{deg}^{-1}$ ; assuming  $\Delta T = 35^\circ$  we find from equation (19) that  $\epsilon_0 = 14\%$ , which cannot be regarded as satisfactory and indicates the need for employing two stages. Assuming  $\Delta T_1 = \Delta T_2 = 17.5^\circ$  we find for the individual stages  $\epsilon_1 = \epsilon_2 = 75\%$  and for

both stages  $\epsilon = \frac{\epsilon_1}{2 + \frac{1}{\epsilon_1}} \approx 22\%$ . Assuming the refrigerating capacity of the

thermobattery to be equal to  $Q_o=5$  W, we find that the total power required by the thermobattery is  $\mathbb{W}=Q_o/\epsilon=23$  W; for the higher stage  $\mathbb{W}_1=Q_o/\epsilon_1=7$  W and for the lower stage  $\mathbb{W}_2=\mathbb{W}-\mathbb{W}_1=16$  W. The voltage drop across each thermoelement will be  $v_o=0.03$  V (see equation (18)).

Assuming the power supply voltage V=1.4 V and the thermoelement length l=2 cm, we find from equation (70a) that the number of thermoelements N=46 (for the higher stage  $N_1=14$  and for the lower stage  $N_2=32$ ), the cross-section area of the arms  $S_1=S_2=1$  cm<sup>2</sup>, and the operating current I=V/V=16 A.

This concludes the calculations for the thermobattery. From design considerations the number of thermoelements was modified to  $N_1 = 15$  and  $N_2 = 28$ . Fig. 50 shows the assembled cooling unit schematically, and the positions of the thermocouples during tests (see table 2).

Tests on the refrigerator. Following an agreement on the co-operation of the Institute for Semiconductors of the Academy of Sciences of the U.S.S.R. and the Leningrad Technological Institute for the Refrigeration Industry, the latter constructed a 10 litre cabinet designed to include the above-described battery. Heat transfer by conduction in this cabinet

under operating conditions was accurately measured by the workers of the Refrigeration Institute and found to be equal to 0.053 cal/deg; subsequent tests were carried out on the battery mounted in this cabinet.

Fig. 51 shows the dependence of the temperature difference across the thermobattery on the current. The optimum current is

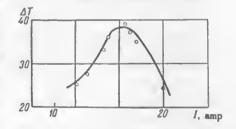


Fig. 51

I=16.5 A which agrees well with the calculated value  $I_0=16$  A. The temperature difference across the thermobattery was found to be somewhat larger than the calculated value ( $\Delta T_0=39^\circ$  as compared with the calculated value  $\Delta T_0=35^\circ$ ). However, such differences between the

experimental and the calculated values were quite understandable since the initial data were determined with insufficient or curacy.

It is seen from the plot in fig. 51 that a two-stage battery is much more sensitive towards departures of the current from the optimum value than a single stage battery. This can be attributed to the fact that when the current changes the heat balance between the stages is upset: If the current increases, the upper stage generates more heat than the lower one can absorb and, therefore, the temperature difference across the lower stage drops appreciably.

TABLE 2

Time of operation of the cabinet, hrs	1	2	3	4	5	6
Current, A	16	16	16	16	16	16
Voltage, V	1.6	1.6	1.6	1.6	1.6	1.6
Temperature, °C						
room, T <sub>1</sub>	24.6	25	25.7	26	26.7	27
inside the cabinet, T2	10.8	6.3	6.0	3.6	3.9	4
cold junctions of stage II, $T_3$ , $T_4$	4.5	3.4	0.8	0.3	0.2	0
bot junctions of stage II, $T_a$	27	25.8	27.8	27.5	28.1	27.7
cold junctions of stage $I$ , $T_a$	26	25.9	27.2	26.9	27.5	26.8
hot junctions of stage $I, T_7$	34	36.7	37.3	38	38.6	39.0
bottom of the tank, T;	32.0	34.4	35.1	35.4	36.6	36.2
at the base of the fin, at the bottom, $T_a$	28.7	31.8	32.5	32.9	34.2	34.4
at the base of the fin, at the top, $T_{\bullet}$	28.3	30.0	31.8	32.2	33.5	33.7
at the tip of the fin, at the bottom, T <sub>10</sub>	27.5	29.6	31.2	32.0	32.7	33.3
at the tip of the fin, at the top, $T_{11}$	28.1	29.8	31.8	32.2	33.5	33.7
$\Delta T_{w} = T_{1} - T_{2}$	13.8	18.7	20.7	22.4	22.6	23
$\Delta T_0 = T_7 - T_3$	29.5	33.3	36.5	37.7	38.8	39

Table 2 shows the results of tests on the cabinet made with the aptimum current over a six hour period. The table does not show the temperatures of the cold functions and the base of the internal radiator separately, since these were both found to be equal to the temperature T, within the accuracy of the measurements. This means that  $\Delta T_B^N = 0$ . As is seen from the table, the cabinet virtually reaches a steady state four hours after switching on. The temperature in the cabinet drops to +4°C at a room temperature of +27°C.

For comparison, we are giving data relating to the domestic refrigorator manufactured by the Gnzoapparat Works of the Ministry of the Ment Induatry of the Rusaian S.F.S.R. This refrigerator (model XIII-1A) provides a temperature drop of the air inside the cabinet to  $+8^{\circ}\text{C}$  4 hours after switching on, when the temperature of the surroundings is  $+30^{\circ}\text{C}$ . The coefficient of performance is  $\epsilon \approx 18\%$ .

Let us calculate the coefficient of performance of the thermoelectric refrigerator described above. As bas been mentioned earlier, the hent transfer by conduction into the cabinet is 0.053 cal/deg. Therefore, for a temperature difference of 23°, the beat flow into the cabinet amounts to  $Q_0 = 0.053 \times 23 = 1.22$  cal = 5.1 W. The coefficient of performance is thus

$$\epsilon = \frac{Q_0}{W} = \frac{5.1}{1.6 \times 16} = 20\%$$
.

Our calculations yielded the value  $\epsilon = 22\%$ .

The data in table 2 show that there was a large number of detrimental temperature drops at the interfaces within the thermobattery, partly due to design faults. The temperature differences over the fina  $T_{\bullet} - T_{\bullet}$  and  $T_{\bullet} - T_{\bullet}$  were partly due to lack of care in the design; the temperature difference  $T_{\tau} - T_{\bullet}$  was due to faulty soldering of the fins; the temperature differences  $T_{\tau} - T_{\bullet}$  and  $T_{\tau} - T_{\tau}$  were caused by inaccurate grinding of the contact surfaces.

Owing to these detrimental temperature drops, the working temperature difference  $\Delta T_{uv}$  was found to be equal to only a little more than half of the total temperature drop across the two stages:

$$\Delta T_0^* = (T_2 - T_4) + (T_5 - T_4) = 12 + 28 = 40^\circ.$$

A reduction of the aum of the detrimental temperature drops  $\Delta T_{\rm e}$  -  $\Delta T_{\rm w}$  would have led to an increase of the value of the coefficient of performance to 30%.

Further increase of the coefficient of performance would require an improvement of the thermoelectric properties of the thermocouple arms, i.e. a higher value of z.

Latest thermoelectric refrigerators. The tents in the 1953 thermoelectric refrigerator showed that even with the materials available at that time it was quite fensible to construct a refrigerator with a refrigerator chamber of large volume.

In 1954 work started (also in conjunction with the Leningrad Technological Institute for the Refrigeration Industry) on the construction of a thermoelectric refrigerator with similar technical and economical characteristics to those of existing absorption refrigerators. The refrigerator consisted of a wooden cabinet with a 55 litre capacity refrigerated chamber. The thickness of insulation of the cabinet walls, outside the region where the thermobattery was boused, was equal to 120 mm.

The quality of the cooling thermoelements at that time was improved, which permitted the dissipation of beat from the bot junctions of the thermobattery by natural air convection using a system of radiators. In these refrigerators use was made of PbTe-PbSe alloys (negative branch) and an alloy, the principal constituents of which were tellurium and antimony (positive branch).

Specimens were prepared by the methods of powder metallurgy (sintering at a temperature of 400°C and a pressure of 4-6 tons/cm²). Die-casting and directional crystallisation can also be used successfully for the preparation of thermoelements.

The quality of the thermoelements was controlled by measuring a and  $\sigma$  (by a null method).

There was no necessity in practice to measure the thermal conductivity  $\kappa$ , since the thermal conductivity of the crystalline lattice of the sub-

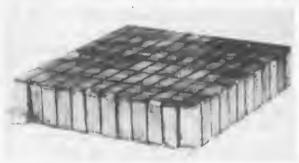


Fig. 52

stances employed in the construction of the thermocouples varied very little from one batch to another.

The specimens were tinned with a special alloy (80% Bi-20% Sn) at a temperature of 200°C, following which, copper plate elec-

trodes were soldered to the specimens. It was very important to eliminate any electrical contact resistance between the electrode and the specimen. The contact resistances were measured by a null method (using alternating current).

The batteries were assembled by connecting positive and negative specimens, separated by layers of electrical insulation, in series.

The construction of such a battery is shown in fig. 52. The tenting of the completed batteries consisted of the measurement of  $\Delta T_{max}$  in various

The tests showed that the thermolatterles prepared for the refrigerators gave an average maximum temperature drop of 47°C (from 440°C to -7°C). It should be noted that the latest thermoelements, prepared at the lastitute for Semiconductors of the Academy of Sciences of the U.S.S.R. from new alloys, give a much greater temperature drop (approximately 70°C) for the same hot junction temperature.

Tests were also carried out on a single-stage and a two-stage battery subjected to a heat load in vacuo. The heat load was applied from a plane electrical heater pressed against the cold junction of the battery but separated from it by a layer of mica.

These tests made it possible to assess the coefficient of performance of the battery, determined as a ratio of the power supplied to the heater  $W_f$  to the power consumed by the battery  $W_b$ :

$$\epsilon = \frac{W_f}{W_b}$$

for various currents I flowing through the battery.

The radiators fitted to the hot junction were made of copper and mounted in a row on the top parts of the rear and side walls. The design of the radiators ensured a temperature difference between them and the surroundings of not more than 4-5°. The internal cooling radiators were made of aluminium and arranged in a similar row on the upper part of the back wall of the refrigerated chamber. The surface area of the cooling

radiators was 1.4 m<sup>2</sup> and of the heat dissipating radiators was 3.8 m<sup>2</sup>.

The appearance of the cabinet is shown in fig. 53 and its cross-section in fig. 54.

Foursets of twostage thermobntteries with a total refrigerating capacity of  $Q_0 = 20$ kcnl/hr were constructed for the refrigerntor. Tests on the refrigerator gave



Fig. 53

the following results. With a d.c. power consumption of 40 W, a temperature

of -2°C was set up at the centre of the refrigerated chamber and with a power consumption of 30 W the temperature was +2°C. The temperature of the surroundings was +19°C. Steady conditions were set up in the refrigerator after 4-5 hours. Tests on the colonet showed a real passable lity of constructing a thermoelectric refrigerator on a commercial washe with a more economical operation than that of absorption refrigerators

A semi-commercial model of a thermoelectric refrigerator was constructed at the beginning of 1956, in conjunction with No. 2 Stampling

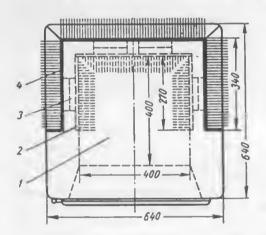


Fig. 54. Diagram of a refrigerator (as seen from above).

1 - the refrigerator chamber, 2 - cooling radiator, 3 - thermobattery, 4 - hot radiator.

Works of the Directorate of Local Industry of Leningrad. The design was based on the cabinet of the 'Leningrad' absorption refrigerator. The cooling units consisted of the thermobatteries used in the earlier model. The radiators fitted to the hut junctions were made of aluminium and mounted on the rear wall of the refri gerator. The internal rudiators, also of aluminium, occupied the greater part of the back wall of the refrigerated chamber. The cooling unit as a whole consisted of four sets of two-stage thermobatteries.

Each two-stage thermobattery was clamped between the cooling and heatdissipating radiators.

The useful volume of the refrigerated chamber was 40 litres. The hent dissipation from the hot radiators was attained, as in the previous model, by natural convection of the surrounding air. The refrigerator could be plugged directly into the 127 V mains. Rectification of the current and smoothing out of current ripples was achieved with the aid of a small rectifying unit assembled from germanium rectifiers. This unit was placed in the bottom part of the refrigerator shell.

Fig. 55 shows one of the four sets of thermoelements from which the unit was assembled. Fig. 56 shows the back wall of the refrigerator.

Tests on the refrigerator gave the following results:

1) under static operating conditions the temperature at the centre of the refrigerated chamber was equal to 0°, in the lower part of the chamber

2°, and at the caoling radiators foot (at a temperature of the surcoundings of 20-22°C);

2) the power cammunition (d.c.) of the refrigerator when starting up was 75 W and for stendy operation was 55 W;

3) the power drawn from the n.c. mains under steady conditions was 75 W; this power could, however, have been reduced to 65-70 W by unling letter quality transformers in the

rectifying unit.

3.2 Other applications of thermoelectric cooling. As has been mentioned earlier, the first thermoelectric refrigerators were less economical than compression refrigerators, the coefficient of performance of this order could be obtained with thermoelectric refrigerators with the values of z raised to  $2.5 \times 10^{-3}$  to  $3 \times 10^{-3}$  using twostage cooling, and to  $3 \times 10^{-3}$  using single-stage cooling. Very recently requisite conditions have been

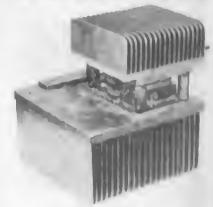


Fig. 55

created for good quality domestic refrigerators. Refrigerators tented in TU-104 passenger jet aeroplanes were found to give satisfactory nervice. Similar refrigerators are being developed for the railway transport.

llowever, even at the present time, there is an ever increasing number of fields of application in which semiconductor thermoelemeath have undisputed advantages over other cooling systems. We have in mind canen when it is necessary to cool small objects representing a thermal load of a few watts. Even the smallest contemporary cooling unit of any type will weigh much more than the cooled object and consume not least than 20-30 W of electrical power, whereas a cooling thermoelement with the same refrigerating capacity may weigh as little as 5-10 g and consume less than 1 W. Important factors here are the absence of rotating purts, such as are used in compression refrigerators, low inertia, and practically unlimited service life.

We shall consider now a few examples of possible applications of cooling thermoelements and thermobatteries.

The use of cooling thermoelements in meteorology. The measurement of air humidity is important in meteorological observations and in the control of numerous technological processes. One of the instruments must widely used for this purpose is the condensation hygrometer which relies on the measurement of the dew point for the determination of the relative humidity.

To determine the dew point it is necessary to have a set temperature of which can be gradually reduced until water as



Fig. 56

to condense on the large the two per the transfer of the surface o

Until now the surfaces in various of hygrometers had only on the substance of the substance of the substance of special had been of special had been of special had been of substances of the su

As a result of cell boration between the Institute for Semiconductors and the Vucibal Principal Geophysical Laboratory, prototypes of

an instrument for determining the dew point have now been construct which employ a semiconductor thermoelement, fed by d.c. from a minute accumulator, as the cooling unit. The cold junction of the thermoelement is provided with a condensation mirror. A beam of light is projected from a small bulb onto the mirror and reflected from it into a special planta sensitive relay. When the water vapour begins to condense on the mirror the reflection coefficient of the mirror changes abruptly, the intensity of the reflected beam of light drops and this actuates the photosensitive relay which changes the direction of the current flowing through the thermoelement. The heat which is now generated at the junction housing the mirror rapidly vaporises the moisture, the intensity of the reflected light again increases and the relay again reverses the direction of the

arent. With a anitable aelection of parameters the entire process takes only a few seconds. Fig. 57 shows a model of such a hygrometer.



Fig. 57

It should be noted that the inertia of the semiconductor thermoelement may be reduced simply by a reduction of its length, permitting the use of

much instruments for meteorological ubservations from an aeroplane. Another method of reducing the time required for attaining the necessary temperature drop consists of operating the thermodement under pulsed current conditions. In this case the current pulses substantially exceed the optimum current. The reduction of the time for achieving  $\Delta T_{max}$  across the thermoelement is due to the fact that the Pettier effect (proportional to the first power of the current) is a surface phenomenon and has a very low inertia, whereas the process of transfer of the Joule heat, generated in



Fig. 58

the volume of the thermoelement, to the cold junction is characterised by a much higher inertia.

This last method can only be used, however, when a pulsed temperature drop is required; the pulses should be fed at sufficiently large intervals to allow the thermoelement, in which much more Joule heat is generated

Fig. 59

than under stationary conditions, to reach equilibrium with the surroundings.

The behaviour of semiconductor thermoelements under nonstationary conditions has not yet been sufficiently investigated. Work in this direction is continuing.

An oil trap for vacuum pumps developed by E. A. Kolenko at the Institute for Semiconductors is shown in fig. 58. It consists of a cylindrical attachment with two flanges which is connected between the pump and the evncuated enclosure, using lead gaskets.

To the cold junctions of the thermobattery are soldered polished condensing baffles, whilst the hot junctions are in contact with the outer wall (fig. 59). The outer wall is surrounded by a water-cooled jacket. The

thirteen baffles are mounted at an angle so that the migrating oil vapour molecules are subjected to multiple collisions. The thermoelectric battery reduces the temperature of the plates to approximately  $-30^{\circ}$ C at a temperature of the surroundings of  $+20^{\circ}$ C.

The thermoelectric battery consumes 10-12 amp at a voltage of 0.6-0.8 V; its power consumption is therefore of the order of 10 W. In the absence of a

\* E. A. Kolenko, Pribory i Tekh. Eksper., 1957, No. 3, p. 112.

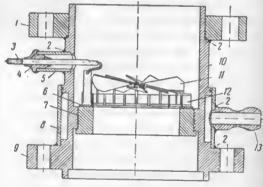


Fig. 60. Section through the trap.

1 and 9 - flanges; 2 - soldered joint; 3 - current terminal; 4 - glass insulator; 5 - Kovar cup; 6 - oxidised aluminium ring; 7 - copper ring; 8 - water jacket; 10 - shell; 11 - cooling baffles; 12 - thermoelectric battery; 13 - cooling water inlet.

d.c. source, the true may be fed by u.c. through a standard selenium rectifier.

Fig. 60 shows a section through the trap and its main components.

When compared with liquid oxygen and liquid air vacuum traps, the thermoelectric unit does not entail the risk of an explosion, as may occur when a glass trap cracks and oxygen mixes with the oil. Moreover, liquid air and liquid oxygen are not always available.

In the microtome shown in fig. 61 a few thermoelements are used to keep the tissue at the optimum cutting temperature permitting sections us

thin as 2  $\mu$  to be cut without difficulty. 2500 such microtomes have already been distributed.

Low temperature cooling. In 1954 tests were carried out on low temperature cooling with a three-stage thermopile. Thermoelements used for the construction of the thermopile had  $z = 1.3 \times 10^{-3}$  deg<sup>-1</sup>. The thermopile was designed to reduce the temperature by  $60^{\circ}$ C (from +20° to -40°C) with a heat input to the third stage at -40°C equal to 1 W. The temperature drop obtained from each stage was calculated so that  $\epsilon_1 = \epsilon_2 = \epsilon_3 \approx 33\%$ .

In this case according to equation (63)  $Q_h = 4Q_c$  and therefore  $W_1: W_2: W_3 \approx 4$ .

Table 3 contains data for the calculations for the thermopile.

Column 3 shows  $\Delta T_{max}$  for the three stages for the specified



Fig. 61

temperature range, calculated from equation (16). To facilitate the design and also to create some spare cooling capacity, the number of thermoelements in the second and first stages was somewhat increased and amounted to 18 and 72 thermoelements respectively.

As may be seen from table 3, the successive stages had steeply decrensing surface areas. To ensure the requisite heat transfer from the hot junctions of the third and second stages, 10 mm thick copper plates were placed between the stages of the thermopile. Electrical insulation

APPILICATIONS

together with good thermal contact was arbieved with the aid of mice sheets. 20  $\mu$  thick, wetted with mineral oil. The thermopile stages were

TABLE 3

Stage	ΔΤ	$\Delta T_{max}$	ε, %	$Q_c$ ,	₩, watt	I,	V, volts	N, stage	S, cm <sup>3</sup>	Weight,
1	24°(+20°, - 4°)	42°	32.2	12.4	49.6	16	3.5	64	104	1760
11	21° (- 2°, -23°)	37°	33	3.1	12.4	16	0.79	16	26	440
Ш	18° (-22°, -40°)	31°	32	1	3.1	16	0.195	4	6.5	110

Note: N - number of thermoelements; Qc - cooling capacity of the stage.

connected electrically in series in such a manner that the leads joined the cold junction of one stage to the hot junction of the next stage.

Fig. 62 shows the assembled thermopile. As has been mentioned above, the cooling capacity of the third stage at the temperature of -40°C was



Fig. 62

designed for 1 W only. Such small heat loads can only exist under heat insulation conditions which are close to ideal (i.e. in a high vacuum).

The vacuum apparatus, shown in fig. 63, consisted of a steel base 1 which also served as a radiator dissipating heat generated by the first

stage of the thermopile; the chamber 2 with circulating water for controlling the temperature of the radiator; forevacuum and high vacuum pumps, and a glass hell jar 3. The thermocauples used to measure the temperature of the various portions of the pile were inserted into holes in the flanges 4, and the leads into flanges 5 which were insulated from the base. Good contact between individual stages of the thermopile was achieved with

the aid of a special device 6. The very small contact area between the knife edges of the clamping device and the pile (hundredths of a cm²) made it possible to neglect heat flow to the cold junctions of the third stage.

When it was found necessary to vary the temperature of the radiator by an appreciable amount, container 2 was connected to an ultrathermostat using a circulating liquid cooled with solid carbon dioxide. Copper-constantan measur-

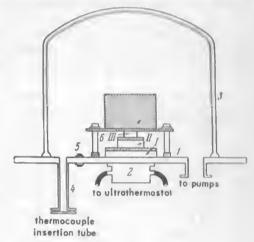


Fig. 63

ing thermocouples were connected to the cold and hot junctions of all stages of the thermopile. The effect of a thermal load on the operation of the thermopile was investigated with the aid of a small constantan henter cemented to the cold junctions of the third stage.

Table 4 sums up the results of the measurements of the temperature drops produced by two and three stages of the thermopile, with and without a load, for various temperature intervals.

It will be seen from the table that when the heater was not switched on, the three-stage thermopile produced a temperature drop of 73° (from +26° to -47°C). In this case  $\Delta T$  of the third stage was 29.5°.  $\Delta T_{max}$  calculated from equation (16) for the operating conditions of the third stage (at  $z=1.2\times10^{-3}$ ) is equal to 30.6°. This difference seems to be due to a small heat load consisting of the flow of heat along the leads to the heater, the heat absorbed from the radiating surroundings, and the heat conducted by the rarefied air (vacuum of  $10^{-3}-10^{-4}$  mm Hg). Calculations show that the heat load which can be attributed to these factors amounts to 0.1 W.

Table 4 also contains results of tests with thermal loads applied to the thermopile. At loads of 0.55, 1, and 3 W the temperature drop produced by the thermopile was reduced by 7°, 11°, and 29°C respectively.

Columns 5 and 6 show the results obtained with two stages (I and II) of the thermopile in various temperature ranges (cooling from +37°C and from +3°C).

THE BMOEL FOTRIC COOLING

TABLE 4

			DELL Y			
	1	2	3	4	5	6
Heat, W	0	0.55	1	3	0	0
$T_h^I$ , °C	+26	+25	+25	+33	+37	+ 3
$T_c^I$ , °C	- 2	- 2.5	- 3	+ 6	+ 2.5	<b>-19</b>
$\Delta T_1$ , °C	5	5.5	6	4.5	5.5	6
$T_h^{II}$ , °C	+ 3	+ 3	+ 3	+10.5	+ 8.5	-13
$T_c^{II}$ , °C	-18	-17.5	-17.5	- 7.5	-17.5	-39
$\Delta T_2$ , °C	0.5	1	2	3	-	-
$T_h^{III}$ , °C	-17.5	-16.5	-15.5	- 4.5	_	_
$T_c^{III}$ , °C	-47	-41	-37	-11	_	_
Troom, °C	25	25	24	25	27	26
$\Delta T_{total}$ , °C	73	66	62	44	54.5	42
$\Delta T$	72	66	61	36	44.5	-
$W_{pile}$ , W	78	78	75	70	71	68
L <sub>pile</sub> , A	15.5	15.5	15	14	15	15

Note:  $\Delta T_1$  and  $\Delta T_2$  are undesirable temperature drops across the insulating layers and plates between stages I and Il, and II and III of the thermopile;  $\Delta T_{total}$  is the difference between room temperature and the temperature of the cold junction of stage III.

It is seen from the table that over the lower temperature range the electric power consumed by the thermopile is somewhat reduced owing to the lower voltage drop across the pile. This is due to the fact that in the material used for the construction of the thermoelement the temperature dependence of the electric conductivity was  $\sigma \propto T^{-\frac{3}{2}}$  in the positive arm and  $\sigma \propto T^{-\frac{3}{2}}$  in the negative arm. As a result of this the resistance of the pile decreased with the lowering of the temperature.

Two- and three-stage thermopiles were used in experiments consisting of cooling of a cylindrical chamber with a volume of 1300 cm3 having a surface area of 1600 cm2. In order to reduce the hent load on the thermopile to a minimum the surface of the chamber was silvered and pulished (reflection coefficient approx, 95%) The tests were carried out in a vacuum of the order of  $2 \times 10^{-4}$  to  $4 \times 10^{-4}$  mm Hg. The measuring themse comple was mounted in the wall of the chamber, Results are repurted in tuble 5.

With a three-stage thermopile the temperature was decreased to 40° below the temperature of the surroundings. As will be seen from table 5

the temperature drop produced by the second and third stages was in this case much smaller than that produced by the first stage and the temperature difference between the hot junction of the first stage and the radiator increased considerably, leading to un increase of Th to +42°C. This demonstrates that the thermal load on the pile was fairly large. If it is again assumed that the thermal load consisted of the heat conducted by the rarefied air, the heat flowing through the clamping rods 6 (fig. 63) and the heat radiated by the surroundings (taking the absorption coefficient of the surface of the chamber to be 0.05), then the calculated total heat load was 2.5 W.

Tests were also carried out on cooling the chamber with the aid of two stages (I and II) of the thermopile. The results were in this case somewhat better (table 5, column 2) mainly as a result of a decrease in the total heat load on the cold junctions of the second stage and the smaller detrimental temperature drops.

TABLE 5

	1	2
7, °C	+42	+40
$T_c^I$ , °C	+10	+ 7
$\Delta T_1$ , °C	5	3.5
$T_h^{II}$ , °C	+15	+10.5
$T_c^{II}$ °C	- 6	-16.5
$\Delta T_{z}$ , ${}^{\circ}\mathrm{C}$	1	-
$\tau_h^{III}$ , °C	- 5	
$\tau_c^{III}$ , °C	-17	-
T <sub>chamber</sub> , °C	-15	-16.5
Troom, °C	+25	+25
∆T <sub>total</sub> , °C	40	41.5

Combined cooling. All single-stage refrigerating machines have definite limits of temperature reduction below which further cooling becomes impossible. To achieve lower temperatures use is made of refrigerating machines with two, three, and more stages. The application of semiconductor thermopiles opens up the possibility of constructing combined units in which the first cooling stage is performed by a conventional refrigerating machine and further reduction of the temperature is achieved with the aid of a small size thermopile. In this case the thermopile is mounted in the evaporator of the refrigerating machine.

Such combined units are eminently sultable in ranes where the requisite cooling only slightly exceeds the capabilities of a single-stage refrigerating machine. Under these conditions it is in many cases more convenient to use a thermopile than to replace the machine with a bulky two-stage plant.

Several tests on combined cooling were carried out in the Thermoelectric Cooling and Heating Laboratory of the Institute for Semiconductors.

The first stage consisted of the cooling unit of the "ZIS Moskvn" electric refrigerator. Cooling to lower temperatures was achieved with the aid of thermopile stages, for which purpose use was made of the stages of the previously described cooling thermopile.

The thermopile was mounted on the bottom wall of the evaporator of the refrigerating unit. Good thermal contact between the hot junction of the thermopile and the base of the evaporator was achieved by covering the base with a low m.pt. alloy (m.pt. = +45°C). The pile was electrically insulated from the base with a layer of mica wetted with mineral oil. A 5 cm thick layer of cotton wool served as thermal insulation between

TABLE 6

1	2	3	4	
-24.5	-25	-28	27	
-41	-41.5	-45	-43	
0	2.5			
-41	-39			
63	-47			
	1.5	2	0	
	<b>-45.5</b>	-43	-23	
	-68	-70	-78	
38.5	43	42	51	
23	25	24	24	
86	93	94	102	
	-41 0 -41 -63	-24.5 -25 -41 -41.5 0 2.5 -41 -39 -63 -47 1.5 -45.5 -68 38.5 43 23 25	-24.5     -25     -28       -41     -41.5     -45       0     2.5       -41     -39       -63     -47       1.5     2       -45.5     -43       -68     -70       38.5     43     42       23     25     24	-24.5     -25     -28     -27       -41     -41.5     -45     -43       0     2.5       -41     -39       -63     -47       1.5     2     0       -45.5     -43     -23       -68     -70     -78       38.5     43     42     51       23     25     24     24

Note:  $\Delta T_1$  and  $\Delta T_2$  are undesirable temperature drops across the insulating layers and plates between the stages of the thermopile;  $\Delta T_{total}$  is the difference between room temperature and the temperature of the cold junction of the last stage of the thermopile.

the evaporator and the surroundings. When testing the thermopile under no-load conditions, the inside of the evaporator was also packed with cotton wool. A copper container with a volume of 3 litres (surface area of  $2.5 \times 10^{4}~\rm cm^{2}$ ) and a cylindrical chamber with a volume of 0.6 litres served as the low temperature chambers. The thermopile was fed from a d.c. source which was independent of the circuit supplying the power to the compressor-driven refrigerator unit.

The compressor refrigerator unit made it possible to reduce the temperature of the evaporator surface to -30° to -32°C. The results of tents are reported in table 6.

When the compressor unit was used in conjunction with two thermupile stages (II and III) the temperature of the cold junction of the third stage was -63°C at a room temperature of +23°C. With a three-stage thermopile working in conjunction with a compressor unit the temperature of the cold junction of the last stage was -68°C. The last stage consisted of a single thermoelement.

In both the aforementioned cases the stages of the thermopile working under a load gave temperature drops appreciably smaller than the maximum temperature drops. In order to produce still lower temperatures a two-stage thermopile with stages of widely differing power was mounted in the evaporator of the cooling unit. The first stage of the thermopile consisted of 18 thermoelements and the second of a single thermoelement. Under these conditions the loading of the first stage is much smaller, i.e. this stage produces a greater temperature drop.

With a refrigerating unit incorporating such a two-stage thermopile, it was possible to reduce the temperature to -70°C at a room temperature of +24°C (table 6, column 3).

Similar tests were carried out using, for the last stage, n thermoelement with an improved negative arm with z equal to  $1.6 \times 10^{-3}$  to  $1.7 \times 10^{-9}$  deg<sup>-1</sup> The temperature could then be reduced to  $-78^{\circ}$ C for a room temperature of  $+24^{\circ}$ C, the total temperature drop amounting in this case to  $102^{\circ}$ C.

Table 7 shows the results of combined cooling of small chambers. Columns 1 and 2 show the data on the cooling of a 3 litre capacity container (with a surface area of 2,500 cm²) with the aid of the first (72 thermoelement) and second (18 thermoelement) stages, respectively. Column 3 gives the data on the cooling of a smaller capacity chamber (0.6 litres) with the aid of the second thermopile stage. Column 4 gives the results of tests on cooling with the aid of both thermopile stages (I and II). The cold junction of the last stage was joined to a copper sheet with a total surface area 900 cm², since the size of the evacuated chamber was such that there was not enough space for mounting the cooling chamber together with a two-stage thermobattery. In this case the thermal

APPLICATIONS

lond corresponded to the presence of a chamber with a surface area of 900 cm<sup>2</sup>; since no heat was generated inside the chambers, the total lond depended on the surface area. The temperature at the surface of the sheet was -46.5°C at a room temperature of +25°C. The total temperature drop was 71.5°C.

It is thus possible to reduce the temperatures in chambers of up to n few litres capacity not subjected to thermal loads to  $-40^{\circ}$  to  $-45^{\circ}$ C, using combined cooling with an ordinary refrigerator unit. A modification of the

TABLE 7

	1	2	3	4
$T_h^I$ , °C $T_c^J$ , °C	-22	-	_	-19.5
$I_c^J$ , °C	-41	-	_	-36
$r_h^{II}$ , °C	_	-25	-24	-35
T <sub>c</sub> <sup>II</sup> , ℃	-	-40	-43	-46.5
Chamber				
Tcentre, °C	-41	-39.5	-42	-46.5
Tedge, °C	-40	-38	-41	-46.5
T <sub>room</sub> , °C	+25	+23	+24	+25
$\Delta T_{total}$ , °C	65	61	65	71.5

design of the evaporator, aimed at positioning the main part of the cooling surface in contact with the surface of the hot junction of the thermopile will obviously reduce the hot junction temperature of the thermopile to -30° to -32°C and permit the achievement of still lower temperatures in the chamber.

In principle it is also possible to provide a combination of ordinary and thermoelectric cooling methods with the thermopile serving as the first stage, i.e. with the cold junction cooling the condenser of the refrigerator. In this case the thermopile operates under more favourable conditions since  $\Delta T_{main}$  increases with the increase of the temperature of the cold junction and therefore the coefficient of performance of the thermopile for a given temperature drop also increases.

Thermostatic temperature control. The Pettler effect has a reversible character, i.e., when the direction of current flow is changed the cold junction becomes the hot junction, and vice versa. This property pennits the use of thermopiles, when accessary, as heating units; from the point of view of power utilisation, up to a certain  $\Delta T_{max}$ . Pettier heating is preferable to conventional resistance heating. In this case, in addition to the Joule heat generated in the thermopile in the same way as in a conventional heater, heat is also pumped by the Peltier effect from that cold junction to the hot junction. For small temperature differences (10° to 20°C) thermoelectric heating is much more efficient (3 to 4 times) than conventional resistance heating.

One of the important applications of thermopiles will undoubtedly bn their use for temperature control.

Semiconductor (principally germanium) devices have found wide application in many branches of radio engineering. They suffer, however, from a very important disadvantage, viz, rapid deterioration of their operating characteristics at temperatures above +50° or +60°C and below -40° or -50°C, which in many cases prevents the conversion to transistor operation of electronic circuits and equipment exposed to overheating.

In 1955, tests were started, with the assistance of Prof. Yu. S. Bykov, on the thermostatic control of small volumes (up to 1 litre) which could house the most vulnerable parts of electronic and other equipment. A pile consisting of 18 thermoelements was used as a temperature stabiliser.

The volume, the temperature of which was stabilised, was the interior of a copper container insulated with a 1 cm thick felt cover. laside the container was mounted a bimetallic temperature control unit which, through a relay, reversed the current in the thermopile at a temperature inside the chamber of +42°C. The pile operated in this case as a cooler or a heater depending on the direction of current flow. In one arrangement the radiator consisted of an aluminium block (the chassis) with a total surface area of 1500 cm² and a thickness of 1.5 mm, and, in another arrangement, a copper radiator with a surface area of 12,000 cm² was employed.

Tests on controlling the temperature of the chamber with the aid of n pile under still air conditions, using an aluminium chassis as the radiator, gave the following results.

The temperature difference between the hot junction of the thermopile and the inside of the chamber was 42° (+45°, +87°C). It should also be noted that subsequent measurements showed that the temperature inside

the chamber was 3° to 4° higher than at the cald junction of the thermoelement (owing to heat flow from the surroundings through the chamber wall). Thus  $\Delta T$  for the pile was  $45^{\circ}-47^{\circ}$ C. The temperature difference between the inside of the chamber and the surroundings was, under these conditions, only 10° (+45°, +55°C). This was due to the presence of two large detrimental temperature differences:

- 1) a temperature difference along the chassis (between the area under the hot junction and the edge of the chassis) amounting to 16°-18° and due to the small thickness of the top of the chassis (1.5 mm) and inside-quate thermal conductivity of the material from which the chassis was made.
- 2) a temperature difference between the chassis and the surroundings due to the low thermal conductivity of still air. This temperature difference reached 15°-16°.

To reduce the temperature difference between the chassis and the surroundings measurements were made using a small fan to ventilate the chassis. Under these conditions the temperature difference became much smaller and was only 4° to 4.5°. The temperature difference along the chassis remained, as was expected, practically unaffected. The temperature difference between the inside of the chamber and the surroundings increased to 18° to 19° (+45°, +64°C).

In order to study the possibility of reducing the temperature difference along the chassis tests were carried out on the thermopile-chamber combination after replacing the chassis with a copper radiator of a much larger surface area (12,000 cm<sup>2</sup>) and a much thicker apper wall (5 mm). The ventilating conditions remained unchanged. In this case the temperature difference along the radiator decreased to 6° to 7° (as compared with 16°-189. The temperature difference between the radiator and the surroundings decreased to 2.5° to 3° (owing to the larger surface area of the radiator). The temperature difference between the inside of the chamber and the surrounding air increased to 21° to 22° (+45°, +66° to +67°). This relatively small increase of the temperature difference can be attributed to the fact that, for temperature differences of this magnitude, the pile operated under a large thermal load (with the available insulation the heat load for  $\Delta T = 15^{\circ}$  or  $20^{\circ}$  was 6 to 7 watts). A further increase of the useful temperature difference with a pile having the same power and efficiency can be achieved by improving the insulation or by using a small metallic radiator on the chassis under the pile.

Tests at sub-zero temperatures of the surroundings were carried out by Yu. S. Bykov. In this case the temperature inside the chamber was maintained at +45°C, when the temperature of the surroundings fell to -21°C.

Thus a pile of the investigated type, loaded with an insulated volume of 0.6 litres, can produce a temperature difference between the hot and

cold junctions of up to 45° to 50° and permit the amintenance of the temperature within the clamber at the level of +45°C for ambient tamperature variations between the limits of +65° to -21°C.

The problem of reducing the detrimental temperature differences and increasing the useful temperature difference (between the inside of the chamber and the surroundings) can be solved by resort to the following measures:

- 1) reduction of the temperature drop across the oil-covered micu layer nt the cold and hot junctions of the pile, which in our case amounted to 2° to 3° nt ench contact. By using special varnishes and contings this temperature drop can be reduced to 1°-1.5°C;
- 2) reduction of the temperature difference between the chassis and the surroundings to a value of 2° to 3°. This can be achieved by forced convection:
- 3) reduction of the temperature difference along the chassis to a value of 5° to 6°. This can be achieved by increasing the thickness of the chassis and fitting the chassis with a small radiator immediately below the hot junction of the thermopile;
- 4) reduction of the heat load on the pile. This can be achieved by improving the insulation.

Work on the solution of these problems will undoubtedly permit the achievement of better results in future investigations.

Tests were also carried out on controlling the temperature of separate semiconductor diodes and transistors with the aid of a single thermoelement. In this case it was found possible either to reduce the temperature of the transistor by 20°-25° or to increase its power by 2-3 times.

A thermostat with a thermoelectric battery consuming 3-4 W may be used to keep the temperature of a thermally insulated chamber with a volume of 100 cm<sup>3</sup> constant at 20-30°C under ambient temperature variations from +60 to -60°C.

Such a thermostat has been employed for controlling the temperature of a crystal oscillator employing a transistor.

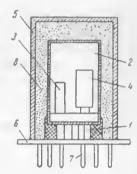
A block diagram of the apparatus is shown in fig. 64. It consists of n temperature stabiliser 1, thermostatic chamber 2, temperature sensing instrument 3, controller 4, commutator 5, and power supply source 6. The construction of the thermostat is shown diagrammatically in fig. 20. The temperature stabiliser 1 consists of 15 thermoelements connected in series to form a rectangular plate with dimensions of  $40 \times 40 \times 13$  mm and a cooling surface aren of  $16 \text{ cm}^2$ . To increase the mechanical strength of

E. K. Iordanishvili and L. G. Tkalich, Zhur. Tekh. Fiz., 27, No. 6, 1215, 1957.

the battery, the thermoelements are mounted in an elamite frame. The thermoelements have  $z=1.7\times 10^{-3}~\rm deg^{-1}$ . The ralculated optimum current is 3.5 A

The temperature stabiliser (fig. 65) is fixed to one of the walls of the copper working chamber and insulnted from it with thin mich leaves

wetted with oil. The working chamber 2 contains the oscillator unit 3 and a temperature pick-up 4. The working chamber, together with the thermoelectric battery is mounted in a metallic jacket 5 on top of a copper radiator 6



6

Fig. 64

Fig. 65

with fins 7. The space between the working chamber and the jacket is filled with mipora (an expanded plastic material). The total weight of the thermostat is 2 kg and its dimensions are  $160 \times 140 \times 110 \text{ mm}$ .

Small thermostats employing thermoelements have also numerous other applications. For example, an automatic 0°C reference point was constructed in which a thermoelement maintains water all the time at a transition point between the liquid and solid phases. Thermostats are also used to distribute the sperm of bulls to collective and state farms for artificial insemination, thus assisting the breeding of high grade cattle. The temperature is maintained at a suitable level so that the sperm remains active for a long period of time.

3.3 Data from foreign literature. There has so far been very little information in the foreign literature giving results of investigations on results of investigations on thermoelectric cooling.

In 1953 there appeared a review article in the journal "Kältetechnik" (German Federal Republic) outlining the results of an investigation by German scientists in this field.\* The author of the paper reached the conclusion that the maximum temperature drop which could be obtained with the aid of thermoelements did not then exceed 26°C. In 1954 British scientists reported that they were able to achieve a temperature drop of 37°C.\*\*

At the end of 1955 a report was published in the American journal "Product Engineering" that the Radio Corporation of America had constructed a prototype domestic refrigerator based on the Peltier effect. This brief mention was, however, only of an advertising nature and did not contain any information about the materials of the thermoelements or other characteristics of the refrigerator. It was only noted that the heat transfer from the hot junctions was achieved with the ald of circulating water, from which it may be concluded that the efficiency of the thermoelements was low. Judging from the photograph shown in the journal the volume of the working chamber did not exceed 10 litres.\*

<sup>\*</sup> E. Justi, Kältetechnik, No. 6, 130, 1953.

<sup>\*\*</sup> H. J. Goldsmid and R. W. Douglas, British Journ. of Appl. Phys., 3, No. 11, 386, 1954.

<sup>\*</sup> More recently, I'. F. Shilliday has published an article "The Performance of Composite Peliter Junction of Bismuth Telluride" (Journ. Appl. Phys., 28, 1035, 1957) describing the work done at the Battelle Memorial Institute. (Editor's note)

#### CONCLUSIONS

When current-quality materials are used in the construction of thermoelements in thermobatteries for cooling volumes of tens of litres, thermoelectric refrigerators are more economical than absorption units but are as yet inferior to compression units.

It is, however, well known that the coefficient of performance of a compression refrigerator decreases with the decrease of its capacity. Therefore, when it is necessary to design a refrigerator for cooling a chamber of only a few litres capacity, thermoelectric cooling with the existing thermoelements is already preferable, from the power consumption viewpoint, to cooling with compression units; it also has certain other advantages, such as the absence of moving parts, freedom from corrosion, etc.

There is no doubt that, for controlling the temperature of small units, thermoelectric cooling has no competition from existing refrigerators of the conventional types.

This book has described results obtained with thermoelements developed in the period 1952-1955 at the Institute for Semiconductors of the Academy of Sciences of the U.S.S.R.

We now have at our disposal thermoelements with much better performances and there is every reason to believe that the efficiency of thermoelectric refrigerators will, in the immediate future, exceed that of compression-type refrigerating plants and that the fields of application of thermoelectric cooling will become much wider.

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